

# AN2606 Application note

# STM32 microcontroller system memory boot mode

#### Introduction

The bootloader is stored in the internal boot ROM memory (system memory) of STM32 devices. It is programmed by ST during production. Its main task is to download the application program to the internal Flash memory through one of the available serial peripherals (USART, CAN, USB, I<sup>2</sup>C, SPI, etc.). A communication protocol is defined for each serial interface, with a compatible command set and sequences. This document applies to the products listed in *Table 1*. They are referred as STM32 throughout the document.

**Table 1. Applicable products** 

Туре	Part number or product series
Microcontrollers	STM32L0 series: STM32L01xxx, STM32L02xxx, STM32L031xx, STM32L041xx, STM32L051xx, STM32L052xx, STM32L053xx, STM32L062xx, STM32L063xx, STM32L063xx, STM32L062xx, STM32L1 series.  STM32L1 series: STM32L476xx, STM32L486xx STM32F0 series: STM32F03xxx, STM32F04xxx, STM32F05xxx, STM32F07xxx, STM32F1 series.  STM32F1 series.  STM32F3 series: STM32F301xx, STM32F302xx, STM32F303xx, STM32F318xx, STM32F3 series: STM32F301xx, STM32F334xx, STM32F358xx, STM32F378xx, STM32F378xx, STM32F378xx, STM32F378xx, STM32F378xx, STM32F417xx, STM32F411xx, STM32F412xx, STM32F415xx, STM32F417xx, STM32F417xx, STM32F427xx, STM32F429xx, STM32F437xx, STM32F439xx, STM32F446xx, STM32F469xx, STM32F479xx  STM32F7 series: STM32F74xxx, STM32F75xxx
	STIVISZET SELIES. STIVISZET 4XXX, STIVISZET SXXX

The main features of the bootloader are the following:

- It uses an embedded serial interface to download the code with a predefined communication protocol.
- It transfers and updates the Flash memory code, the data, and the vector table sections.

This application note presents the general concept of the bootloader. It describes the supported peripherals and hardware requirements to be considered when using the bootloader of STM32 devices. However the specifications of the low-level communication protocol for each supported serial peripheral are documented in separate documents as referred in *Section 1: Related documents*.

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AN2606 Related documents

#### 1 Related documents

For each supported product (listed in *Table 1*), please refer to the following documents available from *www.st.com*:

- Datasheet or databrief
- Reference manual
- Application Note:
  - AN3154: CAN protocol used in the STM32 bootloader
  - AN3155: USART protocol used in the STM32 bootloader
  - AN3156: USB DFU protocol used in the STM32 bootloader
  - AN4221: I2C protocol used in the STM32 bootloader
  - AN4286: SPI protocol used in the STM32 bootloader

# 2 Glossary

#### F0 Series:

**STM32F03xxx** is used to refer to STM32F030x4, STM32F030x6, STM32F038x6, STM32F030xC, STM32F031x4 and STM32F031x6 devices.

STM32F04xxx is used to refer to STM32F042x4 and STM32F042x6 devices.

**STM32F05xxx and STM32F030x8 devices** is used to refer to STM32F051x4, STM32F051x6, STM32F051x8, STM32F058x8 and STM32F030x8 devices.

**STM32F07xxx** is used to refer to STM32F070x6, STM32F070xB, STM32F071xB STM32F072x8 and STM32F072xB devices.

STM32F09xxx is used to refer to STM32F091xx and STM32F098xx devices.

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#### F1 Series:

**STM32F10xxx** is used to refer to Low-density, Medium-density, High-density, Low-density value line, Medium-density value line and High-density value line devices:

**Low-density devices** are STM32F101xx, STM32F102xx and STM32F103xx microcontrollers where the Flash memory density ranges between 16 and 32 Kbytes.

**Medium-density devices** are STM32F101xx, STM32F102xx and STM32F103xx microcontrollers where the Flash memory density ranges between 64 and 128 Kbytes.

**High-density devices** are STM32F101xx and STM32F103xx microcontrollers where the Flash memory density ranges between 256 and 512 Kbytes.

**Low-density value line devices** are STM32F100xx microcontrollers where the Flash memory density ranges between 16 and 32 Kbytes.

**Medium-density value line devices** are STM32F100xx microcontrollers where the Flash memory density ranges between 64 and 128 Kbytes.

**High-density value line devices** are STM32F100xx microcontrollers where the Flash memory density ranges between 256 and 5128 Kbytes.

STM32F105xx/107xx is used to refer to STM32F105xx and STM32F107xx devices.

**STM32F10xxx XL-density** is used to refer to STM32F101xx and STM32F103xx devices where the Flash memory density ranges between 768 Kbytes and 1 Mbyte.

#### F2 Series:

**STM32F2xxxx** is used to refer to STM32F215xx, STM32F205xx, STM32F207xx and SMT32F217xx devices.

#### F3 Series:

**STM32F301xx/302x4(6/8)** is used to refer to STM32F301x4, STM32F301x6, STM32F301x8, STM32F302x4, STM32F302x6 and STM32F302x8 devices.

STM32F302xB(C)/303xB(C) is used to refer to STM32F302xB, STM32F302xC, STM32F303xB and STM32F303xC devices.

**STM32F302xD(E)/303xD(E)** is used to refer to STM32F302xD, STM32F302xE, STM32F303xD and STM32F303xE devices.

**STM32F303x4(6/8)/334xx/328xx** is used to refer to STM32F303x4, STM32F303x6, STM32F303x8, STM32F334x4, STM32F334x6, STM32F334x8, and STM32F328x8 devices.

STM32F318xx is used to refer to STM32F318x8 devices.

STM32F358xx is used to refer to STM32F358xC devices.

**STM32F373xx** is used to refer to STM32F373x8, STM32F373xB and STM32F373xC devices.

STM32F378xx is used to refer to STM32F378xC devices.

STM32F398xx is used to refer to STM32F398xE devices.

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#### F4 Series:

**STM32F40xxx/41xxx** is used to refer to STM32F405xx, STM32F407xx, STM32F415xx and SMT32F417xx devices.

STM32F401xB(C) is used to refer to STM32F401xB and STM32F401xC devices.

STM32F401xD(E) is used to refer to STM32F401xD and STM32F401xE devices.

STM32F410xx is used to refer to STM32F410x8 and STM32F410xB devices.

STM32F411xx is used to refer to STM32F411xD and STM32F411xE devices.

**STM32F412xx** is used to refer to STM32F412Cx, STM32F412Rx, STM32F412Vx and STM32F412Zx devices.

**STM32F42xxx/43xxx** is used to refer to STM32F427xx, STM32F429xx, STM32F437xx and STM32F439xx devices

STM32F446xx is used to refer to STM32F446xE and STM32F446xC devices

**STM32F469xx/479xx** is used to refer to STM32F469xE, STM32F469xG, STM32F469xI, STM32F479xG and STM32F479xI devices.

#### F7 Series:

**STM32F74xxx/75xxx** is used to refer to STM32F745xx, STM32F746xx and STM32F756xx devices.

#### L0 Series:

STM32L01xxx/02xxx is used to refer to STM32L011xx and STM32L021xx devices.

STM32L031xx/041xx is used to refer to STM32L031xx and STM32L041xx devices.

**STM32L05xxx/06xxx** is used to refer to STM32L051xx, STM32L052xx, STM32L053xx, STM32L062xx and STM32L063xx ultralow power devices.

**STM32L07xxx/08xxx** is used to refer to STM32L071xx, STM32L072xx, STM32L073xx, STM32L081xx, STM32L082xx and STM32L083xx devices

#### L1 Series:

**STM32L1xxx6(8/B)** is used to refer to STM32L1xxV6T6, STM32L1xxV6H6, STM32L1xxR6T6, STM32L1xxR6H6, STM32L1xxC6T6, STM32L1xxC6H6, STM32L1xxV8T6, STM32L1xxV8H6, STM32L1xxR8T6, STM32L1xxR8H6, STM32L1xxC8T6, STM32L1xxC8H6, STM32L1xxVBT6, STM32L1xxVBH6, STM32L1xxRBT6, STM32L1xxRBH6, STM32L1xxCBH6 and STM32L1xxCBH6 ultralow power devices.

STM32L1xxx6(8/B)A is used to refer to STM32L1xxV6T6-A, STM32L1xxV6H6-A, STM32L1xxR6T6-A, STM32L1xxR6H6-A, STM32L1xxC6T6-A, STM32L1xxC6H6-A, STM32L1xxV8T6-A, STM32L1xxV8H6-A, STM32L1xxR8T6-A, STM32L1xxR8H6-A, STM32L1xxC8T6-A, STM32L1xxC8H6-A, STM32L1xxVBT6-A, STM32L1xxVBH6-A, STM32L1xxRBT6-A, STM32L1xxRBT6-A, STM32L1xxCBT6-A and STM32L1xxCBH6-A ultralow power devices.

**STM32L1xxxC** is used to refer to STM32L1xxVCT6, STM32L1xxVCH6, STM32L1xxRCT6, STM32L1xxUCY6, STM32L1xxCCT6 and STM32L1xxCCU6 ultralow power devices.

**STM32L1xxxD** is used to refer to STM32L1xxZDT6, STM32L1xxQDH6, STM32L1xxVDT6, STM32L1xxRDY6, STM32L1xxRDT6, STM32L1xxZCT6,

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STM32L1xxQCH6, STM32L1xxRCY6, STM32L1xxVCT6-A and STM32L1xxRCT6-A ultralow power devices.

**STM32L1xxxE** is used to refer to STM32L1xxZET6, STM32L1xxQEH6, STM32L1xxVET6, STM32L1xxVET6 ultralow power devices.

#### L4 Series:

**STM32L476xx/486xx** is used to refer to STM32L476xE, STM32L476xG and STM32L486xG devices

Note: BL\_USART\_Loop refers to the USART Bootloader execution loop.

BL\_CAN\_Loop refers to the CAN Bootloader execution loop. BL\_I2C\_Loop refers to the I2C Bootloader execution loop. BL\_SPI\_Loop refers to the SPI Bootloader execution loop.



# 3 General bootloader description

#### 3.1 Bootloader activation

The bootloader is activated by applying one of the patterns described in *Table 2: Bootloader activation patterns*.

If Boot From Bank2 option is activated (for products supporting this feature), Bootloader executes Dual Boot mechanism as described in figures "Dual Bank Boot Implementation for STM32xxxxx" where STM32xxxxx is the relative STM32 product.

Otherwise, Bootloader selection protocol is executed as described in figures "Bootloader VY.x selection for STM32xxxx" where STM32xxxx is the relative STM32 product.

When readout protection Level2 is activated, STM32 does not boot on system memory in any case and Bootloader can't be executed (unless jumping to it from Flash user code, all commands are not accessible except Get, GetID, and GetVersion).

Table 2. Bootloader activation patterns

Patterns	Condition			
Pattern1	Boot0(pin) = 1 and Boot1(pin) = 0			
Pattern2	Boot0(pin) = 1 and nBoot1(bit) = 1			
	Boot0(pin) = 1, Boot1(pin) = 0 and BFB2(bit) = 1			
Pattern3	Boot0(pin) = 0, BFB2(bit) = 0 and both banks don't contain valid code			
	Boot0(pin) = 1, Boot1(pin) = 0, BFB2(bit) = 0 and both banks don't contain valid code			
	Boot0(pin) = 1, Boot1(pin) = 0 and BFB2(bit) = 1			
Pattern4	Boot0(pin) = 0, BFB2(bit) = 0 and both banks don't contain valid code			
	Boot0(pin) = 1, Boot1(pin) = 0 and BFB2(bit) = 0			
	Boot0(pin) = 1, Boot1(pin) = 0 and BFB2(bit) = 0			
Pattern5	Boot0(pin) = 0, BFB2(bit) = 1 and both banks don't contain valid code			
	Boot0(pin) = 1, Boot1(pin) = 0 and BFB2 (bit) = 1			
	Boot0(pin) = 1, nBoot1(bit) = 1 and nBoot0_SW(bit) = 1			
Pattern6	nBoot0(bit) = 0, nBoot1(bit) = 1 and nBoot0_SW(bit) = 0			
	Boot0(pin) = 0, nBoot0_SW (bit) = 1 and main flash empty			
	Boot0(pin) = 1, nBoot1(bit) = 1 and BFB2(bit) = 0			
Pattern7	Boot0(pin) = 0, BFB2(bit) = 1 and both banks don't contain valid code			
	Boot0(pin) = 1, nBoot1(bit) = 1 and BFB2(bit) = 1			
Pattern8	Boot(pin) = 0 and BOOT_ADD0(optionbyte) = 0x0040			
i aucino	Boot(pin) = 1 and BOOT_ADD1(optionbyte) = 0x0040			



In addition to patterns described above, user can execute bootloader by performing a jump to system memory from user code. Before jumping to Bootloader user must:

- Disable all peripheral clocks
- Disable used PLL
- Disable interrupts
- Clear pending interrupts

System memory boot mode can be exited by getting out from bootloader activation condition and generating hardware reset or using Go command to execute user code.

Note:

If you choose to execute the Go command, the peripheral registers used by the bootloader are not initialized to their default reset values before jumping to the user application. They should be reconfigured in the user application if they are used. So, if the IWDG is being used in the application, the IWDG prescaler value has to be adapted to meet the requirements of the application (since the prescaler was set to its maximum value).

Note:

For STM32 devices having the Dual Bank Boot feature, in order to jump to system memory from user code, the user has first to remap the System Memory Bootloader at address 0x00000000 using SYSCFG register, then jump to Bootloader.

Refer to product Reference Manual for details about Memory remapping.

#### 3.2 Bootloader identification

Depending on the STM32 device used, the bootloader may support one or more embedded serial peripherals used to download the code to the internal Flash memory. The bootloader identifier (ID) provides information about the supported serial peripherals.

For a given STM32 device, the bootloader is identified by means of the:

- Bootloader (protocol) version: version of the serial peripheral (USART, CAN, USB, etc.) communication protocol used in the bootloader. This version can be retrieved using the bootloader Get Version command.
- 2. **Bootloader identifier (ID)**: version of the STM32 device bootloader, coded on one byte in the **0xXY** format, where:
  - X specifies the embedded serial peripheral(s) used by the device bootloader:
    - X = 1: one USART is used
    - X = 2: two USARTs are used
    - X = 3: USART, CAN and DFU are used
    - X = 4: USART and DFU are used
    - X = 5: USART and  $I^2C$  are used
    - X = 6:  $I^2C$  is used
    - X = 7: USART, CAN, DFU and I<sup>2</sup>C are used
    - X = 8:  $I^2C$  and SPI are used
    - X = 9: USART, CAN, DFU,  $I^2C$  and SPI are used
    - X = 10: USART. DFU and I<sup>2</sup>C are used
    - X = 11: USART,  $I^2C$  and SPI are used
    - X = 12: USART and SPI are used
    - X = 13: USART. DFU. I<sup>2</sup>C and SPI are used
  - Y specifies the device bootloader version

Let us take the example of a bootloader ID equal to 0x10. This means that it is the first version of the device bootloader that uses only one USART.

The bootloader ID is programmed in the last byte address - 1 of the device system

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memory and can be read by using the bootloader "Read memory" command or by direct access to the system memory via JTAG/SWD.

The table below provides identification information about the bootloaders embedded in STM32 devices.

Table 3. Embedded bootloaders

STM32		Supported carial	Во	otloader ID	Bootloader (protocol) version	
series	Device		Supported serial peripherals	ID		Memory location
	STM32F05xxx a STM32F030x8		USART1/USART2	0x21	0x1FFFF7A6	USART (V3.1)
	STM32F030xx4	·/6	USART1	0x10	0x1FFFF7A6	USART (V3.1)
	STM32F030xC		USART1/I2C1	0x52	0x1FFFF796	USART (V3.1) I2C1(V1.0)
	STM32F04xxx		USART1/USART2/ I2C1/ DFU (USB Device FS)	0xA0	0x1FFFF6A6	USART (V3.1) DFU (V2.2) I2C (V1.0)
F0	STM32F071xx/	72xx	USART1/USART2/ I2C1/ DFU (USB Device FS)	0xA1	0x1FFFF6A6	USART (V3.1) DFU (V2.2) I2C (V1.0)
	STM32F070x6		USART1/USART2/ DFU (USB Device FS)/ I2C1	0xA2	0x1FFFF6A6	USART (V3.1) DFU (V2.2) I2C (V1.0)
	STM32F070xB		USART1/USART2/ DFU (USB Device FS)/ I2C1	0xA2	0x1FFFF6A6	USART (V3.1) DFU (V2.2) I2C (V1.0)
	STM32F09xxx		USART1/USART2/ I2C1	0x50	0x1FFFF796	USART (V3.1) I2C (V1.0)
		Low-density	USART1	NA	NA	USART (V2.2)
		Medium- density	USART1	NA	NA	USART (V2.2)
	071100710	High-density	USART1	NA	NA	USART (V2.2)
	STM32F10xxx	Medium- density value line	USART1	0x10	0x1FFFF7D6	USART (V2.2)
F1		High-density value line	USART1	0x10	0x1FFFF7D6	USART (V2.2)
	STM32F105xx/107xx		USART1 / USART2 (remapped) / CAN2 (remapped) / DFU (USB Device)	NA	NA	USART (V2.2 <sup>(1)</sup> ) CAN (V2.0) DFU(V2.2)
	STM32F10xxx	XL-density	USART1/USART2 (remapped)	0x21	0x1FFFF7D6	USART (V3.0)



Table 3. Embedded bootloaders (continued)

STM32		Cumported corial	Bootloader ID		Bootloader
series	Device	Supported serial peripherals	ID	Memory location	(protocol) version
		USART1/USART3	0x20	0x1FFF77DE	USART (V3.0)
F2	STM32F2xxxx	USART1/USART3/ CAN2/ DFU (USB Device FS)	0x33	0x1FFF77DE	USART (V3.1) CAN (V2.0) DFU (V2.2)
	STM32F373xx	USART1/USART2/ DFU (USB Device FS)	0x41	0x1FFFF7A6	USART (V3.1) DFU (V2.2)
	STM32F378xx	USART1/USART2/ I2C1	0x50	0x1FFFF7A6	USART (V3.1) I2C (V1.0)
	STM32F302xB(C)/303xB(C)	USART1/USART2/ DFU (USB Device FS)	0x41	0x1FFFF796	USART (V3.1) DFU (V2.2)
	STM32F358xx	USART1/USART2/ I2C1	0x50	0x1FFFF796	USART (V3.1) I2C (V1.0)
F3	STM32F301xx/302x4(6/8)	USART1/USART2/ DFU (USB Device FS)	0x40	0x1FFFF796	USART (V3.1) DFU (V2.2)
	STM32F318xx	USART1/USART2/ I2C1/ I2C3	0x50	0x1FFFF796	USART (V3.1) I2C (V1.0)
	STM32F302xD(E)/303xD(E)	USART1/USART2/ DFU (USB Device FS)	0x40	0x1FFFF796	USART (V3.1) DFU (V2.2)
	STM32F303x4(6/8)/334xx/328xx	USART1/USART2/ I2C1	0x50	0x1FFFF796	USART (V3.1) I2C (V1.0)
	STM32F398xx	USART1/USART2/ I2C1/I2C3	0x50	0x1FFFF796	USART (V3.1) I2C (V1.0)



Table 3. Embedded bootloaders (continued)

STM32	Device	Supported serial peripherals	Bootloader ID		Bootloader
series			ID	Memory location	(protocol) version
	STM32F40xxx/41xxx	USART1/USART3/ CAN2/ DFU (USB Device FS)	0x31	0x1FFF77DE	USART (V3.1) CAN (V2.0) DFU (V2.2)
		USART1/USART3/ CAN2 / DFU (USB Device FS) //2C1/I2C2/I2C3/SPI1/S PI2	0x90	0x1FFF77DE	USART (V3.1) CAN (V2.0) DFU (V2.2) SPI(V1.1) I2C (V1.0)
F4	STM32F42xxx/43xxx	USART1/USART3/ CAN2 /DFU (USB Device FS) / I2C1/I2C2/I2C3	0x70	0x1FFF76DE	USART (V3.1) CAN (V2.0) DFU (V2.2) I2C (V1.0)
		USART1/USART3/ CAN2 / DFU (USB Device FS) / I2C1/I2C2/I2C3/SPI1/ SPI2/ SPI4	0x90	0x1FFF76DE	USART (V3.1) CAN (V2.0) DFU (V2.2) SPI(V1.1) I2C (V1.0)
	STM32F401xB(C)	USART1/USART2/ DFU (USB Device FS)/ I2C1/I2C2/I2C3/ SPI1/SPI2/ SPI3	0xD1	0x1FFF76DE	USART (V3.1) DFU (V2.2) SPI(V1.1) I2C (V1.0)



Table 3. Embedded bootloaders (continued)

STM32	Device	Commonted conicl	Во	otloader ID	Bootloader
series		Supported serial peripherals	ID	Memory location	(protocol) version
	STM32F401xD(E)	USART1/USART2/ DFU (USB Device FS)/ I2C1/I2C2/I2C3/ SPI1/SPI2/ SPI3	0xD1	0x1FFF76DE	USART (V3.1) DFU (V2.2) SPI(V1.1) I2C (V1.1)
	STM32F410xx	USART1/USART2/ I2C1/I2C2/I2C4 SPI1/SPI2	0xB1	0x1FFF76DE	USART (V3.1) I2C (V1.2) SPI (V1.1)
	STM32F411xx	USART1/USART2/DFU (USB Device FS)/ I2C1/I2C2/I2C3/ SPI1/SPI2/ SPI3	0xD0	0x1FFF76DE	USART (V3.1) DFU (V2.2) SPI(V1.1) I2C (V1.1)
F4	STM32F412xx	USART1/USART2/ USART3/CAN2/ DFU (USB Device FS)/ I2C1/I2C2/I2C3/I2C4/ SPI1/SPI3/SPI4	0x91	0x1FFF76DE	USART (V3.1) CAN (V2.0) DFU (V2.2) SPI (V1.1) I2C (V1.2)
	STM32F446xx	USART1/USART3/ CAN2 / DFU (USB Device FS) / I2C1/I2C2/I2C3/SPI1/ SPI2/ SPI4	0x90	0x1FFF76DE	USART (V3.1) CAN (V2.0) DFU (V2.2) SPI(V1.1) I2C (V1.2)
	STM32F469xx/479xx	USART1/USART3/ I2C1/I2C2/I2C3/ CAN2/ DFU (USB Device FS)/ SPI1/ SPI2/ SPI4	0x90	0x1FFF76DE	USART (V3.1) I2C (V1.2) CAN (V2.0) DFU (V2.2) SPI (V1.1)
F7		USART1/USART3/ I2C1/I2C2/I2C3/ CAN2/ DFU (USB Device FS)	0x70	0x1FF0EDBE	USART (V3.1) I2C (V1.2) CAN (V2.0) DFU (V2.2)
	STM32F74xxx/75xxx	USART1/USART3/ I2C1/I2C2/I2C3/ CAN2/ DFU (USB Device FS)/ SPI1/SPI2/SPI4	0x90	0x1FF0EDBE	USART (V3.1) I2C (V1.2) CAN (V2.0) DFU (V2.2) SPI (V1.2)

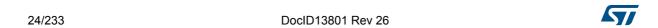


Table 3. Embedded bootloaders (continued)

STM32	Device	Cumported coriol	Bootloader ID		Bootloader
series		Supported serial peripherals	ID	Memory location	(protocol) version
	STM32L01xxx/02xxx	USART2/SPI1	0xC3	0x1FF00FFE	USART (V3.1) SPI (V1.1)
	STM32L031xx/041xx	USART2/SPI1	0xC0	0x1FF00FFE	USART (V3.1) SPI (V1.1)
L0	STM32L05xxx/06xxx	USART1/USART2/SPI1/ SPI2	0xC0	0x1FF00FFE	USART (V3.1) SPI (V1.1)
	CTM22I 07:00//09:00/	USART1/USART2/ DFU (USB Device FS)	0x41	0x1FF01FFE	USART (V3.1) DFU (V2.2)
	STM32L07xxx/08xxx	USART1/USART2/ SPI1/SPI2/	0xB2	0x1FF01FFE	USART (V3.1) SPI (V1.1)
	STM32L1xxx6(8/B)	USART1/USART2	0x20	0x1FF00FFE	USART (V3.0)
	STM32L1xxx6(8/B)A	USART1/USART2	0x20	0x1FF00FFE	USART (V3.1)
L1	STM32L1xxxC	USART1/USART2/ DFU (USB Device FS)	0x40	0x1FF01FFE	USART (V3.1) DFU (V2.2)
	STM32L1xxxD	USART1/USART2/ DFU (USB Device FS)	0x45	0x1FF01FFE	USART (V3.1) DFU (V2.2)
	STM32L1xxxE	USART1/USART2/ DFU (USB Device FS)	0x40	0x1FF01FFE	USART (V3.1) DFU (V2.2)
L4	STM32L476xx/486xx	USART1/USART2/ USART3/ I2C1/I2C2/I2C3/ DFU (USB Device FS)	0xA3	0x1FFF6FFE	USART (V3.1) I2C (V1.2) DFU (V2.2)
		USART1/USART2/ USART3/ I2C/I2C2/I2C3/ SPI1/SPI2/CAN1/ DFU (USB Device FS)	0x90	0x1FFF6FFE	USART (V3.1) I2C (V1.2) SPI (V1.1) CAN(V2.0) DFU(V2.2)

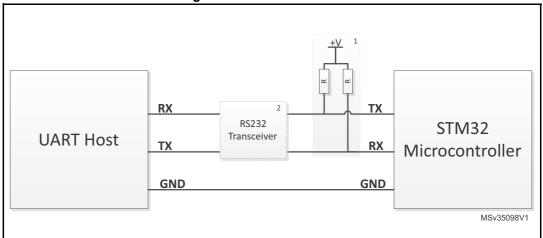
For connectivity line devices, the USART bootloader returns V2.0 instead of V2.2 for the protocol version. For more details
please refer to the "STM32F105xx and STM32F107xx revision Z" errata sheet available from http://www.st.com.



# 3.3 Hardware connection requirements

To use the USART bootloader, the host has to be connected to the (RX) and (TX) pins of the desired USARTx interface via a serial cable.

Figure 1. USART Connection



- 1. A Pull-UP resistor should be added, if pull-up resistor are not connected in host side.
- An RS232 transceiver must be connected to adapt voltage level (3.3V 12V) between STM32 device and host.

Note:

+V typically 3.3 V and R value typically 100KOhm. This value depend on the application and the used hardware.

To use the DFU, connect the microcontroller's USB interface to a USB host (i.e. PC).

USB Host

DM

DM

STM32

Microcontroller

GND

MS35037V1

Figure 2. USB Connection

This additional circuit permits to connect a Pull-Up resistor to (DP) pin using VBus when needed. Refer to
product section (Table which describes STM32 Configuration in system memory boot mode) to know if an
external pull-up resistor must be connected to (DP) pin.

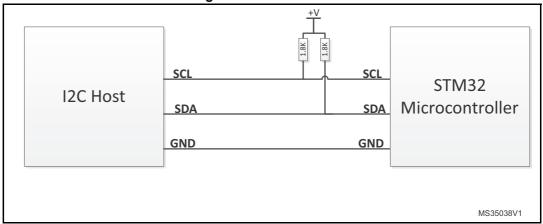
Note:

+V typically 3.3 V.This value depends on the application and the used hardware.



To use the I2C bootloader, connect the host (master) and the desired I2Cx interface (slave) together via the data (SDA) and clock (SCL) pins. A 1.8 KOhm pull-up resistor has to be connected to both (SDA) and (SCL) lines.

Figure 3. I2C Connection

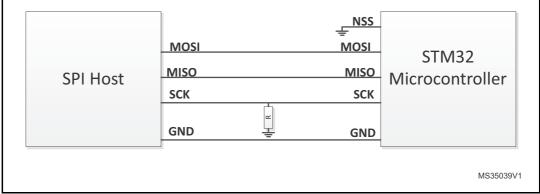


Note:

+V typically 3.3 V.This value depends on the application and the used hardware.

To use the SPI bootloader, connect the host (master) and the desired SPIx interface (slave) together via the (MOSI), (MISO) and (SCK) pins. The (NSS) pin must be connected to (GND). A pull-down resistor should be connected to the (SCK) line.

Figure 4. SPI Connection



Note:

R value typically 10KOhm. This value depends on the application and the used hardware.

To use the CAN interface, the host has to be connected to the (RX) and (TX) pins of the desired CANx interface via CAN transceiver and a serial cable. A 120 Ohm resistor should be added as terminating resistor.

CAN H TX RX STM32 CAN CAN **CAN Host** Transceiv Transceiv Microcontroller TX RX er CAN L **GND GND** MS35040V1

Figure 5. CAN Connection

Note:

When a bootloader firmware supports DFU, it is mandatory that no USB Host is connected to the USB peripheral during the selection phase of the other interfaces. After selection phase, the user can plug a USB cable without impacting the selected bootloader execution except commands which generate a system reset.

It is recommended to keep the RX pins of unused Bootloader interfaces (USART\_RX, SPI\_MOSI, CAN\_RX and USB D+/D- lines if present) at a known (low or high) level at the startup of the Bootloader (detection phase). Leaving these pins floating during the detection phase might lead to activating unused interface.

### 3.4 Bootloader Memory Management

All write operations using bootloader commands must only be Word-aligned (the address should be a multiple of 4). The number of data to be written must also be a multiple of 4 (non-aligned half page write addresses are accepted).

Some Products embed bootloader that has some specific features:

- Some products don't support Mass erase operation. To perform a mass erase operation using bootloader, two options are available:
  - Erase all sectors one by one using the Erase command
  - Set protection level to Level 1. Then, set it to Level 0 (using the Read protect command and then the Read Unprotect command). This operation results in a mass erase of the internal Flash memory.
- Bootloader firmware of STM32 L1 and L0 series supports Data Memory in addition to standard memories (internal Flash, internal SRAM, option bytes and System memory). The start address and the size of this area depends on product, please refer to product reference manual for more information. Data memory can be read and written but cannot be erased using the Erase Command. When writing in a Data memory location, the bootloader firmware manages the erase operation of this location before any write. A write to Data memory must be Word-aligned (address to be written should be a multiple of 4) and the number of data must also be a multiple of 4. To erase a Data memory location, you can write zeros at this location.
- Bootloader firmware of STM32 F2, F4, F7 and L4 series supports OTP memory in addition to standard memories (internal Flash, internal SRAM, option bytes and System memory). The start address and the size of this area depends on product, please refer to product reference manual for more information. OTP memory can be read and

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- written but cannot be erased using Erase command. When writing in an OTP memory location, make sure that the relative protection bit is not reset.
- For STM32 F2, F4 and F7 series the internal flash write operation format depends on voltage Range. By default write operation are allowed by one byte format (Half-Word, Word and Double-Word operations are not allowed). to increase the speed of write operation, the user should apply the adequate voltage range that allows write operation by Half-Word, Word or Double-Word and update this configuration on the fly by the bootloader software through a virtual memory location. This memory location is not physical but can be read and written using usual bootloader read/write operations according to the protocol in use. This memory location contains 4 bytes which are described in table below. It can be accessed by 1, 2, 3 or 4 bytes. However, reserved bytes should remain at their default values (0xFF), otherwise the request will be NACKed.

Table 4. STM32 F2, F4 and F7 Voltage Range configuration using bootloader

Address	Size	Description
0xFFFF0000	1 byte	This byte controls the current value of the voltage range.  0x00: voltage range [1.8 V, 2.1 V]  0x01: voltage range [2.1 V, 2.4 V]  0x02: voltage range [2.4 V, 2.7 V]  0x03: voltage range [2.7 V, 3.6 V]  0x04: voltage range [2.7 V, 3.6 V] and double word write/erase operation is used. In this case it is mandatory to supply 9 V through the VPP pin (refer to the product reference manual for more details about the double-word write procedure).  Other: all other values are not supported and will be NACKed.
0xFFFF0001	1 byte	Reserved. 0xFF: default value. Other: all other values are not supported and will be NACKed.
0xFFFF0002	1 byte	Reserved.  0xFF: default value.  Other: all other values are not supported and will be NACKed.
0xFFFF0003	1 byte	Reserved. 0xFF: default value. Other: all other values are not supported and will be NACKed.

The table below lists the valid memory area depending on the Bootloader commands.

Table 5. Supported memory area by Write, Read, Erase and Go Commands

Memory Area	Write command	Read command	Erase command	Go command
Flash	Supported	Supported	Supported	Supported
RAM	Supported	Supported	Not Supported	Supported
System Memory	Not Supported	Supported	Not Supported	Not Supported
Data Memory	Supported	Supported	Not Supported	Not Supported
OTP Memory	Supported	Supported	Not Supported	Not Supported



# 4 STM32F03xx4/6 devices bootloader

# 4.1 Bootloader configuration

The STM32F03xx4/6 bootloader is activated by applying pattern2 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 6. STM32F03xx4/6 configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
	RCC	HSI Enabled	The system clock frequency is 24 MHz (using PLL clocked by HSI).  1 Flash Wait State.
	RAM	-	2 Kbyte starting from address 0x20000000 are used by the bootloader firmware.
Common to all bootloaders	System memory	-	3 Kbyte starting from address 0x1FFFEC00 contain the bootloader firmware.
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset in case the hardware IWDG option was previously enabled by the user.
USART1	USART1	Enabled	Once initialized, the USART1 configuration is 8 bits, even parity and 1 Stop bit.
bootloader (on PA10/PA9)	USART1_RX pin	Input	PA10 pin: USART1 in reception mode.
1 410/1 43)	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode.
USART1	USART1	Enabled	Once initialized, the USART1 configuration is 8 bits, even parity and 1 Stop bit.
bootloader (on PA14/PA15)	USART1_RX pin	Input	PA15 pin: USART1 in reception mode.
	USART1_TX pin	Output	PA14 pin: USART1 in transmission mode.
USART1 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host.

The system clock is derived from the embedded internal high-speed RC, no external quartz is required for the bootloader execution.

Note:

After the STM32F03xx4/6 devices has booted in bootloader mode, serial wire debug (SWD) communication is no longer possible until the system is reset. This is because the SWD uses the PA14 pin (SWCLK) which is already used by the bootloader (USART1\_TX).



#### 4.2 Bootloader selection

The figure below shows the bootloader selection mechanism.

System Reset

System Init (Clock, GPIOs, IWDG, SysTick)

Disable all interrupt sources

Configure USARTx

Execute BL\_USART\_Loop for USARTx

MS35015V1

Figure 6. Bootloader selection for STM32F03xx4/6 devices

#### 4.3 Bootloader version

The following table lists the STM32F03xx4/6 devices bootloader versions.

Table 7. STM32F03xx4/6 bootloader versions

Bootloader version number	Description	Known limitations
V1.0	Initial bootloader version	For the USART interface, two consecutive NACKs instead of 1 NACK are sent when a Read Memory or Write Memory command is sent and the RDP level is active.

# 5 STM32F030xC devices bootloader

# 5.1 Bootloader configuration

The STM32F030xC bootloader is activated by applying pattern6 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 8.STM32F030xC configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
	RCC	HSI enabled	The system clock configured to 48 MHz with HSI 8 MHz as clock source.
Common to all bootloaders	RAM	-	6 Kbyte starting from address 0x20000000 are used by the bootloader firmware
	System memory	-	8 Kbyte starting from address 0x1FFFD800, contain the bootloader firmware.
USART1	USART1	Enabled	Once initialized the USART1 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART2	USART2	Enabled	Once initialized the USART2 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART2_RX pin	Input	PA15 pin: USART2 in reception mode
	USART2_TX pin	Output	PA14 pin: USART2 in transmission mode
USART1 and USART2 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.
I2C1 bootloader	I2C1	Enabled	The I2C1 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b1000001x (where x = 0 for write and x = 1 for read)
120 i sociodadi	I2C1_SCL pin	Input/Output	PB6 pin: clock line is used in open-drain mode.
	I2C1_SDA pin	Input/Output	PB7 pin: data line is used in open-drain mode.

Note:

After the STM32F030xC devices have booted in Bootloader mode using USART2, the serial wire debug (SWD) communication is no more possible until the system is reset, because SWD uses PA14 pin (SWCLK) which is already used by the Bootloader (USART2\_RX).

The system clock is derived from the embedded internal high-speed RC, no external quartz is required for the bootloader execution.



#### 5.2 Bootloader selection

The figure below shows the bootloader selection mechanism.

System Reset System Init (Clock, GPIOs, IWDG, SysTick) Configure I2Cx 0x7F received on Disable all interrupt **USART**x sources and other interfaces clock's no Disable all interrupt Configure sources and other USARTx interfaces clock's I2Cx Address Detected no Execute Execute BL\_USART\_Loop BL I2C Loop for for USARTx I2Cx MSv36789V1

Figure 7.Bootloader selection for STM32F030xC

#### 5.3 Bootloader version

V5.2

The following table lists the STM32F030xC devices bootloader versions.

Initial bootloader version

Bootloader
version Description Known limitations
number

None

Table 9.STM32F030xC bootloader versions

#### 6 STM32F05xxx and STM32F030x8 devices bootloader

# 6.1 Bootloader configuration

The STM32F05xxx and STM32F030x8 devices bootloader is activated by applying pattern2 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 10. STM32F05xxx and STM32F030x8 devices configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
	RCC	HSI Enabled	The system clock frequency is 24 MHz (using PLL clocked by HSI). 1 Flash Wait State.
	RAM	-	2 Kbyte starting from address 0x20000000 are used by the bootloader firmware.
Common to all bootloaders	System memory	-	3 Kbyte starting from address 0x1FFFEC00, contain the bootloader firmware.
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset in case the hardware IWDG option was previously enabled by the user.
USART1	USART1	Enabled	Once initialized, the USART1 configuration is 8 bits, even parity and 1 Stop bit.
bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode.
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode.
USART2	USART2	Enabled	Once initialized, the USART2 configuration is 8 bits, even parity and 1 Stop bit.
bootloader	USART2_RX pin	Input	PA15 pin: USART2 in reception mode.
	USART2_TX pin	Output	PA14 pin: USART2 in transmission mode.
USART1 and USART2 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host.

The system clock is derived from the embedded internal high-speed RC, no external quartz is required for the bootloader execution.

Note:

After the STM32F05xxx and STM32F030x8 devices have booted in bootloader mode, the serial wire debug (SWD) communication is no more possible until the system is reset, because SWD uses PA14 pin (SWCLK) which is already used by the bootloader (USART2\_TX).

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#### 6.2 Bootloader selection

The figure below shows the bootloader selection mechanism.

System Reset

System Init (Clock, GPIOs, IWDG, SysTick)

Ox7F received on USARTx

Yes

Configure
USARTx

Execute
BL\_USART\_Loop
for USARTx

Figure 8. Bootloader selection for STM32F05xxx and STM32F030x8 devices

#### 6.3 Bootloader version

The following table lists the STM32F05xxx and STM32F030x8 devices bootloader versions.

Table 11. STM32F05xxx and STM32F030x8 devices bootloader versions

Bootloader version number	Description	Known limitations
V2.1	Initial bootloader version	When the user application configures a value of HSI TRIM bits (in RCC_CR register) and then jumps to the bootloader, the HSITRIM value is set (0) at bootloader startup.  For the USART interface, two consecutive NACKs instead of 1 NACK are sent when a Read Memory or Write Memory command is sent and the RDP level is active.

# 7 STM32F04xxx devices bootloader

# 7.1 Bootloader configuration

The STM32F04xxx bootloader is activated by applying pattern6 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 12. STM32F04xxx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
	RCC	HSI enabled	The system clock frequency is 48 MHz with HSI 48 MHz as clock source.
		-	The Clock Recovery System (CRS) is enabled for the DFU bootloaders to allow USB to be clocked by HSI 48 MHz.
Common to all	RAM	-	6 Kbyte starting from address 0x20000000 are used by the bootloader firmware
bootloaders	System memory	-	13 Kbyte starting from address 0x1FFFC400, contain the bootloader firmware
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
USART1	USART1	Enabled	Once initialized the USART1 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART2	USART2	Enabled	Once initialized the USART2 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART2_RX pin	Input	PA15 pin: USART2 in reception mode
	USART2_TX pin	Output	PA14 pin: USART2 in transmission mode
USART1 and USART2 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.

Table 12. STM32F04xxx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
I2C1 bootloader	I2C1	Enabled	The I2C1configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0111110x (where x = 0 for write and x = 1 for read).
	I2C1_SCL pin	Input/Output	PB6 pin: clock line is used in open-drain mode.
	I2C1_SDA pin	Input/Output	PB7 pin: data line is used in open-drain mode.
DFU bootloader	USB	Enabled	USB used in FS mode
	USB_DM pin		PA11: USB DM line.
	USB_DP pin	Input/Output	PA12: USB DP line No external pull-up resistor is required.

Note:

After the STM32F04xxx devices have booted in Bootloader mode using USART2, the serial wire debug (SWD) communication is no more possible until the system is reset, because SWD uses PA14 pin (SWCLK) which is already used by the Bootloader (USART2\_RX).

The system clock is derived from the embedded internal high-speed RC, no external quartz is required for the bootloader execution.



The figure below shows the bootloader selection mechanism.

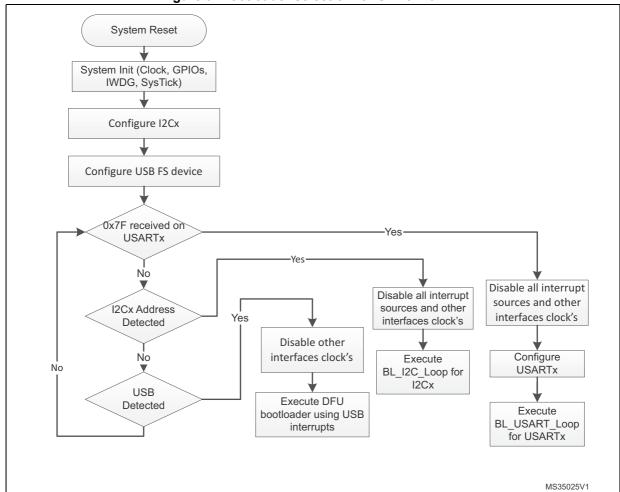


Figure 9. Bootloader selection for STM32F04xxx

### 7.3 Bootloader version

The following table lists the STM32F04xxx devices bootloader versions:

Table 13. STM32F04xxx bootloader versions

Bootloader version number	Description	Known limitations
V10.0	Initial bootloader version	When the user application configures a value of HSI TRIM bits (in RCC_CR register) and then jumps to the bootloader, the HSITRIM value is set to (0) at bootloader startup



## 8 STM32F070x6 devices bootloader

## 8.1 Bootloader configuration

The STM32F070x6 bootloader is activated by applying pattern6 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 14. STM32F070x6 configuration in system memory boot mode

Bootloader	Feature/Periphe ral	State	Comment	
Common to all		HSI enabled	At startup, the system clock frequency is configured to 48 MHz using the HSI. If an external clock (HSE) is not present, the system is kept clocked from the HSI.	
	RCC	HSE enabled	The external clock can be used for all bootloader interfaces and should have one of the following values 24,18,12,8,6,4 MHz. The PLL is used to generate 48 MHz for USB and system clock.	
bootloaders		-	The Clock Security System (CSS) interrupt is enabled for HSE. Any failure (or removal) of the external clock generates system reset.	
	RAM	-	6 Kbyte starting from address 0x20000000 are used by the bootloader firmware	
	System memory	-	13 Kbyte starting from address 0x1FFFC400, contain the bootloader firmware.	
USART1	USART1	Enabled	Once initialized the USART1 configuration is: 8-bits even parity and 1 Stop bit	
bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode	
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode	
USART2	USART2	Enabled	Once initialized the USART2 configuration is: 8-bits, even parity and 1 Stop bit	
bootloader	USART2_RX pin	Input	PA15 pin: USART2 in reception mode	
	USART2_TX pin	Output	PA14 pin: USART2 in transmission mode	
USART1 and USART2 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.	
I2C1 bootloader	I2C1	Enabled	The I2C1 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0111110x where x = 0 for write and x = 1 for read)	
	I2C1_SCL pin	Input/Output	PB6 pin: clock line is used in open-drain mode.	
	I2C1_SDA pin	Input/Output	PB7 pin: data line is used in open-drain mode.	



Bootloader	Feature/Periphe ral	State	Comment
DFU bootloader	USB	Enabled	USB FS configured in Forced Device mode. USB FS interrupt vector is enabled and used for USB DFU communications.
	USB_DM pin		PA11 pin: USB FS DM line
	USB_DP pin	Input/Output	PA12 pin: USB FS DP line. No external Pull-up resistor is required.

Note: If HSI deviation exceeds 1%, the bootloader might not function correctly.

Note: After the STM32F070x6 devices have booted in Bootloader mode using USART2, the serial wire debug (SWD) communication is no more possible until the system is reset, because SWD uses PA14 pin (SWCLK) which is already used by the Bootloader (USART2\_RX).

The bootloader has two cases of operation depending on the presence of the external clock (HSE) at bootloader startup:

- If HSE is present and has a value of 24, 18, 16, 12, 8, 6, 4 MHz, the system clock is configured to 48 MHz with HSE as clock source. The DFU interface, USART1, USART2 and I2C1 are functional and can be used to communicate with the bootloader device.
- If HSE is not present, the HSI is kept as default clock source and only USART1, USART2 and I2C1 are functional.

The external clock (HSE) must be kept if it's connected at bootloader startup because it will be used as system clock source.



The figure below shows the bootloader selection mechanism.

System Reset Configure System clock to 48 MHz using HSI HSE= 24, 18, 16, -No 12, 8, 6, 4 MHz ? Yes Reconfigure System clock to 48 MHz using HSE System Init (Clock, GPIOs, System Init (Clock, GPIOs, IWDG, SysTick) IWDG, SysTick) Configure USB Configure I2Cx 0x7F received on **USART**x yes no Disable all interrupt sources and other interfaces clock's I2Cx Address ves Detected Disable all interrupt Disable other sources and other Configure interfaces clock's interfaces clock's USARTx no no **Execute DFU** Execute Execute USB cable BL\_I2C\_Loop for bootloader using USB BL\_USART\_Loop Detected & USB interrupts for USARTx configured MSv36794V1

Figure 10.Bootloader selection for STM32F070x6



## 8.3 Bootloader version

The following table lists the STM32F070x6 devices bootloader versions.

Table 15.STM32F070x6 bootloader versions

Bootloader version number	Description	Known limitations
V10.2	Initial bootloader version	When the user application configures a value of HSI TRIM bits (in RCC_CR register) and then jumps to the bootloader, the HSITRIM value is set to (0) at bootloader startup.
V10.3	Clock configuration fixed to HSI 8 MHz	When the user application configures a value of HSI TRIM bits (in RCC_CR register) and then jumps to the bootloader, the HSITRIM value is set to (0) at bootloader startup.



# 9 STM32F070xB devices bootloader

## 9.1 Bootloader configuration

The STM32F070xB bootloader is activated by applying pattern2 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 16. STM32F070xB configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
Common to all	RCC	HSI enabled	At startup, the system clock frequency is configured to 48 MHz using the HSI. If an external clock (HSE) is not present, the system is kept clocked from the HSI.
		HSE enabled	The external clock can be used for all bootloader interfaces and should have one of the following values 24,18,12,8,6,4 MHz. The PLL is used to generate 48 MHz for USB and system clock.
bootloaders		-	The Clock Security System (CSS) interrupt is enabled for HSE. Any failure (or removal) of the external clock generates system reset.
	RAM	-	6 Kbyte starting from address 0x20000000 are used by the bootloader firmware
	System memory	-	12 Kbyte starting from address 0x1FFFC800, contain the bootloader firmware.
USART1	USART1	Enabled	Once initialized the USART1 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART2	USART2	Enabled	Once initialized the USART2 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART2_RX pin	Input	PA15 pin: USART2 in reception mode
	USART2_TX pin	Output	PA14 pin: USART2 in transmission mode
USART1 and USART2 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.
I2C1 bootloader	I2C1	Enabled	The I2C1 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0111011x (where x = 0 for write and x = 1 for read)
	I2C1_SCL pin	Input/Output	PB6 pin: clock line is used in open-drain mode.
	I2C1_SDA pin	Input/Output	PB7 pin: data line is used in open-drain mode.



Table 16. STM32F070xB configuration in system memory boo	t mode	(continued)
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Bootloader	Feature/Peripheral	State	Comment
DFU bootloader	USB	Enabled	USB FS configured in Forced Device mode. USB FS interrupt vector is enabled and used for USB DFU communications.
	USB_DM pin		PA11 pin: USB FS DM line
	USB_DP pin	Input/Output	PA12 pin: USB FS DP line. No external Pull-up resistor is required.

Note: If HSI deviation exceeds 1%, the bootloader might not function correctly.

Note: After the STM32F070xB devices have booted in Bootloader mode using USART2, the serial wire debug (SWD) communication is no more possible until the system is reset, because

The bootloader has two cases of operation depending on the presence of the external clock (HSE) at bootloader startup:

SWD uses PA14 pin (SWCLK) which is already used by the Bootloader (USART2\_RX).

- If HSE is present and has a value of 24, 18, 16, 12, 8, 6, 4 MHz, the system clock is configured to 48 MHz with HSE as clock source. The DFU interface, USART1, USART2 and I2C1 are functional and can be used to communicate with the bootloader device.
- If HSE is not present, the HSI is kept as default clock source and only USART1, USART2 and I2C1 are functional.

The external clock (HSE) must be kept if it's connected at bootloader startup because it will be used as system clock source.



The figure below shows the bootloader selection mechanism.

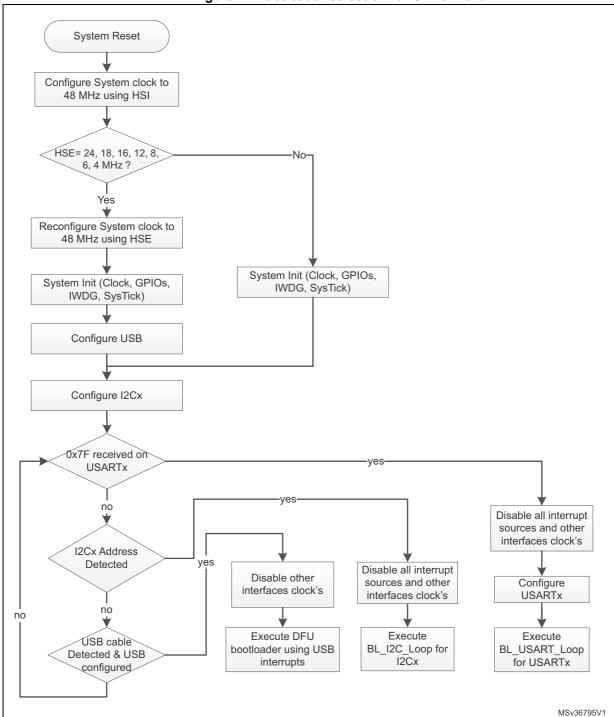


Figure 11.Bootloader selection for STM32F070xB

## 9.3 Bootloader version

The following table lists the STM32F070xB devices bootloader versions.

Table 17.STM32F070xB bootloader versions

Bootloader version number	Description	Known limitations
V10.2	Initial bootloader version	When the user application configures a value of HSI TRIM bits (in RCC_CR register) and then jumps to the bootloader, the HSITRIM value is set to (0) at bootloader startup.
V10.3	Clock configuration fixed to HSI 8 MHz	When the user application configures a value of HSI TRIM bits (in RCC_CR register) and then jumps to the bootloader, the HSITRIM value is set to (0) at bootloader startup.



## 10 STM32F071xx/72xx devices bootloader

## 10.1 Bootloader configuration

The STM32F071xx/72xx bootloader is activated by applying pattern2 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 18. STM32F071xx/72xx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
	RCC	HSI enabled	The system clock frequency is 48 MHz with HSI 48 MHz as clock source.
		-	The Clock Recovery System (CRS) is enabled for the DFU bootloaders to allow USB to be clocked by HSI 48 MHz.
Common to all	RAM	-	6 Kbyte starting from address 0x20000000 are used by the bootloader firmware
Common to all bootloaders	System memory	-	12 Kbyte starting from address 0x1FFFC800, contain the bootloader firmware
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
USART1	USART1	Enabled	Once initialized the USART1 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART2 bootloader	USART2	Enabled	Once initialized the USART2 configuration is: 8-bits, even parity and 1 Stop bit
	USART2_RX pin	Input	PA15 pin: USART2 in reception mode
	USART2_TX pin	Output	PA14 pin: USART2 in transmission mode
USART1 and USART2 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.



Table 18. STM32F071xx/72xx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
I2C1 bootloader	I2C1	Enabled	The I2C1 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0111011x (where x = 0 for write and x = 1 for read)
	I2C1_SCL pin	Input/Output	PB6 pin: clock line is used in open-drain mode.
	I2C1_SDA pin	Input/Output	PB7 pin: data line is used in open-drain mode.
DFU bootloader	USB	Enabled	USB used in FS mode
	USB_DM pin	Input/Output	PA11: USB DM line.
	USB_DP pin		PA12: USB DP line No external pull-up resistor is required.

Note:

After the STM32F071xx/72xx devices have booted in Bootloader mode using USART2, the serial wire debug (SWD) communication is no more possible until the system is reset, because SWD uses PA14 pin (SWCLK) which is already used by the Bootloader (USART2\_RX).

The system clock is derived from the embedded internal high-speed RC, no external quartz is required for the bootloader execution.



The figure below shows the bootloader selection mechanism.

System Reset System Init (Clock, GPIOs, IWDG, SysTick) Configure I2Cx Configure USB FS device 0x7F received on **USART**x Yes No Disable all interrupt Disable all interrupt sources and other sources and other 12Cx Address interfaces clock's Detected interfaces clock's Disable other interfaces clock's Configure No Execute No BL I2C Loop for **USART**x I2Cx USB Execute DFU Detected Execute bootloader using USB BL USART Loop interrupts for USARTx MS35026V1

Figure 12. Bootloader selection for STM32F071xx/72xx

### 10.3 Bootloader version

The following table lists the STM32F071xx/72xx devices bootloader versions:

Table 19. STM32F071xx/72xx bootloader versions

Bootloader version number	Description	Known limitations
V10.1	Initial bootloader version	When the user application configures a value of HSI TRIM bits (in RCC_CR register) and then jumps to the bootloader, the HSITRIM value is set to (0) at bootloader startup



## 11 STM32F09xxx devices bootloader

## 11.1 Bootloader configuration

The STM32F09xxx bootloader is activated by applying pattern6 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 20.STM32F09xxx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
	RCC	HSI enabled	The system clock configured to 48 MHz with HSI 48 MHz as clock source.
Common to all bootloaders	RAM	-	6 Kbyte starting from address 0x20000000 are used by the bootloader firmware
	System memory	-	8 Kbyte starting from address 0x1FFFD800, contain the bootloader firmware.
USART1	USART1	Enabled	Once initialized the USART1 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART2	USART2	Enabled	Once initialized the USART2 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART2_RX pin	Input	PA15 pin: USART2 in reception mode
	USART2_TX pin	Output	PA14 pin: USART2 in transmission mode
USART1 and USART2 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.
I2C1 bootloader	I2C1	Enabled	The I2C1 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b1000001x (where x = 0 for write and x = 1 for read)
1201 5001104401	I2C1_SCL pin	Input/Output	PB6 pin: clock line is used in open-drain mode.
	I2C1_SDA pin	Input/Output	PB7 pin: data line is used in open-drain mode.

Note:

After the STM32F09xxx devices have booted in Bootloader mode using USART2, the serial wire debug (SWD) communication is no more possible until the system is reset, because SWD uses PA14 pin (SWCLK) which is already used by the Bootloader (USART2\_RX).

The system clock is derived from the embedded internal high-speed RC, no external quartz is required for the bootloader execution.



The figure below shows the bootloader selection mechanism.

System Reset System Init (Clock, GPIOs, IWDG, SysTick) Configure I2Cx 0x7F received on Disable all interrupt **USART**x sources and other interfaces clock's no Disable all interrupt Configure sources and other USARTx interfaces clock's I2Cx Address Detected no Execute Execute BL\_USART\_Loop BL\_I2C\_Loop for for USARTx I2Cx MSv36789V1

Figure 13. Bootloader selection for STM32F09xxx

### 11.3 Bootloader version

The following table lists the STM32F09xxx devices bootloader versions.

Table 21.STM32F09xxx bootloader versions

## 12 STM32F10xxx devices bootloader

## 12.1 Bootloader configuration

The STM32F10xxx bootloader is activated by applying pattern1 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 22. STM32F10xxx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
	RCC	HSI enabled	The system clock frequency is 24 MHz using the PLL.
	RAM	-	512 byte starting from address 0x20000000 are used by the bootloader firmware.
	System memory	-	2 Kbyte starting from address 0x1FFFF000 contain the bootloader firmware.
USART1 bootloader	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value and is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
	USART1	Enabled	Once initialized, the USART1 configuration is: 8 bits, even parity and 1 Stop bit.
	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output push-pull	PA9 pin: USART1 in transmission mode
	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host.

The system clock is derived from the embedded internal high-speed RC, no external quartz is required for the bootloader execution.

The figure below shows the bootloader selection mechanism.

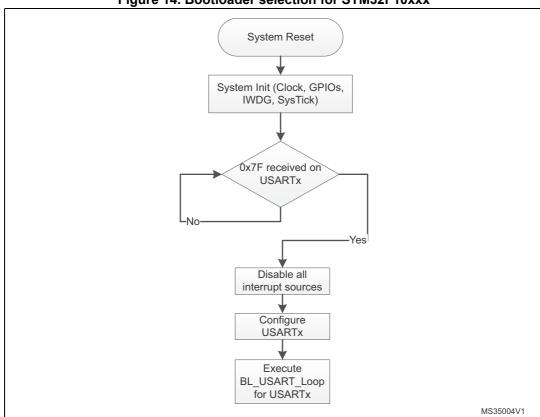


Figure 14. Bootloader selection for STM32F10xxx

### 12.3 Bootloader version

The following table lists the STM32F10xxx devices bootloader versions:

**Bootloader version number** Description V2.0 Initial bootloader version - Updated Go Command to initialize the main stack pointer - Updated Go command to return NACK when jump address is in V2.1 the Option byte area or System memory area - Updated Get ID command to return the device ID on two bytes Update the bootloader version to V2.1 Updated Read Memory, Write Memory and Go commands to deny access with a NACK response to the first 0x200 bytes of V2.2 RAM memory used by the bootloader Updated Readout Unprotect command to initialize the whole RAM content to 0x0 before ROP disable operation

Table 23. STM32F10xxx bootloader versions

#### 13 STM32F105xx/107xx devices bootloader

#### 13.1 **Bootloader configuration**

The STM32F105xx/107xx bootloader is activated by applying pattern1 (described in Table 2: Bootloader activation patterns). The following table shows the hardware resources used by this bootloader.

Table 24. STM32F105xx/107xx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
	RCC	HSI enabled	The system clock frequency is 24 MHz using the PLL. This is used only for USART1 and USART2 bootloaders and during CAN2, USB detection for CAN and DFU bootloaders (once CAN or DFU bootloader is selected, the clock source will be derived from the external crystal).
Common to all bootloaders		HSE enabled	The external clock is mandatory only for DFU and CAN bootloaders and it must provide one of the following frequencies: 8 MHz, 14.7456 MHz or 25 MHz.  For CAN bootloader, the PLL is used only to generate 48 MHz when 14.7456 MHz is used as HSE.  For DFU bootloader, the PLL is used to generate a 48 MHz system clock from all supported external clock frequencies.
		-	The Clock Security System (CSS) interrupt is enabled for the CAN and DFU bootloaders. Any failure (or removal) of the external clock will generate system reset.
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value and is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
	System memory	-	18 Kbyte starting from address 0x1FFF B000 contain the bootloader firmware.
	RAM	-	4 Kbyte starting from address 0x20000000 are used by the bootloader firmware.
	USART1	Enabled	Once initialized, the USART1 configuration is: 8 bits, even parity and 1 Stop bit.
USART1 bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output push-pull	PA9 pin: USART1 in transmission mode
USART1 and USART2 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloader.



Table 24. STM32F105xx/107xx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
USART2 bootloader	USART2	Enabled	Once initialized, the USART2 configuration is: 8 bits, even parity and 1 Stop bit. The USART2 uses its remapped pins.
	USART2_RX pin	Input	PD6 pin: USART2 receive (remapped pin)
	USART2_TX pin	Output push-pull	PD5 pin: USART2 transmit (remapped pin)
CAN2 bootloader	CAN2	Enabled	Once initialized, the CAN2 configuration is: Baudrate 125 kbps, 11-bit identifier.  Note: CAN1 is clocked during the CAN bootloader execution because CAN1 manages the communication between CAN2 and SRAM.
	CAN2_RX pin	Input	PB5 pin: CAN2 receives (remapped pin).
	CAN2_TX pin	Output push-pull	PB6 pin: CAN2 transmits (remapped pin).
	USB	Enabled	USB OTG FS configured in Forced Device mode
DFU bootloader	USB_VBUS pin	Input	PA9: Power supply voltage line
DFO boolloadel	USB_DM pin		PA11 pin: USB_DM line
	USB_DP pin	Input/Output	PA12 pin: USB_DP line. No external Pull-up resistor is required

The system clock is derived from the embedded internal high-speed RC for USARTx bootloader. This internal clock is used also for DFU and CAN bootloaders but only for the selection phase. An external clock (8 MHz, 14.7456 MHz or 25 MHz.) is required for DFU and CAN bootloader execution after the selection phase.



The figure below shows the bootloader selection mechanism.

System Reset System Init (Clock, GPIOs, IWDG, SysTick) Configure USB USB cable Yes Detected no Disable all interrupt sources HSE= 8MHz, 14.7456MHz or USARTx 25 MHz Configure **USART**x no Yes Execute Frame detected on CANx BL USART Loop Reconfigure System for USARTx clock to 48MHz and USB clock to 48 MHz yes HSE= 8MHz, Execute DFU no bootloader using USB 14.7456MHz or 25 MHz interrupts Generate System reset Reconfigure System clock to 48MHz Disable all interrupt sources Configure CAN Execute BL\_CAN\_Loop for CANx MS35005V1

Figure 15. Bootloader selection for STM32F105xx/107xx devices



### 13.3 Bootloader version

The following table lists the STM32F105xx/107xx devices bootloader versions:

Table 25. STM32F105xx/107xx bootloader versions

Bootloader version number	Description	
V1.0	Initial bootloader version	
V2.0	<ul> <li>Bootloader detection mechanism updated to fix the issue when GPIOs of unused peripherals in this bootloader are connected to low level or left floating during the detection phase.</li> <li>For more details please refer to Section 13.3.2.</li> <li>Vector table set to 0x1FFF B000 instead of 0x0000 0000</li> <li>Go command updated (for all bootloaders): USART1, USART2, CAN2, GPIOA, GPIOB, GPIOD and SysTick peripheral registers are set to their default reset values</li> <li>DFU bootloader: USB pending interrupt cleared before executing the Leave DFU command</li> <li>DFU subprotocol version changed from V1.0 to V1.2</li> <li>Bootloader version updated to V2.0</li> </ul>	
V2.1	<ul> <li>Fixed PA9 excessive consumption described in Section 13.3.4.</li> <li>Get-Version command (defined in AN3155) corrected. It returns 0x22 instead of 0x20 in bootloader V2.0. Refer to Section 13.3.3 for more details.</li> <li>Bootloader version updated to V2.1</li> </ul>	
V2.2	<ul> <li>Fixed DFU option bytes descriptor (set to 'e' instead of 'g' because it is read/write and not erasable).</li> <li>Fixed DFU polling timings for Flash Read/Write/Erase operations.</li> <li>Robustness enhancements for DFU bootloader interface.</li> <li>Updated bootloader version to V2.2.</li> </ul>	

### 13.3.1 How to identify STM32F105xx/107xx bootloader versions

Bootloader V1.0 is implemented on devices which date code is below 937 (refer to STM32F105xx and STM32F107xx datasheet for where to find the date code on the device marking). Bootloader V2.0 and V2.1 are implemented on devices with a date code higher or equal to 937.

There are two ways to distinguish between bootloader versions:

 When using the USART bootloader, the Get-Version command defined in AN2606 and AN3155 has been corrected in V2.1 version. It returns 0x22 instead of 0x20 as in bootloader V2.0.



- The values of the vector table at the beginning of the bootloader code are different. The
  user software (or via JTAG/SWD) reads 0x1FFFE945 at address 0x1FFFB004 for
  bootloader V2.0 0x1FFFE9A1 for bootloader V2.1, and 0x1FFFE9C1 for bootloader
  V2.2.
- The DFU version is the following:
  - V2.1 in bootloader V2.1
  - V2.2 in bootloader V2.2.

It can be read through the bcdDevice field of the DFU Device Descriptor.

# 13.3.2 Bootloader unavailability on STM32F105xx/STM32F107xx devices with a date code below 937

### **Description**

The bootloader cannot be used if the USART1\_RX (PA10), USART2\_RX (PD6, remapped), CAN2\_Rx (PB5, remapped), OTG\_FS\_DM (PA11), and/or OTG\_FS\_DP (PA12) pin(s) are held low or left floating during the bootloader activation phase.

The bootloader cannot be connected through CAN2 (remapped), DFU (OTG FS in Device mode), USART1 or USART2 (remapped).

On 64-pin packages, the USART2\_RX signal remapped PD6 pin is not available and it is internally grounded. In this case, the bootloader cannot be used at all.

### Workaround

- For 64-pin packages
   None. The bootloader cannot be used.
- For 100-pin packages

Depending on the used peripheral, the pins for the unused peripherals have to be kept at a high level during the bootloader activation phase as described below:

- If USART1 is used to connect to the bootloader, PD6 and PB5 have to be kept at a high level.
- If USART2 is used to connect to the bootloader, PA10, PB5, PA11 and PA12 have to be kept at a high level.
- If CAN2 is used to connect to the bootloader, PA10, PD6, PA11 and PA12 have to be kept at a high level.
- If DFU is used to connect to the bootloader, PA10, PB5 and PD6 have to be kept at a high level.

Note:

This limitation applies only to STM32F105xx and STM32F107xx devices with a date code below 937. STM32F105xx and STM32F107xx devices with a date code higher or equal to 937 are not impacted. See STM32F105xx and STM32F107xx datasheets for where to find the date code on the device marking.



# 13.3.3 USART bootloader Get-Version command returns 0x20 instead of 0x22

### **Description**

In USART mode, the Get-Version command (defined in AN3155) returns 0x20 instead of 0x20.

This limitation is present on bootloader versions V1.0 and V2.0, while it is fixed in bootloader version 2.1.

### Workaround

None.

# 13.3.4 PA9 excessive power consumption when USB cable is plugged in bootloader V2.0

### **Description**

When connecting a USB cable after booting from System-Memory mode, PA9 pin (connected to  $V_{BUS}$ =5 V) is also shared with USART TX pin which is configured as alternate push-pull and forced to 0 since the USART peripheral is not yet clocked. As a consequence, a current higher than 25 mA is drained by PA9 I/O and may affect the I/O pad reliability.

This limitation is fixed in bootloader version 2.1 by configuring PA9 as alternate function push-pull when a correct 0x7F is received on RX pin and the USART is clocked. Otherwise, PA9 is configured as alternate input floating.

### Workaround

None.



## 14 STM32F10xxx XL-density devices bootloader

## 14.1 Bootloader configuration

The STM32F10xxx XL-density bootloader is activated by applying pattern3 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader:

Table 26. STM32F10xxx XL-density configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
	RCC	HSI enabled	The system clock frequency is 24 MHz using the PLL.
	RAM	-	2 Kbyte starting from address 0x2000 0000 are used by the bootloader firmware.
Common to all	System memory	-	6 Kbyte starting from address 0x1FFF E000 contain the bootloader firmware.
bootloaders	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value and is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
USART1	USART1	Enabled	Once initialized, the USART1 configuration is: 8 bits, even parity and 1 Stop bit.
bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output push-pull	PA9 pin: USART1 in transmission mode
	USART2	Enabled	Once initialized, the USART2 configuration is: 8 bits, even parity and 1 Stop bit.
USART2 bootloader	USART2_RX pin	Input	PD6 pin: USART2 receives (remapped pins).
	USART2_TX pin	Output push-pull	PD5 pin: USART2 transmits (remapped pins).
USART1 and USART2 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host.

The system clock is derived from the embedded internal high-speed RC, no external quartz is required for the bootloader execution.

The figure below shows the bootloader selection mechanism.

System Reset BFB2 bit reset (BFB2 = 0)yes ▼ If Value @0x08080000 is within int. SRAM address Jump to user code in Bank2 no no If Value @0x08000000 is within int. SRAM address Jump to user code in Bank1 Continue Bootloader execution Disable all interrupt sources System Init (Clock, GPIOs, IWDG, SysTick) Configure Yes USARTx 0x7F received on Execute USARTx BL USART Loop for USARTx MS35006V1

Figure 16. Bootloader selection for STM32F10xxx XL-density devices

### 14.3 Bootloader version

The following table lists the STM32F10xxx XL-density devices bootloader versions:

Table 27. STM32F10xxx XL-density bootloader versions

Bootloader version number	Description
V2.1	Initial bootloader version



## 15 STM32F2xxxx devices bootloader

Two bootloader versions are available on STM32F2xxxx devices:

- V2.x supporting USART1 and USART3
   This version is embedded in STM32F2xxxx devices revision B.
- V3.x supporting USART1, USART3, CAN2 and DFU (USB FS Device)
   This version is embedded in STM32F2xxxx devices revision X and Y.

### 15.1 Bootloader V2.x

### 15.1.1 Bootloader configuration

The STM32F2xxxx bootloader is activated by applying pattern1 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 28. STM32F2xxxx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
	RCC	HSI enabled	The system clock frequency is 24 MHz.
	RAM	-	8 Kbyte starting from address 0x2000 0000.
	System memory	-	30688 byte starting from address 0x1FFF 0000 contain the bootloader firmware.
Common to all bootloaders	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value and is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
	Power	-	Voltage range is set to [1.62 V, 2.1 V]. In this range internal Flash write operations are allowed only in byte format (Half-Word, Word and Double-Word operations are not allowed). The voltage range can be configured in run time using bootloader commands.
USART1	USART1	Enabled	Once initialized, the USART1 configuration is: 8 bits, even parity and 1 Stop bit.
bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART3	USART3	Enabled	Once initialized, the USART3 configuration is: 8 bits, even parity and 1 Stop bit.
bootloader (on PC10/PC11)	USART3_RX pin	Input	PC11 pin: USART3 in reception mode
PC10/PC11)	USART3_TX pin	Output	PC10 pin: USART3 in transmission mode



Bootloader	Feature/Peripheral	State	Comment
USART3	USART3	Enabled	Once initialized, the USART3 configuration is: 8 bits, even parity and 1 Stop bit
bootloader (on PB10/PB11)	USART3_RX pin	Input	PB11 pin: USART3 in reception mode
	USART3_TX pin	Output	PB10 pin: USART3 in transmission mode
USART1 and USART3 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host.

Table 28. STM32F2xxxx configuration in system memory boot mode (continued)

The system clock is derived from the embedded internal high-speed RC. No external quartz is required for the bootloader code.

### 15.1.2 Bootloader selection

The figure below shows the bootloader selection mechanism.

System Reset

System Init (Clock, GPIOs, IWDG, SysTick)

Disable all interrupt sources

Configure
USARTx

Execute
BL\_USART\_Loop
for USARTx

MS35010V1

### 15.1.3 Bootloader version

This following table lists the STM32F2xxxx devices V2.x bootloader versions:

Table 29. STM32F2xxxx bootloader V2.x versions

Bootloader version number	Description	Known limitations
V2.0	Initial V2.x bootloader version	When a Read Memory command or Write Memory command is issued with an unsupported memory address and a correct address checksum (ie. address 0x6000 0000), the command is aborted by the bootloader device, but the NACK (0x1F) is not sent to the host. As a result, the next 2 bytes (which are the number of bytes to be read/written and its checksum) are considered as a new command and its checksum.  For the CAN interface, the Write Unprotect command is not functional. Instead you can use Write Memory command and write directly to the option bytes in order to disable the write protection. (1)

If the "number of data - 1" (N-1) to be read/written is not equal to a valid command code (0x00, 0x01, 0x02, 0x11, 0x21, 0x31, 0x43, 0x44, 0x63, 0x73, 0x82 or 0x92), then the limitation is not perceived from the host since the command is NACKed anyway (as an unsupported new command).



## 15.2 Bootloader V3.x

## 15.2.1 Bootloader configuration

The STM32F2xxxx bootloader is activated by applying pattern1 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 30. STM32F2xxxx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
	RCC	HSI enabled	The system clock frequency is 24 MHz using the PLL.  The HSI clock source is used at startup (interface detection phase) and when USARTx interfaces are selected (once CAN or DFU bootloader is selected, the clock source will be derived from the external crystal).
		HSE enabled	The system clock frequency is 60 MHz. The HSE clock source is used only when the CAN or the DFU (USB FS Device) interfaces are selected. The external clock must provide a frequency multiple of 1 MHz and ranging from 4 MHz to 26 MHz.
Common to all bootloaders		-	The Clock Security System (CSS) interrupt is enabled for the CAN and DFU bootloaders. Any failure (or removal) of the external clock generates system reset.
	RAM	-	8 Kbyte starting from address 0x20000000 are used by the bootloader firmware.
	System memory	-	30688 byte starting from address 0x1FF0 0000 contain the bootloader firmware.
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
	Power	-	Voltage range is set to [1.62 V, 2.1 V]. In this range internal Flash write operations are allowed only in byte format (Half-Word, Word and Double-Word operations are not allowed). The voltage range can be configured in run time using bootloader commands.



Table 30. STM32F2xxxx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
USART1 bootloader	USART1	Enabled	Once initialized, the USART1 configuration is: 8 bits, even parity and 1 Stop bit.
	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART3 bootloader	USART3	Enabled	Once initialized, the USART3 configuration is: 8 bits, even parity and 1 Stop bit.
(on PB10/PB11)	USART3_RX pin	Input	PB11 pin: USART3 in reception mode
	USART3_TX pin	Output	PB10 pin: USART3 in transmission mode
USART3 bootloader	USART3	Enabled	Once initialized, the USART3 configuration is: 8 bits, even parity and 1 Stop bit.
(on PC10/PC11)	USART3_RX pin	Input	PC11 pin: USART3 in reception mode
	USART3_TX pin	Output	PC10 pin: USART3 in transmission mode
USART1 and USART3 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.
CAN2 bootloader	CAN2	Enabled	Once initialized, the CAN2 configuration is: Baudrate 125 kbps, 11-bit identifier.  Note: CAN1 is clocked during CAN2 bootloader execution because CAN1 manages the communication between CAN2 and SRAM.
	CAN2_RX pin	Input	PB5 pin: CAN2 in reception mode
	CAN2_TX pin	Output	PB13 pin: CAN2 in transmission mode
DFU bootloader	USB	Enabled	USB OTG FS configured in Forced Device mode
	USB_DM pin	Input/Output	PA11: USB DM line.
	USB_DP pin		PA12: USB DP line No external Pull-up resistor is required
CAN2 and DFU bootloaders	TIM11	Enabled	This timer is used to determine the value of the HSE. Once the HSE frequency is determined, the system clock is configured to 60 MHz using PLL and HSE.

The system clock is derived from the embedded internal high-speed RC for USARTx bootloaders. This internal clock is also used for CAN and DFU (USB FS Device) but only for the selection phase. An external clock multiple of 1 MHz (between 4 and 26 MHz) is required for CAN and DFU bootloader execution after the selection phase.

The figure below shows the bootloader selection mechanism.

System Reset Disable all yes System Init (Clock, GPIOs, interrupt sources IWDG, SysTick) Configure Configure USB OTG FS USARTx device Execute 0x7F received on BL\_USART\_Loop for USARTx USARTx -yesno HSE detected Frame detected no on CANx pin yes yes no HSE detected Disable all no interrupt sources Generate System USB cable reset Reconfigure System Yes Detected clock to 60MHz Reconfigure System clock to 60MHz and Configure CAN USB clock to 48 MHz Execute Execute DFU BL\_CAN\_Loop for bootloader using USB CANx interrupts MS35011V1

Figure 18. Bootloader V3.x selection for STM32F2xxxx devices

### 15.2.3 Bootloader version

The following table lists the STM32F2xxxx devices V3.x bootloader versions:

Table 31. STM32F2xxxx bootloader V3.x versions

Bootloader version number	Description	Known limitations
V3.2	Initial V3.x bootloader version.	<ul> <li>When a Read Memory command or Write Memory command is issued with an unsupported memory address and a correct address checksum (ie. address 0x6000 0000), the command is aborted by the bootloader device, but the NACK (0x1F) is not sent to the host. As a result, the next 2 bytes (which are the number of bytes to be read/written and its checksum) are considered as a new command and its checksum<sup>(1)</sup>.</li> <li>Option bytes, OTP and Device Feature descriptors (in DFU interface) are set to "g" instead of "e" (not erasable memory areas).</li> </ul>
V3.3	Fix V3.2 limitations. DFU interface robustness enhancement.	<ul> <li>For the USART interface, two consecutive NACKs (instead of 1 NACK) are sent when a Read Memory or Write Memory command is sent and the RDP level is active.</li> <li>For the CAN interface, the Write Unprotect command is not functional. Instead you can use Write Memory command and write directly to the option bytes in order to disable the write protection.</li> </ul>

If the "number of data - 1" (N-1) to be read/written is not equal to a valid command code (0x00, 0x01, 0x02, 0x11, 0x21, 0x31, 0x43, 0x44, 0x63, 0x73, 0x82 or 0x92), then the limitation is not perceived from the host since the command is NACKed anyway (as an unsupported new command).



# 16 STM32F301xx/302x4(6/8) devices bootloader

## 16.1 Bootloader configuration

The STM32F301xx/302x4(6/8) bootloader is activated by applying pattern2 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 32. STM32F301xx/302x4(6/8) configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
Common to all bootloaders	RCC	HSI enabled	The system clock frequency is 48 MHz with HSI 48 MHz as clock source.
		HSE enabled	The external clock can be used for all bootloader interfaces and should have one the following values 24, 18,16, 12, 9, 8, 6, 4, 3 MHz.  The PLL is used to generate the USB 48 MHz clock and the 48 MHz clock for the system clock.
		-	The Clock Security System (CSS) interrupt is enabled for the DFU bootloader. Any failure (or removal) of the external clock generates system reset.
	RAM	-	6 Kbyte starting from address 0x20000000 are used by the bootloader firmware
	System memory	-	8 Kbyte starting from address 0x1FFFD800, contain the bootloader firmware
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
USART1 bootloader	USART1	Enabled	Once initialized the USART1 configuration is: 8-bits, even parity and 1 Stop bit
	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART2 bootloader	USART2	Enabled	Once initialized the USART2 configuration is: 8-bits, even parity and 1 Stop bit
	USART2_RX pin	Input	PA3 pin: USART2 in reception mode
	USART2_TX pin	Output	PA2 pin: USART2 in transmission mode
USART1 and USART2 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.



Table 32. STM32F301xx/302x4(6/8) configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
DFU bootloader	USB	Enabled	USB used in FS mode
	USB_DM pin	Input/Output	PA11: USB DM line.
	USB_DP pin		PA12: USB DP line An external pull-up resistor 1.5 KOhm must be connected to USB_DP pin.

The bootloader has two case of operation depending on the presence of the external clock (HSE) at bootloader startup:

- If HSE is present and has a value of 24, 18, 16, 12, 9, 8, 6, 4 or 3 MHz, the system clock is configured to 48 MHz with HSE as clock source. The DFU interface, USART1 and USART2 are functional and can be used to communicate with the bootloader device.
- If HSE is not present, the HSI is kept as default clock source and only USART1 and USART2 are functional.

The external clock (HSE) must be kept if it's connected at bootloader startup because it will be used as system clock source.



The figure below shows the bootloader selection mechanism.

System Reset Configure System clock to 48 MHz using HSI HSE= 24, 18, 16, 12, 9, 8, 6, 4, 3 MHz? Yes Reconfigure System clock to 48 MHz using HSE System Init (Clock, GPIOs, System Init (Clock, GPIOs, IWDG, SysTick) IWDG, SysTick) Configure USB FS device USB cable Detected & USB Disable all interrupt configured sources and other Disable other interfaces clock's no interfaces clock's Configure **USART**x 0x7F received on Execute DFU **USART**x bootloader using USB no Execute interrupts BL USART Loop for USARTx MS35027V1

Figure 19. Bootloader selection for STM32F301xx/302x4(6/8)

### 16.3 Bootloader version

The following table lists the STM32F301xx/302x4(6/8) devices bootloader versions:

Table 33. STM32F301xx/302x4(6/8) bootloader versions

Bootloader version number	Description	Known limitations
V4.0	Initial bootloader version	None



# 17 STM32F302xB(C)/303xB(C) devices bootloader

## 17.1 Bootloader configuration

The STM32F302xB(C)/303xB(C) bootloader is activated by applying pattern2 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 34. STM32F302xB(C)/303xB(C) configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
Common to all bootloaders	RCC	HSI enabled	At startup, the system clock frequency is configured to 48 MHz using the HSI. If an external clock (HSE) is not present, the system is kept clocked from the HSI.
		HSE enabled	The external clock can be used for all bootloader interfaces and should have one the following values 24, 18,16, 12, 9, 8, 6, 4, 3 MHz.  The PLL is used to generate the USB 48 MHz clock and the 48 MHz clock for the system clock.
		-	The Clock Security System (CSS) interrupt is enabled for the DFU bootloader. Any failure (or removal) of the external clock generates system reset.
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value and is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
	System memory	-	8 Kbyte starting from address 0x1FFFD800. This area contains the bootloader firmware
	RAM	-	5 Kbyte starting from address 0x20000000 are used by the bootloader firmware.
USART1 and USART2 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloader.
	USART1	Enabled	Once initialized, the USART1 configuration is: 8 bits, even parity and 1 Stop bit.
USART1 bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode



Table 34. STM32F302xB(C)/303xB(C) configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
USART2 bootloader	USART2	Enabled	Once initialized, the USART2 configuration is: 8 bits, even parity and 1 Stop bit. The USART2 uses its remapped pins.
	USART2_RX pin	Input	PD6 pin: USART2 in reception mode
	USART2_TX pin	Output	PD5 pin: USART2 in transmission mode
DFU bootloader	USB	Enabled	USB used in FS mode
	USB_DM pin	Input/Output	PA11: USB DM line.
	USB_DP pin		PA12: USB DP line An external pull-up resistor 1.5 KOhm must be connected to USB_DP pin.

The bootloader has two case of operation depending on the presence of the external clock (HSE) at bootloader startup:

- If HSE is present and has a value of 24, 18, 16, 12, 9, 8, 6, 4 or 3 MHz, the system clock is configured to 48 MHz with HSE as clock source. The DFU interface, USART1 and USART2 are functional and can be used to communicate with the bootloader device.
- If HSE is not present, the HSI is kept as default clock source and only USART1 and USART2 are functional.

The external clock (HSE) must be kept if it's connected at bootloader startup because it will be used as system clock source.



### 17.2 Bootloader selection

The figure below shows the bootloader selection mechanism.

System Reset Configure System clock to 48MHz using HSI HSE = 24, 18, 16, 12, 9, 8, 6, 4, 3 MHz yes Reconfigure System clock to 48MHz using HSE System Init (Clock, GPIOs, IWDG, SysTick) System Init (Clock, GPIOs, IWDG, SysTick) Configure USB USB configured Yes Execute DFU and cable Detected bootloader using USB Disable all interrupts interrupt sources No Configure USARTX 0x7F received Νo on USARTx Execute BL USART\_Loop for USARTx MS35016V3

Figure 20. Bootloader selection for STM32F302xB(C)/303xB(C) devices

#### 17.3 Bootloader version

The following table lists the STM32F302xB(C)/303xB(C) devices bootloader versions.

Table 35. STM32F302xB(C)/303xB(C) bootloader versions

Bootloader version number	Description	Known limitations
V4.1	Initial bootloader version	None



# 18 STM32F302xD(E)/303xD(E) devices bootloader

# 18.1 Bootloader configuration

.The STM32F302xD(E)/303xD(E) bootloader is activated by applying pattern2 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 36.STM32F302xD(E)/303xD(E) configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
		HSI enabled	The system clock frequency is 48 MHz with HSI 48 MHz as clock source.
	RCC	HSE enabled	The external clock can be used for all bootloader interfaces and should have one the following values 24, 18,16, 12, 9, 8, 6, 4, 3 MHz.  The PLL is used to generate the USB 48 MHz clock and the 48 MHz clock for the system clock.
Common to all bootloaders		-	The Clock Security System (CSS) interrupt is enabled for the DFU bootloader. Any failure (or removal) of the external clock generates system reset.
	RAM	-	6 Kbyte starting from address 0x20000000 are used by the bootloader firmware
	System memory	-	8 Kbyte starting from address 0x1FFFD800, contain the bootloader firmware
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
USART1	USART1	Enabled	Once initialized the USART1 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART2	USART2	Enabled	Once initialized the USART2 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART2_RX pin	Input	PA3 pin: USART2 in reception mode
	USART2_TX pin	Output	PA2 pin: USART2 in transmission mode
USART1 and USART2 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.
	USB	Enabled	USB FS configured in Forced Device mode. USB FS interrupt vector is enabled and used for USB DFU communications.
DFU bootloader	USB_DM pin		PA11 pin: USB FS DM line.
	USB_DP pin	Input/Output	PA12 pin: USB FS DP line. An external pull-up resistor 1.5 KOhm must be connected to USB_DP pin.



The bootloader has two cases of operation depending on the presence of the external clock (HSE) at bootloader startup:

- If HSE is present and has a value of 24, 18, 16, 12, 9, 8, 6, 4 or 3 MHz, the system clock is configured to 48 MHz with HSE as clock source. The DFU interface, USART1 and USART2 are functional and can be used to communicate with the bootloader device.
- If HSE is not present, the HSI is kept as default clock source and only USART1 and USART2 are functional.

The external clock (HSE) must be kept if it's connected at bootloader startup because it will be used as system clock source.

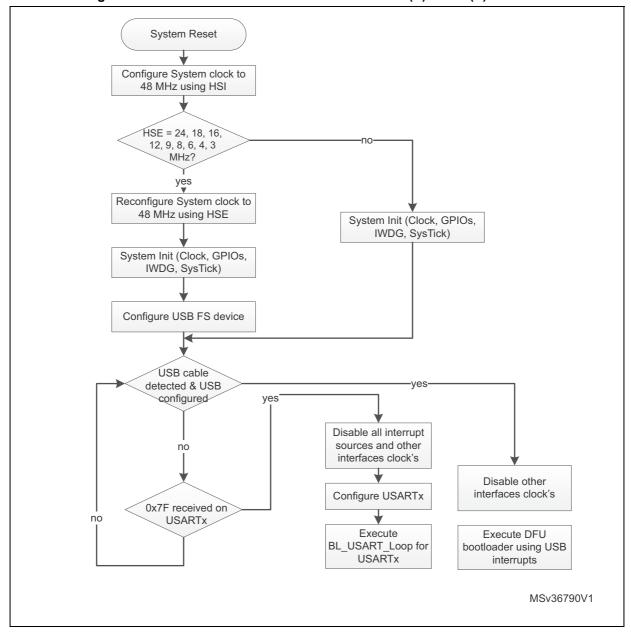




### 18.2 Bootloader selection

The figure below shows the bootloader selection mechanism.

Figure 21. Bootloader selection for STM32F302xD(E)/303xD(E)



### 18.3 Bootloader version

The following table lists the STM32F302xD(E)/303xD(E) devices bootloader versions.

Table 37.STM32F302xD(E)/303xD(E) bootloader versions

Bootloader version number	Description	Known limitations
V4.0	Initial bootloader version	None



## 19 STM32F303x4(6/8)/334xx/328xx devices bootloader

## 19.1 Bootloader configuration

The STM32F303x4(6/8)/334xx/328xx bootloader is activated by applying pattern2 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 38. STM32F303x4(6/8)/334xx/328xx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
	RCC	HSI enabled	The system clock frequency is 60 MHz with HSI 8 MHz as clock source.
	RAM	-	6 Kbyte starting from address 0x20000000 are used by the bootloader firmware
Common to all bootloaders	System memory	-	8 Kbyte starting from address 0x1FFFD800, contain the bootloader firmware
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
USART1	USART1	Enabled	Once initialized the USART1 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART2	USART2	Enabled	Once initialized the USART2 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART2_RX pin	Input	PA3 pin: USART2 in reception mode
	USART2_TX pin	Output	PA2 pin: USART2 in transmission mode
USART1 and USART2 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.
I2C1 bootloader	I2C1	Enabled	The I2C1 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0111111x (where x = 0 for write and x = 1 for read)
.231 50000000	I2C1_SCL pin	Input/Output	PB6 pin: clock line is used in open-drain mode.
	I2C1_SDA pin	Input/Output	PB7 pin: data line is used in open-drain mode.



The system clock is derived from the embedded internal high-speed RC, no external quartz is required for the bootloader execution.

#### 19.2 Bootloader selection

The figure below shows the bootloader selection mechanism.

System Reset Disable all interrupt sources System Init (Clock, GPIOs, IWDG, SysTick) Configure I2Cx 12C Address Execute detected Yes BL\_I2C\_Loop for Configure I2Cx USARTx Nο Execute BL\_USART\_Loop 0x7F received on for USARTx USART\_x Νo MS35029V1

Figure 22. Bootloader selection for STM32F303x4(6/8)/334xx/328xx

#### 19.3 Bootloader version

The following table lists the STM32F303x4(6/8)/334xx/328xx devices bootloader versions:

Bootloader version number

Description Known limitations

V5.0 Initial bootloader version None

Table 39. STM32F303x4(6/8)/334xx/328xx bootloader versions

### 20 STM32F318xx devices bootloader

## 20.1 Bootloader configuration

The STM32F318xx bootloader is activated by applying pattern2 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 40. STM32F318xx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
	RCC	HSI enabled	The system clock frequency is 60 MHz with HSI 8 MHz as clock source.
	RAM	-	6 Kbyte starting from address 0x20000000 are used by the bootloader firmware
Common to all bootloaders	System memory	-	8 Kbyte starting from address 0x1FFFD800, contain the bootloader firmware
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
USART1	USART1	Enabled	Once initialized the USART1 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART2	USART2	Enabled	Once initialized the USART2 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART2_RX pin	Input	PA3 pin: USART2 in reception mode
	USART2_TX pin	Output	PA2 pin: USART2 in transmission mode
USART1 and USART2 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.
I2C1 bootloader	I2C1	Enabled	The I2C1 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0111101x (where x = 0 for write and x = 1 for read)
2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	I2C1_SCL pin	Input/Output	PB6 pin: clock line is used in open-drain mode.
	I2C1_SDA pin	Input/Output	PB7 pin: data line is used in open-drain mode.



Bootloader	Feature/Peripheral	State	Comment
I2C3 bootloader	I2C3	Enabled	The I2C3 configuration is: I2C speed: up to 400 KHz, 7-bit address,slave mode, analog filter ON. Slave 7-bit address: 0b0111101x (where x = 0 for write and x = 1 for read) and digital filter disabled.
	I2C3_SCL pin	Input/Output	PA8 pin: clock line is used in open-drain mode.
	I2C3_SDA pin	Input/Output	PB5 pin: data line is used in open-drain mode.

Table 40. STM32F318xx configuration in system memory boot mode (continued)

The system clock is derived from the embedded internal high-speed RC, no external quartz is required for the bootloader execution.

### 20.2 Bootloader selection

The figure below shows the bootloader selection mechanism.

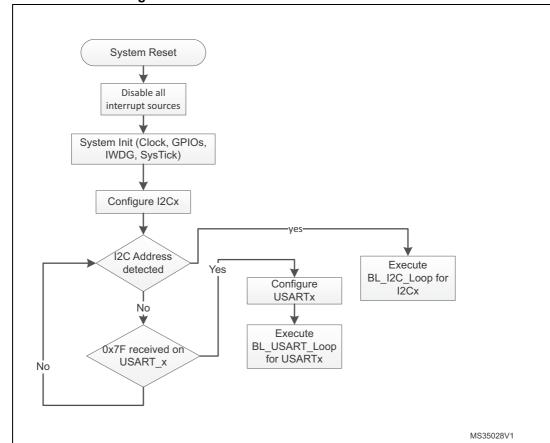


Figure 23. Bootloader selection for STM32F318xx

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### 20.3 Bootloader version

The following table lists the STM32F318xx devices bootloader versions:

Table 41. STM32F318xx bootloader versions

Bootloader version number	Description	Known limitations
V5.0	Initial bootloader version	None

### 21 STM32F358xx devices bootloader

## 21.1 Bootloader configuration

The STM32F358xx bootloader is activated by applying pattern2 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 42. STM32F358xx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
Common to all bootloaders	RCC	HSI enabled	The system clock frequency is 8 MHz using the HSI.
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value and is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user). Window feature is disabled.
	System memory	-	8 Kbyte starting from address 0x1FFFD800. This area contains the bootloader firmware.
	RAM	-	5 Kbyte starting from address 0x20000000 are used by the bootloader firmware.
USART1	USART1	Enabled	Once initialized, the USART1 configuration is: 8 bits, even parity and 1 Stop bit.
bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode.
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode.
USART2	USART2	Enabled	Once initialized, the USART2 configuration is: 8 bits, even parity and 1 Stop bit. The USART2 uses its remapped pins.
bootloader	USART2_RX pin	Input	PD6 pin: USART2 in reception mode.
	USART2_TX pin	Output	PD5 pin: USART2 in transmission mode.
USART1 and USART2 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloader.
I2C1 bootloader	I2C1	Enabled	The I2C1 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0110111x (where x = 0 for write and x = 1 for read)
	I2C1_SCL pin	Input/ Output	PB6 pin: clock line is used in open-drain mode.
	I2C1_SDA pin	Input/ Output	PB7 pin: data line is used in open-drain mode.

The system clock is derived from the embedded internal high-speed RC, no external quartz is required for the bootloader execution.

### 21.2 Bootloader selection

The figure below shows the bootloader selection mechanism.

System Reset Disable all interrupt sources System Init (Clock, GPIOs, IWDG, SysTick) Configure I2Cx 12C Address Execute detected Yes BL\_I2C\_Loop for Configure I2Cx **USART**x Νο Execute BL\_USART\_Loop for USARTx 0x7F received on USART\_x No MS35019V1

Figure 24. Bootloader selection for STM32F358xx devices

#### 21.3 Bootloader version

The following table lists the STM32F358xx devices bootloader versions.

Table 43. STM32F358xx bootloader versions

Bootloader version number	Description	Known limitations
V5.0	Initial bootloader version	For USART1 and USART2 interfaces, the maximum baudrate supported by the bootloader is 57600 baud.

### 22 STM32F373xx devices bootloader

## 22.1 Bootloader configuration

The STM32F373xx bootloader is activated by applying pattern2 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 44. STM32F373xx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
		HSI enabled	At startup, the system clock frequency is configured to 48 MHz using the HSI. If an external clock (HSE) is not present, the system is kept clocked from the HSI.
		HSE enabled	The external clock can be used for all bootloader interfaces and should have one the following values 24, 18,16, 12, 9, 8, 6, 4, 3 MHz.  The PLL is used to generate the USB 48 MHz clock and the 48 MHz clock for the system clock.
Common to all bootloaders		-	The Clock Security System (CSS) interrupt is enabled for the DFU bootloader. Any failure (or removal) of the external clock generates system reset.
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value and is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
	System memory	-	8 Kbyte starting from address 0x1FFFD800. This area contains the bootloader firmware
	RAM	-	5 Kbyte starting from address 0x20000000 are used by the bootloader firmware.
USART1 and USART2 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloader.
	USART1	Enabled	Once initialized, the USART1 configuration is: 8 bits, even parity and 1 Stop bit.
USART1 bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode

Bootloader	Feature/Peripheral	State	Comment
USART2 bootloader	USART2	Enabled	Once initialized, the USART2 configuration is: 8 bits, even parity and 1 Stop bit. The USART2 uses its remapped pins.
	USART2_RX pin	Input	PD6 pin: USART2 in reception mode
	USART2_TX pin	Output	PD5 pin: USART2 in transmission mode
DFU bootloader	USB	Enabled	USB used in FS mode
	USB_DM pin		PA11: USB DM line.
	USB_DP pin	Input/Output	PA12: USB DP line An external pull-up resistor 1.5 KOhm must be connected to USB_DP pin.

Table 44. STM32F373xx configuration in system memory boot mode (continued)

The bootloader has two case of operation depending on the presence of the external clock (HSE) at bootloader startup:

- If HSE is present and has a value of 24, 18, 16, 12, 9, 8, 6, 4 or 3 MHz, the system clock is configured to 48 MHz with HSE as clock source. The DFU interface, USART1 and USART2 are functional and can be used to communicate with the bootloader device.
- If HSE is not present, the HSI is kept as default clock source and only USART1 and USART2 are functional.

Note: The external clock (HSE) must be kept if it's connected at bootloader startup because it will be used as system clock source.



### 22.2 Bootloader selection

The figure below shows the bootloader selection mechanism.

System Reset Configure System clock to 48MHz using HSI HSE = 24, 18, 16, 12, 9, 8, 6, 4, 3 MHz yes Reconfigure System clock to 48MHz using HSE System Init (Clock, GPIOs, IWDG, SysTick) System Init (Clock, GPIOs, IWDG, SysTick) Configure USB USB configured Yes Execute DFU and cable Detected bootloader using USB Disable all interrupts interrupt sources No Configure USARTX 0x7F received No on USART\_x Execute BL USART Loop for USARTx MS35016V2

Figure 25. Bootloader selection for STM32F373xx devices

#### 22.3 Bootloader version

The following table lists the STM32F373xx devices bootloader versions.

Table 45. STM32F373xx bootloader versions

Bootloader version number	Description	Known limitations
V4.1	Initial bootloader version	None

## 23 STM32F378xx devices bootloader

## 23.1 Bootloader configuration

The STM32F378xx bootloader is activated by applying pattern2 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 46. STM32F378xx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
	RCC	HSI enabled	The system clock frequency is 8 MHz using the HSI.
Common to all bootloaders	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value and is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user). Window feature is disabled.
	System memory	-	8 Kbyte starting from address 0x1FFFD800. This area contains the bootloader firmware
	RAM	-	4 Kbyte starting from address 0x20000000 are used by the bootloader firmware.
USART1	USART1	Enabled	Once initialized, the USART1 configuration is: 8 bits, even parity and 1 Stop bit
bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode.
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode.
USART2 bootloader	USART2	Enabled	Once initialized, the USART2 configuration is: 8 bits, even parity and 1 Stop bit. The USART2 uses its remapped pins.
	USART2_RX pin	Input	PD6 pin: USART2 in reception mode.
	USART2_TX pin	Output	PD5 pin: USART2 in transmission mode.
USART1 and USART2 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloader.
I2C1	I2C1	Enabled	The I2C1 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0110111x (where x = 0 for write and x = 1 for read).
bootloader	I2C1_SCL pin	Input/ Output	PB6 pin: clock line is used in open-drain mode.
	I2C1_SDA pin	Input/ Output	PB7 pin: data line is used in open-drain mode.



The system clock is derived from the embedded internal high-speed RC, no external quartz is required for the bootloader execution.

### 23.2 Bootloader selection

The figure below shows the bootloader selection mechanism.

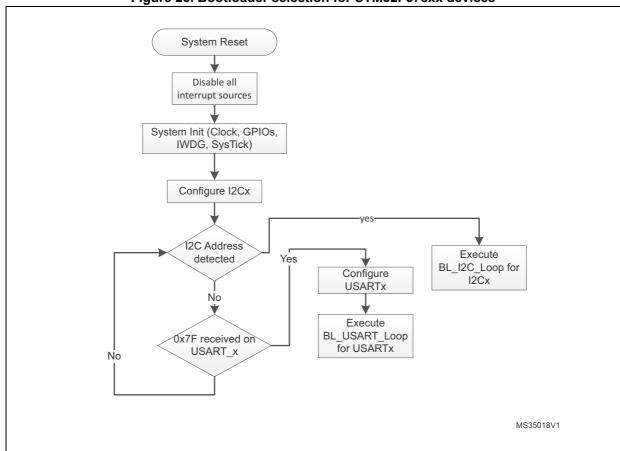


Figure 26. Bootloader selection for STM32F378xx devices

#### 23.3 Bootloader version

The following table lists the STM32F378xx devices bootloader versions.

Table 47. STM32F378xx bootloader versions

Bootloader version number	Description	Known limitations
V5.0	Initial bootloader version	For USART1 and USART2 interfaces, the maximum baudrate supported by the bootloader is 57600 baud.

### 24 STM32F398xx devices bootloader

## 24.1 Bootloader configuration

The STM32F398xx bootloader is activated by applying pattern2 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 48.STM32F398xx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
	RCC	HSI enabled	The system clock frequency is 60 MHz with HSI 8 MHz as clock source.
	RAM	-	6 Kbyte starting from address 0x20000000 are used by the bootloader firmware
Common to all bootloaders	System memory	-	7 Kbyte starting from address 0x1FFFD800, contain the bootloader firmware
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
USART1	USART1	Enabled	Once initialized the USART1 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART2	USART2	Enabled	Once initialized the USART2 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART2_RX pin	Input	PA3 pin: USART2 in reception mode
	USART2_TX pin	Output	PA2 pin: USART2 in transmission mode
USART1 and USART2 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.
			The I2C1 configuration is:
I2C1 bootloader	I2C1	Enabled	I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b1000000x (where x = 0 for write and x = 1 for read).
	I2C1_SCL pin	Input/Output	PB6 pin: clock line is used in open-drain mode.
	I2C1_SDA pin	Input/Output	PB7 pin: data line is used in open-drain mode.
I2C3 bootloader	I2C3	Enabled	The I2C3 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b1000000x (where x = 0 for write and x = 1 for read).
	I2C3_SCL pin	Input/Output	PA8 pin: clock line is used in open-drain mode.
	I2C3_SDA pin	Input/Output	PB5 pin: data line is used in open-drain mode.



The system clock is derived from the embedded internal high-speed RC for all bootloader interfaces. No external quartz is required for bootloader operations.

#### 24.2 Bootloader selection

The figure below shows the bootloader selection mechanism.

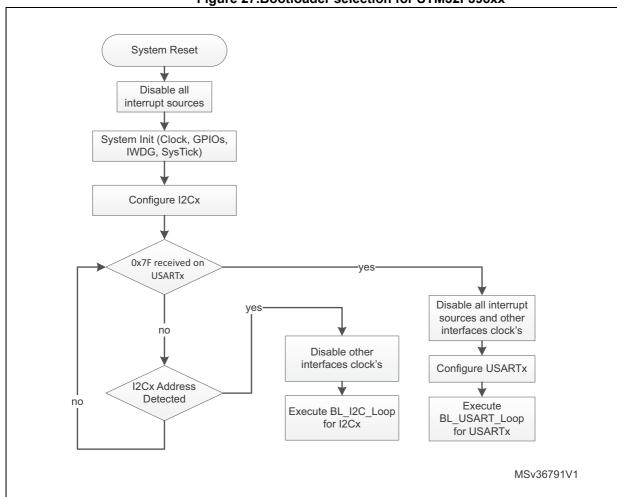


Figure 27.Bootloader selection for STM32F398xx

### 24.3 Bootloader version

The following table lists the STM32F398xx devices bootloader versions.

Table 49.STM32F398xx bootloader versions

Bootloader version number	Description	Known limitations
V5.0	Initial bootloader version	None

## 25 STM32F40xxx/41xxx devices bootloader

### 25.1 Bootloader V3.x

## 25.1.1 Bootloader configuration

The STM32F40xxx/41xxx bootloader is activated by applying pattern1 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 50. STM32F40xxx/41xxx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
		HSI enabled	The system clock frequency is 24 MHz using the PLL.  The HSI clock source is used at startup (interface detection phase) and when USARTx interfaces are selected (once CAN or DFU bootloader is selected, the clock source will be derived from the external crystal).
	RCC	HSE enabled	The system clock frequency is 60 MHz. The HSE clock source is used only when the CAN or the DFU (USB FS Device) interfaces are selected. The external clock must provide a frequency multiple of 1 MHz and ranging from 4 MHz to 26 MHz.
Common to all bootloaders		-	The Clock Security System (CSS) interrupt is enabled for the CAN and DFU bootloaders. Any failure (or removal) of the external clock generates system reset.
	RAM	-	8 Kbyte starting from address 0x20000000 are used by the bootloader firmware.
	System memory	-	30688 byte starting from address 0x1FFF 0000 contain the bootloader firmware.
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
	Power	-	Voltage range is set to [1.62 V, 2.1 V]. In this range internal Flash write operations are allowed only in byte format (Half-Word, Word and Double-Word operations are not allowed). The voltage range can be configured in run time using bootloader commands.



Table 50. STM32F40xxx/41xxx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
	USART1	Enabled	Once initialized, the USART1 configuration is: 8 bits, even parity and 1 Stop bit.
USART1 bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART3 bootloader	USART3	Enabled	Once initialized, the USART3 configuration is: 8 bits, even parity and 1 Stop bit.
(on PB10/PB11)	USART3_RX pin	Input	PB11 pin: USART3 in reception mode
	USART3_TX pin	Output	PB10 pin: USART3 in transmission mode
USART3 bootloader	USART3	Enabled	Once initialized, the USART3 configuration is: 8 bits, even parity and 1 Stop bit.
(on PC10/PC11)	USART3_RX pin	Input	PC11 pin: USART3 in reception mode
	USART3_TX pin	Output	PC10 pin: USART3 in transmission mode
USART1 and USART3 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.
CAN2 bootloader	CAN2	Enabled	Once initialized, the CAN2 configuration is: Baudrate 125 kbps, 11-bit identifier.  Note: CAN1 is clocked during CAN2 bootloader execution because CAN1 manages the communication between CAN2 and SRAM.
	CAN2_RX pin	Input	PB5 pin: CAN2 in reception mode
	CAN2_TX pin	Output	PB13 pin: CAN2 in transmission mode
	USB	Enabled	USB OTG FS configured in Forced Device mode
DFU bootloader	USB_DM pin		PA11: USB DM line.
	USB_DP pin	Input/Output	PA12: USB DP line No external Pull-up resistor is required
CAN2 and DFU bootloaders	TIM11	Enabled	This timer is used to determine the value of the HSE. Once the HSE frequency is determined, the system clock is configured to 60 MHz using PLL and HSE.

The system clock is derived from the embedded internal high-speed RC for USARTx bootloaders. This internal clock is also used for CAN and DFU (USB FS Device) but only for the selection phase. An external clock multiple of 1 MHz (between 4 and 26 MHz) is required for CAN and DFU bootloader execution after the selection phase.

#### 25.1.2 **Bootloader selection**

The figure below shows the bootloader selection mechanism.

System Reset Disable all yes System Init (Clock, GPIOs, interrupt sources IWDG, SysTick) Configure Configure USB OTG FS USARTx device Execute BL USART Loop 0x7F received on for USARTx **USART**x no HSE detected Frame detected no on CANx pin yes yes no ▼ HSE detected Disable all no interrupt sources Generate System USB cable Yes reset Reconfigure System Detected clock to 60MHz Reconfigure System clock to 60MHz and Configure CAN USB clock to 48 MHz Execute Execute DFU BL CAN Loop for bootloader using USB CANx interrupts MS35012V1

Figure 28. Bootloader V3.x selection for STM32F40xxx/41xxx devices

#### 25.1.3 Bootloader version

The following table lists the STM32F40xxx/41xxx devices V3.x bootloader versions:

Table 51. STM32F40xxx/41xxx bootloader V3.x versions

Bootloader version number	Description	Known limitations
V3.0	Initial bootloader version	<ul> <li>When a Read Memory command or Write Memory command is issued with an unsupported memory address and a correct address checksum (ie. address 0x6000 0000), the command is aborted by the bootloader device, but the NACK (0x1F) is not sent to the host. As a result, the next 2 bytes (which are the number of bytes to be read/written and its checksum) are considered as a new command and its checksum<sup>(1)</sup>.</li> <li>Option bytes, OTP and Device Feature descriptors (in DFU interface) are set to "g" instead of "e" (not erasable memory areas).</li> </ul>
V3.1	Fix V3.0 limitations. DFU interface robustness enhancement.	<ul> <li>For the USART interface, two consecutive NACKs (instead of 1 NACK) are sent when a Read Memory or Write Memory command is sent and the RDP level is active.</li> <li>For the CAN interface, the Write Unprotect command is not functional. Instead you can use Write Memory command and write directly to the option bytes in order to disable the write protection.</li> </ul>

If the "number of data - 1" (N-1) to be read/written is not equal to a valid command code (0x00, 0x01, 0x02, 0x11, 0x21, 0x31, 0x43, 0x44, 0x63, 0x73, 0x82 or 0x92), then the limitation is not perceived from the host since the command is NACKed anyway (as an unsupported new command).



### 25.2 Bootloader V9.x

### 25.2.1 Bootloader configuration

The STM32F40xxx/41xxx bootloader is activated by applying pattern1 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Note:

The bootloader version V9.x is only embedded in STM32F405xx/415xx WCSP90 package devices.

Table 52. STM32F40xxx/41xxx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
		HSI enabled	The system clock frequency is 60 MHz using the PLL.  The HSI clock source is used at startup (interface detection phase) and when USART or SPI or I2C interfaces are selected (once CAN or DFU bootloader is selected, the clock source will be derived from the external crystal).
	RCC	HSE enabled	The system clock frequency is 60 MHz. The HSE clock source is used only when the CAN or the DFU (USB FS Device) interfaces are selected. The external clock must provide a frequency multiple of 1 MHz and ranging from 4 MHz to 26 MHz.
Common to all		-	The Clock Security System (CSS) interrupt is enabled for the CAN and DFU bootloaders. Any failure (or removal) of the external clock generates system reset.
bootloaders	RAM	-	12 Kbyte starting from address 0x20000000 are used by the bootloader firmware
	System memory	-	30424 byte starting from address 0x1FFF0000, contain the bootloader firmware
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
	Power	-	Voltage range is set to [1.62 V, 2.1 V]. In this range internal Flash write operations are allowed only in byte format (Half-Word, Word and Double-Word operations are not allowed). The voltage range can be configured in run time using bootloader commands.



Table 52. STM32F40xxx/41xxx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
USART1	USART1	Enabled	Once initialized the USART1 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART3	USART3	Enabled	Once initialized the USART3 configuration is: 8-bits, even parity and 1 Stop bit
bootloader (on PB10/PB11)	USART3_RX pin	Input	PB11 pin: USART3 in reception mode
	USART3_TX pin	Output	PB10 pin: USART3 in transmission mode
USART3	USART3	Enabled	Once initialized the USART3 configuration is: 8-bits, even parity and 1 Stop bit
bootloader (on PC10/PC11)	USART3_RX pin	Input	PC11 pin: USART3 in reception mode
FC10/FC11)	USART3_TX pin	Output	PC10 pin: USART3 in transmission mode
USART1 and USART3 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.
CAN2 bootloader	CAN2	Enabled	Once initialized the CAN2 configuration is: Baudrate 125 kbps, 11-bit identifier.  Note: CAN1 is clocked during CAN2 bootloader execution because CAN1 manages the communication between CAN2 and SRAM.
	CAN2_RX pin	Input	PB5 pin: CAN2 in reception mode
	CAN2_TX pin	Output	PB13 pin: CAN2 in transmission mode
I2C1 bootloader	I2C1	Enabled	The I2C1 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0111010x (where x = 0 for write and x = 1 for read).
	I2C1_SCL pin	Input/Output	PB6 pin: clock line is used in open-drain mode.
	I2C1_SDA pin	Input/Output	PB7 pin: data line is used in open-drain mode.
I2C2 bootloader	I2C2	Enabled	The I2C2 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0111010x (where x = 0 for write and x = 1 for read).
	I2C2_SCL pin	Input/Output	PF1 pin: clock line is used in open-drain mode.
	I2C2_SDA pin	Input/Output	PF0 pin: data line is used in open-drain mode.



Table 52. STM32F40xxx/41xxx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
I2C3 bootloader	I2C3	Enabled	The I2C3 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0111010x (where x = 0 for write and x = 1 for read).
1200 30040000	I2C3_SCL pin	Input/Output	PA8 pin: clock line is used in open-drain mode.
	I2C3_SDA pin	Input/Output	PC9 pin: data line is used in open-drain mode.
	SPI1	Enabled	The SPI1 configuration is: slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI1_MOSI pin	Input	PA7 pin: Slave data Input line, used in Push-pull pull-down mode
SPI1 bootloader	SPI1_MISO pin	Output	PA6 pin: Slave data output line, used in Push-pull pull-down mode
	SPI1_SCK pin	Input	PA5 pin: Slave clock line, used in Push-pull pull-down mode
	SPI1_NSS pin	Input	PA4 pin: Slave Chip Select pin used in Push-pull pull-down mode.
	SPI2	Enabled	The SPI2 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI2_MOSI pin	Input	PI3 pin: Slave data Input line, used in Push- pull pull-down mode
SPI2 bootloader	SPI2_MISO pin	Output	PI2 pin: Slave data output line, used in Push-pull pull-down mode
	SPI2_SCK pin	Input	PI1 pin: Slave clock line, used in Push-pull pull-down mode
	SPI2_NSS pin	Input	PI0 pin: Slave Chip Select pin used in Push-pull pull-down mode.
	USB	Enabled	USB OTG FS configured in Forced Device mode
DFU bootloader	USB_DM pin		PA11: USB DM line.
	USB_DP pin	Input/Output	PA12: USB DP line
			No external Pull-up resistor is required
CAN2 and DFU bootloaders	TIM11	Enabled	This timer is used to determine the value of the HSE. Once the HSE frequency is determined, the system clock is configured to 60 MHz using PLL and HSE.



The system clock is derived from the embedded internal high-speed RC for USARTx, I2Cx and SPIx bootloaders. This internal clock is also used for CAN and DFU (USB FS Device) but only for the selection phase. An external clock multiple of 1 MHz (between 4 and 26 MHz) is required for CAN and DFU bootloader execution after the selection phase.



#### 25.2.2 Bootloader selection

The figure below shows the bootloader selection mechanism.

System Reset System Init (Clock, GPIOs, IWDG, SysTick) Configure USB OTG FS device Configure I2Cx Disable all interrupt sources Configure SPIx Configure USARTx Execute 0x7F received on BL USART Loo USARTx p for USARTx no yes Frame detected on CANx HSE detected ves HSE detected no Generate System yes Yes reset USB cable Detected Reconfigure System clock to 60MHz and Disable all Disable all interrupt interrupt sources USB clock to 48 MHz no yes Reconfigure System Execute DFU clock to 60MHz Execute
BL\_I2C\_Loop for I2Cx Address bootloader using Detected = 0x72 USB interrupts Configure CAN no Execute Disable all BL\_CAN\_Loop for interrupt sources CANx Plx detects Synchro mechanism Execute BL\_SPI\_Loop for SPIx MS35012V1

Figure 29. Bootloader V9.x selection for STM32F40xxx/41xxx



### 25.2.3 Bootloader version

The following table lists the STM32F40xxx/41xxx devices V9.x bootloader versions.

Table 53. STM32F40xxx/41xxx bootloader V9.x versions

Bootloader version number	Description	Known limitations
V9.0	This bootloader is an updated version of Bootloader v3.1. This new version of bootloader supports I2C1, I2C2, I2C3, SPI1 and SPI2 interfaces. The RAM used by this bootloader is increased from 8Kb to 12Kb. The ID of this bootloader is 0x90. The connection time is increased.	<ul> <li>For the USART interface, two consecutive NACKs (instead of 1 NACK) are sent when a Read Memory or Write Memory command is sent and the RDP level is active.</li> <li>For the CAN interface, the Write Unprotect command is not functional. Instead you can use Write Memory command and write directly to the option bytes in order to disable the write protection.</li> </ul>



# 26 STM32F401xB(C) devices bootloader

## 26.1 Bootloader configuration

The STM32F401xB(C) bootloader is activated by applying pattern1 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 54. STM32F401xB(C) configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
Common to all bootloaders	RCC	HSI enabled	The system clock frequency is 60 MHz using the PLL.  The HSI clock source is used at startup (interface detection phase) and when USART or SPI or I2C interfaces are selected (once DFU bootloader is selected, the clock source will be derived from the external crystal).
		HSE enabled	The system clock frequency is 60 MHz. The HSE clock source is used only when the DFU (USB FS Device) interfaces are selected. The external clock must provide a frequency multiple of 1 MHz and ranging from 4 MHz to 26 MHz.
		-	The Clock Security System (CSS) interrupt is enabled for the CAN and DFU bootloaders. Any failure (or removal) of the external clock generates system reset.
	RAM	-	12 Kbyte starting from address 0x20000000 are used by the bootloader firmware
	System memory	-	30424 byte starting from address 0x1FFF0000, contain the bootloader firmware
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
	Power	-	Voltage range is set to [1.62 V, 2.1 V]. In this range internal Flash write operations are allowed only in byte format (Half-Word, Word and Double-Word operations are not allowed). The voltage range can be configured in run time using bootloader commands.



Table 54. STM32F401xB(C) configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
USART1 bootloader	USART1	Enabled	Once initialized the USART1 configuration is: 8-bits, even parity and 1 Stop bit
	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART2	USART2	Enabled	Once initialized the USART2 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART2_RX pin	Input	PD6 pin: USART2 in reception mode
	USART2_TX pin	Output	PD5 pin: USART2 in transmission mode
USART1 and USART2 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.
I2C1 bootloader	I2C1	Enabled	The I2C1 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0111001x (where x = 0 for write and x = 1 for read)
	I2C1_SCL pin	Input/Output	PB6 pin: clock line is used in open-drain mode.
	I2C1_SDA pin	Input/Output	PB7 pin: data line is used in open-drain mode.
I2C2 bootloader	I2C2	Enabled	The I2C2 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0111001x (where x = 0 for write and x = 1 for read)
	I2C2_SCL pin	Input/Output	PB10 pin: clock line is used in open-drain mode.
	I2C2_SDA pin	Input/Output	PB3 pin: data line is used in open-drain mode.
I2C3 bootloader	I2C3	Enabled	The I2C3 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0111001x (where x = 0 for write and x = 1 for read)
	I2C3_SCL pin	Input/Output	PA8 pin: clock line is used in open-drain mode.
	I2C3_SDA pin	Input/Output	PB4 pin: data line is used in open-drain mode.



Table 54. STM32F401xB(C) configuration in system memory boot mode (continued)

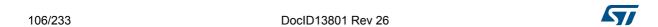
Bootloader	Feature/Peripheral	State	Comment
SPI1 bootloader	SPI1	Enabled	The SPI1 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI1_MOSI pin	Input	PA7 pin: Slave data Input line, used in Push-pull pull-down mode
	SPI1_MISO pin	Output	PA6 pin: Slave data output line, used in Push-pull pull-down mode
	SPI1_SCK pin	Input	PA5 pin: Slave clock line, used in Push-pull pull-down mode
	SPI1_NSS pin	Input	PA4 pin: Slave Chip Select pin used in Push-pull pull-down mode.
SPI2 bootloader	SPI2	Enabled	The SPI2 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI2_MOSI pin	Input	PB15 pin: Slave data Input line, used in Push-pull pull-down mode
	SPI2_MISO pin	Output	PB14 pin: Slave data output line, used in Push-pull pull-down mode
	SPI2_SCK pin	Input	PB13 pin: Slave clock line, used in Push- pull pull-down mode
	SPI2_NSS pin	Input	PB12 pin: Slave Chip Select pin used in Push-pull pull-down mode.
SPI3 bootloader	SPI3	Enabled	The SPI3 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI3_MOSI pin	Input	PC12 pin: Slave data Input line, used in Push-pull pull-down mode
	SPI3_MISO pin	Output	PC11 pin: Slave data output line, used in Push-pull pull-down mode
	SPI3_SCK pin	Input	PC10 pin: Slave clock line, used in Push- pull pull-down mode
	SPI3_NSS pin	Input	PA15 pin: Slave Chip Select pin used in Push-pull pull-down mode.



Table 54. STM32F401xB(C) configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
DFU bootloader	USB	Enabled	USB OTG FS configured in Forced Device mode
	USB_DM pin	Input/Output	PA11: USB DM line.
	USB_DP pin		PA12: USB DP line No external Pull-up resistor is required
	TIM11	Enabled	This timer is used to determine the value of the HSE. Once the HSE frequency is determined, the system clock is configured to 60 MHz using PLL and HSE.

The system clock is derived from the embedded internal high-speed RC for USARTx, I2Cx and SPIx bootloaders. This internal clock is also used for CAN and DFU (USB FS Device) but only for the selection phase. An external clock multiple of 1 MHz (between 4 and 26 MHz) is required for CAN and DFU bootloader execution after the selection phase.



### 26.2 Bootloader selection

The figure below shows the bootloader selection mechanism.

System Reset System Init (Clock, GPIOs, IWDG, SysTick) Configure USB OTG FS device Disable all interrupt sources Configure I2Cx Configure USARTx yes Configure SPIx Execute BL USART Loop for USARTx 0x7F received on **USART**x no HSE detected USB cable Detected Generate System Yes reset Disable all no interrupt sources Reconfigure System clock to 60MHz and USB clock to 48 MHz I2Cx Address Execute Detected BL\_I2C\_Loop for I2Cx no **Execute DFU** bootloader using USB yes interrupts Disable all interrupt sources SPIx detects Synchro mechanism Execute BL\_SPI\_Loop for MS35030V1 SPIx

Figure 30. Bootloader selection for STM32F401xB(C)



### 26.3 Bootloader version

The following table lists the STM32F401xB(C) devices bootloader version.

Table 55. STM32F401xB(C) bootloader versions

Bootloader version number	Description	Known limitations
V13.0	Initial bootloader version	None



# 27 STM32F401xD(E) devices bootloader

# 27.1 Bootloader configuration

The STM32F401xD(E) bootloader is activated by applying pattern1 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 56. STM32F401xD(E) configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
Common to all		HSI enabled	The system clock frequency is 60 MHz using the PLL.  The HSI clock source is used at startup (interface detection phase) and when USART or SPI or I2C interfaces are selected (once DFU bootloader is selected, the clock source will be derived from the external crystal).
	RCC	HSE enabled	The system clock frequency is 60 MHz. The HSE clock source is used only when the DFU (USB FS Device) interfaces are selected. The external clock must provide a frequency multiple of 1 MHz and ranging from 4 MHz to 26 MHz.
		-	The Clock Security System (CSS) interrupt is enabled for the CAN and DFU bootloaders. Any failure (or removal) of the external clock generates system reset.
bootloaders	RAM	-	12 Kbyte starting from address 0x20000000 are used by the bootloader firmware
	System memory	-	30424 byte starting from address 0x1FFF0000, contain the bootloader firmware
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
	Power	-	Voltage range is set to [1.62 V, 2.1 V]. In this range internal Flash write operations are allowed only in byte format (Half-Word, Word and Double-Word operations are not allowed). The voltage range can be configured in run time using bootloader commands.



Table 56. STM32F401xD(E) configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
USART1	USART1	Enabled	Once initialized the USART1 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART2	USART2	Enabled	Once initialized the USART2 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART2_RX pin	Input	PD6 pin: USART2 in reception mode
	USART2_TX pin	Output	PD5 pin: USART2 in transmission mode
USART1 and USART2 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.
I2C1 bootloader	I2C1	Enabled	The I2C1 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0111001x (where x = 0 for write and x = 1 for read)
	I2C1_SCL pin	Input/Output	PB6 pin: clock line is used in open-drain mode.
	I2C1_SDA pin	Input/Output	PB7 pin: data line is used in open-drain mode.
I2C2 bootloader	I2C2	Enabled	The I2C2 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0111001x (where x = 0 for write and x = 1 for read)
	I2C2_SCL pin Inp	Input/Output	PB10 pin: clock line is used in open-drain mode.
	I2C2_SDA pin	Input/Output	PB3 pin: data line is used in open-drain mode.
I2C3 bootloader	I2C3	Enabled	The I2C3 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0111001x (where x = 0 for write and x = 1 for read)
	I2C3_SCL pin	Input/Output	PA8 pin: clock line is used in open-drain mode.
	I2C3_SDA pin	Input/Output	PB4 pin: data line is used in open-drain mode.

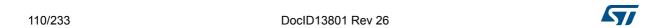


Table 56. STM32F401xD(E) configuration in system memory boot mode (continued)

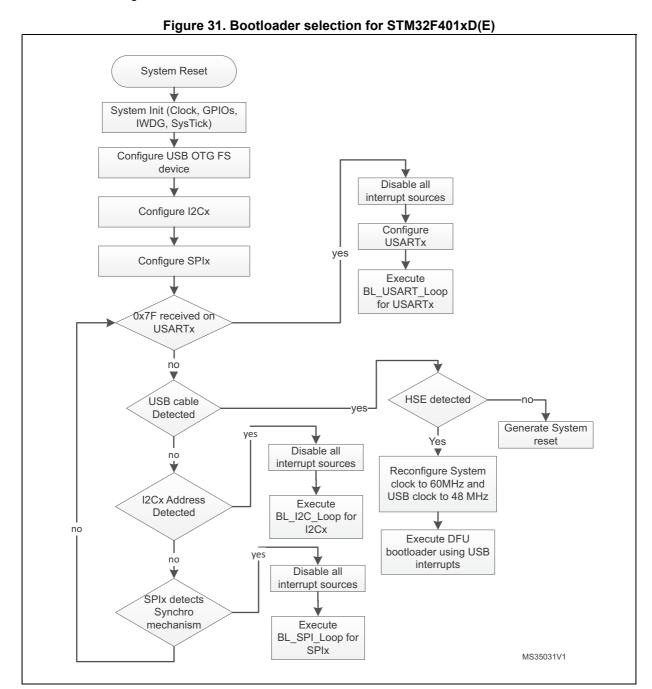
Bootloader	Feature/Peripheral	State	Comment
	SPI1	Enabled	The SPI1 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
SPI1 bootloader	SPI1_MOSI pin	Input	PA7 pin: Slave data Input line, used in Push-pull pull-down mode
	SPI1_MISO pin	Output	PA6 pin: Slave data output line, used in Push-pull pull-down mode
	SPI1_SCK pin	Input	PA5 pin: Slave clock line, used in Push-pull pull-down mode
	SPI1_NSS pin	Input	PA4 pin: Slave Chip Select pin used in Push-pull pull-down mode.
	SPI2	Enabled	The SPI2 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
SPI2 bootloader	SPI2_MOSI pin	Input	PB15 pin: Slave data Input line, used in Push-pull pull-down mode
	SPI2_MISO pin	Output	PB14 pin: Slave data output line, used in Push-pull pull-down mode
	SPI2_SCK pin	Input	PB13 pin: Slave clock line, used in Push- pull pull-down mode
	SPI2_NSS pin	Input	PB12 pin: Slave Chip Select pin used in Push-pull pull-down mode.
	SPI3	Enabled	The SPI3 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
SPI3 bootloader	SPI3_MOSI pin	Input	PC12 pin: Slave data Input line, used in Push-pull pull-down mode
	SPI3_MISO pin	Output	PC11 pin: Slave data output line, used in Push-pull pull-down mode
	SPI3_SCK pin	Input	PC10 pin: Slave clock line, used in Push- pull pull-down mode
	SPI3_NSS pin	Input	PA15 pin: Slave Chip Select pin used in Push-pull pull-down mode.
	USB	Enabled	USB OTG FS configured in Forced Device mode
	USB_DM pin		PA11: USB DM line.
DFU bootloader	USB_DP pin	Input/Output	PA12: USB DP line No external Pull-up resistor is required
	TIM11	Enabled	This timer is used to determine the value of the HSE. Once the HSE frequency is determined, the system clock is configured to 60 MHz using PLL and HSE.



The system clock is derived from the embedded internal high-speed RC for USARTx, I2Cx and SPIx bootloaders. This internal clock is also used for CAN and DFU (USB FS Device) but only for the selection phase. An external clock multiple of 1 MHz (between 4 and 26 MHz) is required for CAN and DFU bootloader execution after the selection phase.

### 27.2 Bootloader selection

The figure below shows the bootloader selection mechanism.





## 27.3 Bootloader version

The following table lists the STM32F401xD(E) devices bootloader version.

Table 57. STM32F401xD(E) bootloader versions

Bootloader version number	Description	Known limitations
V13.1	Initial bootloader version	None



## 28 STM32F410xx device bootloader

## 28.1 Bootloader configuration

The STM32F410xx bootloader is activated by applying pattern1 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 58. STM32F410xx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
	RCC	HSI enabled	The HSI is used at startup as clock source for system clock configured to 60 MHz and for USART and I2C bootloader operation.
	RAM	-	5 Kbyte starting from address 0x20000000 are used by the bootloader firmware
	System memory	-	30431 byte starting from address 0x1FF00000, contain the bootloader firmware
Common to all bootloaders	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
	Power	-	The voltage range is [1.8V, 3.6V] In this range: - Flash wait states 3 System clock Frequency 60 MHz ART Accelerator enabled Flash write operation by byte (refer to Bootloader Memory Management section for more information).
USART1	USART1	Enabled	Once initialized the USART1 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART2	USART2	Enabled	Once initialized the USART2 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART2_RX pin	Input	PA3 pin: USART2 in reception mode
	USART2_TX pin	Output	PA2 pin: USART2 in transmission mode
USARTx bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.

Table 58. STM32F410xx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
I2C1 bootloader	I2C1	Enabled	The I2C1 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b1000111x (where x = 0 for write and x = 1 for read)
	I2C1_SCL pin	Input/Output	PB6 pin: clock line is used in open-drain mode.
	I2C1_SDA pin	Input/Output	PB7 pin: data line is used in open-drain mode.
I2C2 bootloader	I2C2	Enabled	The I2C2 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b1000111x (where x = 0 for write and x = 1 for read)
	I2C2_SCL pin	Input/Output	PB10 pin: clock line is used in open-drain mode.
	I2C2_SDA pin	Input/Output	PB11 pin: data line is used in open-drain mode.
I2C4 bootloader	I2C4	Enabled	The I2C4 configuration is: I2C speed: up to 1 MHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b1000111x (where x = 0 for write and x = 1 for read)
	I2C4_SCL pin	Input/Output	PB15 pin: clock line is used in open-drain mode for STM32F410Cx/Rx devices. PB10 pin: clock line is used in open-drain mode for STM32F410Tx devices.
	I2C4_SDA pin	Input/Output	PB14 pin: data line is used in open-drain mode for STM32F410Cx/Rx devices. PB3 pin: data line is used in open-drain mode for STM32F410Tx devices.



Table 58. STM32F410xx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
	SPI1	Enabled	The SPI1 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI1_MOSI pin	Input	PA7 pin: Slave data Input line, used in Push-pull pull-down mode for STM32F410Cx/Rx devices. PB5 pin: Slave data Input line, used in Push-pull pull-down mode for STM32F410Tx devices.
SPI1 bootloader	SPI1_MISO pin	Output	PA6 pin: Slave data output line, used in Push-pull pull-down mode for STM32F410Cx/Rx devices. PB4 pin: Slave data output line, used in Push-pull pull-down mode for STM32F410Tx devices.
	SPI1_SCK pin	Input	PA5 pin: Slave clock line, used in Pushpull pull-down mode.
	SPI1_NSS pin	Input	PA4 pin: Slave Chip Select pin used in Push-pull pull-up mode for STM32F410Cx/Rx devices. PA15 pin: Slave Chip Select pin used in Push-pull pull-up mode for STM32F410Tx devices.
SPI2 bootloader	SPI2	Enabled	The SPI2 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI2_MOSI pin	Input	PC3 pin: Slave data Input line, used in Push-pull pull-down mode
	SPI2_MISO pin	Output	PC2 pin: Slave data output line, used in Push-pull pull-down mode
	SPI2_SCK pin	Input	PB13 pin: Slave clock line, used in Push- pull pull-down mode
	SPI2_NSS pin	Input	PB12 pin: Slave Chip Select pin used in Push-pull pull-up mode.

The system clock is derived from the embedded internal high-speed RC for all bootloader interfaces. No external quartz is required for bootloader operations.

### 28.2 Bootloader selection

The Figure 32 shows the bootloader selection mechanism.

System Reset Disable all interrupt sources System Init (Clock, GPIOs, IWDG, SysTick) Configure I2Cx Configure SPIx 0x7F received on USARTx No I2C Address -Yes Detected Disable all other No interfaces clocks Disable all other Disable all other interfaces clocks interfaces clocks Configure USARTx SPIx detects Synchro mechanism Execute Execute Execute BL SPI Loop for BL I2C Loop for BL USART Loop SPIx I2Cx for USARTx MSv38431V1

Figure 32.Bootloader V11.x selection for STM32F410xx



## 28.3 Bootloader version

The following table lists the STM32F410xx devices bootloader V11.x versions.

Table 59.STM32F410xx bootloader V11.x versions

Bootloader version number	Description	Known limitations
V11.0	Initial bootloader version	None
V11.1	Support I2C4 and SPI1 for STM32F410Tx devices.	None



# 29 STM32F411xx devices bootloader

# 29.1 Bootloader configuration

The STM32F411xx bootloader is activated by applying pattern1 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 60. STM32F411xx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
		HSI enabled	The system clock frequency is 60 MHz using the PLL.  The HSI clock source is used at startup (interface detection phase) and when USART or SPI or I2C interfaces are selected (once DFU bootloader is selected, the clock source will be derived from the external crystal).
	RCC	HSE enabled	The system clock frequency is 60 MHz. The HSE clock source is used only when the DFU (USB FS Device) interfaces are selected. The external clock must provide a frequency multiple of 1 MHz and ranging from 4 MHz to 26 MHz.
Common to all bootloaders		-	The Clock Security System (CSS) interrupt is enabled for the CAN and DFU bootloaders. Any failure (or removal) of the external clock generates system reset.
	RAM	-	12 Kbyte starting from address 0x20000000 are used by the bootloader firmware
	System memory	-	30424 byte starting from address 0x1FFF0000, contain the bootloader firm- ware
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
	Power	-	Voltage range is set to [1.62 V, 2.1 V]. In this range internal Flash write operations are allowed only in byte format (Half-Word, Word and Double-Word operations are not allowed). The voltage range can be configured in run time using bootloader commands.



Table 60. STM32F411xx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
USART1	USART1	Enabled	Once initialized the USART1 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART2	USART2	Enabled	Once initialized the USART2 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART2_RX pin	Input	PD6 pin: USART2 in reception mode
	USART2_TX pin	Output	PD5 pin: USART2 in transmission mode
USART1 and USART2 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.
I2C1 bootloader	I2C1	Enabled	The I2C1 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0111001x (where x = 0 for write and x = 1 for read)
120 1 2001104401	I2C1_SCL pin	Input/Output	PB6 pin: clock line is used in open-drain mode.
	I2C1_SDA pin	Input/Output	PB7 pin: data line is used in open-drain mode.
I2C2 bootloader	I2C2	Enabled	The I2C2 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0111001x (where x = 0 for write and x = 1 for read)
1202 bootioadei	I2C2_SCL pin	Input/Output	PB10 pin: clock line is used in open-drain mode.
	I2C2_SDA pin	Input/Output	PB3 pin: data line is used in open-drain mode.
I2C3 bootloader	I2C3	Enabled	The I2C3 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0111001x (where x = 0 for write and x = 1 for read)
	I2C3_SCL pin	Input/Output	PA8 pin: clock line is used in open-drain mode.
	I2C3_SDA pin	Input/Output	PB4 pin: data line is used in open-drain mode.

Table 60. STM32F411xx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
	SPI1	Enabled	The SPI1 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI1_MOSI pin	Input	PA7 pin: Slave data Input line, used in Push-pull pull-down mode
SPI1 bootloader	SPI1_MISO pin	Output	PA6 pin: Slave data output line, used in Push-pull pull-down mode
	SPI1_SCK pin	Input	PA5 pin: Slave clock line, used in Push-pull pull-down mode
	SPI1_NSS pin	Input	PA4 pin: Slave Chip Select pin used in Push-pull pull-down mode.
	SPI2	Enabled	The SPI2 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI2_MOSI pin	Input	PB15 pin: Slave data Input line, used in Push-pull pull-down mode
SPI2 bootloader	SPI2_MISO pin	Output	PB14 pin: Slave data output line, used in Push-pull pull-down mode
	SPI2_SCK pin	Input	PB13 pin: Slave clock line, used in Push- pull pull-down mode
	SPI2_NSS pin	Input	PB12 pin: Slave Chip Select pin used in Push-pull pull-down mode.
	SPI3	Enabled	The SPI3 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI3_MOSI pin	Input	PC12 pin: Slave data Input line, used in Push-pull pull-down mode
SPI3 bootloader	SPI3_MISO pin	Output	PC11 pin: Slave data output line, used in Push-pull pull-down mode
	SPI3_SCK pin	Input	PC10 pin: Slave clock line, used in Push- pull pull-down mode
	SPI3_NSS pin	Input	PA15 pin: Slave Chip Select pin used in Push-pull pull-down mode.



Table 60. STM32F411xx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
DFU bootloader	USB	Enabled	USB OTG FS configured in Forced Device mode
	USB_DM pin	PA11: USB DM line. Input/Output PA12: USB DP line No external Pull-up resistor is required	PA11: USB DM line.
	USB_DP pin		PA12: USB DP line No external Pull-up resistor is required
	TIM11	Enabled	This timer is used to determine the value of the HSE. Once the HSE frequency is determined, the system clock is configured to 60 MHz using PLL and HSE.

The system clock is derived from the embedded internal high-speed RC for USARTx, I2Cx and SPIx bootloaders. This internal clock is also used for CAN and DFU (USB FS Device) but only for the selection phase. An external clock multiple of 1 MHz (between 4 and 26 MHz) is required for CAN and DFU bootloader execution after the selection phase.

### 29.2 Bootloader selection

The figure below shows the bootloader selection mechanism.

System Reset System Init (Clock, GPIOs, IWDG, SysTick) Configure USB OTG FS device Disable all interrupt sources Configure I2Cx Configure **USART**x yes Configure SPIx Execute BL USART Loop for USARTx 0x7F received on **USART**x no HSE detected USB cable Detected Generate System yes Yes reset Disable all no interrupt sources Reconfigure System clock to 60MHz and USB clock to 48 MHz I2Cx Address Execute Detected BL\_I2C\_Loop for I2Cx Execute DFU bootloader using USB yes interrupts Disable all interrupt sources SPIx detects Synchro mechanism Execute BL\_SPI\_Loop for MS35032V1 SPIx

Figure 33. Bootloader selection for STM32F411xx

## 29.3 Bootloader version

The following table lists the STM32F411xx devices bootloader version.

Table 61. STM32F411xx bootloader versions

Bootloader version number	Description	Known limitations
V13.0	Initial bootloader version	None

## 30 STM32F412xx devices bootloader

# 30.1 Bootloader configuration

The STM32F412xx bootloader is activated by applying pattern1 (described in *Table 2: Bootloader activation patterns*). The table shows the hardware resources used by this bootloader.

Table 62.STM32F412xx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
		HSI enabled	The HSI is used at startup as clock source for system clock configured to 60 MHz and for USART and I2C bootloader operation.
	RCC	HSE enabled	The HSE is used only when the CAN or the DFU (USB FS Device) interfaces are selected. In this case the system clock configured to 60 MHz with HSE as clock source.  The HSE frequency must be multiple of 1 MHz and ranging from 4 MHz to 26 MHz.
		-	The Clock Security System (CSS) interrupt is enabled for the CAN and DFU bootloaders. Any failure (or removal) of the external clock generates system reset.
Common to all	RAM	-	16 Kbyte starting from address 0x20000000 are used by the bootloader firmware
bootloaders	System memory	-	61440 byte starting from address 0x1FF00000, contain the bootloader firmware
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
	Power	-	The voltage range is [1.8V, 3.6V] In this range: - Flash wait states 3 System clock Frequency 60 MHz ART Accelerator enabled Flash write operation by byte (refer to Bootloader Memory Management section for more information).



Table 62.STM32F412xx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
USART1	USART1	Enabled	Once initialized the USART1 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART2	USART2	Enabled	Once initialized the USART2 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART2_RX pin	Input	PD6 pin: USART2 in reception mode
	USART2_TX pin	Output	PD5 pin: USART2 in transmission mode
USART3	USART3	Enabled	Once initialized the USART3 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART3_RX pin	Input	PB11 pin: USART3 in reception mode
	USART3_TX pin	Output	PB10 pin: USART3 in transmission mode
USARTx bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.
CAN2 bootloader	CAN2	Enabled	Once initialized the CAN2 configuration is: Baudrate 125 kbps, 11-bit identifier.  Note: CAN1 is clocked during CAN2 bootloader execution because CAN1 manages the communication between CAN2 and SRAM.
	CAN2_RX pin	Input	PB5 pin: CAN2 in reception mode
	CAN2_TX pin	Output	PB13 pin: CAN2 in transmission mode
I2C1 bootloader	I2C1	Enabled	The I2C1 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b1000110x (where x = 0 for write and x = 1 for read)
	I2C1_SCL pin	Input/Output	PB6 pin: clock line is used in open-drain mode.
	I2C1_SDA pin	Input/Output	PB7 pin: data line is used in open-drain mode.
I2C2 bootloader	I2C2	Enabled	The I2C2 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b1000110x (where x = 0 for write and x = 1 for read)
	I2C2_SCL pin	Input/Output	PF1 pin: clock line is used in open-drain mode.
	I2C2_SDA pin	Input/Output	PF0 pin: data line is used in open-drain mode.

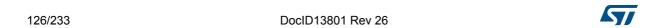


Table 62.STM32F412xx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
I2C3 bootloader	I2C3	Enabled	The I2C3 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b1000110x (where x = 0 for write and x = 1 for read)
	I2C3_SCL pin	Input/Output	PA8 pin: clock line is used in open-drain mode.
	I2C3_SDA pin	Input/Output	PB4 pin: data line is used in open-drain mode.
I2C4 bootloader	I2C4	Enabled	The I2C4 configuration is: I2C speed: up to 1 MHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b1000110x (where x = 0 for write and x = 1 for read)
	I2C4_SCL pin	Input/Output	PB15 pin: clock line is used in open-drain mode.
	I2C4_SDA pin	Input/Output	PB14 pin: data line is used in open-drain mode.
	SPI1	Enabled	The SPI1 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI1_MOSI pin	Input	PA7 pin: Slave data Input line, used in Push-pull pull-down mode
SPI1 bootloader	SPI1_MISO pin	Output	PA6 pin: Slave data output line, used in Push-pull pull-down mode
	SPI1_SCK pin	Input	PA5 pin: Slave clock line, used in Push-pull pull-down mode
	SPI1_NSS pin	Input	PA4 pin: Slave Chip Select pin used in Push-pull pull-up mode.
	SPI3	Enabled	The SPI3 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI3_MOSI pin	Input	PC12 pin: Slave data Input line, used in Push-pull pull-down mode
SPI3 bootloader	SPI3_MISO pin	Output	PC11 pin: Slave data output line, used in Push-pull pull-down mode
	SPI3_SCK pin	Input	PC10 pin: Slave clock line, used in Push- pull pull-down mode
	SPI3_NSS pin	Input	PA15 pin: Slave Chip Select pin used in Push-pull pull-up mode.



Table 62.STM32F412xx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
	SPI4	Enabled	The SPI4 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI4_MOSI pin	Input	PE14 pin: Slave data Input line, used in Push-pull pull-down mode
SPI4 bootloader	SPI4_MISO pin	Output	PE13 pin: Slave data output line, used in Push-pull pull-down mode
	SP4_SCK pin	Input	PE12 pin: Slave clock line, used in Push- pull pull-down mode
	SPI4_NSS pin	Input	PE11 pin: Slave Chip Select pin used in Push-pull pull-up mode.
	USB	Enabled	USB OTG FS configured in Forced Device mode
DFU bootloader	USB_DM pin		PA11 pin: USB DM line.
USE	USB_DP pin	Input/Output	PA12 pin: USB DP line No external Pull-Up resistor is required.
CAN2 and DFU bootloaders	TIM11	Enabled	This timer is used to determine the value of the HSE. Once HSE frequency is determined, the system clock is configured to 60 MHz using PLL and HSE.

The system clock is derived from the embedded internal high-speed RC for USARTx and I2Cx bootloaders. This internal clock is also used for CAN and DFU (USB FS Device) but only for the selection phase. An external clock multiple of 1 MHz (between 4 and 26 MHz) is required for CAN and DFU bootloader execution after the selection phase.

### 30.2 Bootloader selection

The Figure 34 shows the bootloader selection mechanism.

System Reset System Init (Clock, GPIOs, IWDG, SysTick) ves-Configure USB OTG FS device Disable all interrupt ves sources and other interfaces clocks Configure I2Cx Disable all interrupt Disable all interrupt sources and other Configure sources and other **USART**x interfaces clocks interfaces clocks Configure SPIx Execute Execute Execute BL SPI Loop BL I2C Loop BL\_USART\_Loop for I2Cx for USARTx for SPIx 0x7F received on USARTx no ves 12C Address Detected no HSE detected HSE detected Generate System Synchro mechanism yes detected on SPIx yes reset Disable all interrupt Disable other sources and other interfaces clocks no interfaces clocks no Reconfigure System Reconfigure System Frame detected clock to 60MHz and clock to 60MHz on CANx USB clock to 48 MHz Configure CAN no Execute DFU bootloader using USB interrupts USB cable Execute Detected BL CAN Loop for CAN2 MSv38454V1

Figure 34.Bootloader V9.x selection for STM32F412xx

## 30.3 Bootloader version

The following table lists the STM32F412xx devices bootloader V9.x versions.

Table 63.STM32F412xx bootloader V9.x versions

Bootloader version number	Description	Known limitations
V9.0	Initial bootloader version	None
V9.1	Fix USART3 interface pinout	None

## 31 STM32F42xxx/43xxx devices bootloader

#### 31.1 Bootloader V7.x

### 31.1.1 Bootloader configuration

The STM32F42xxx/43xxx bootloader is activated by applying pattern5 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 64. STM32F42xxx/43xxx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
		HSI enabled	The system clock frequency is 24 MHz using the PLL.  The HSI clock source is used at startup (interface detection phase) and when USART or I2C interfaces are selected (once CAN or DFU bootloader is selected, the clock source will be derived from the external crystal).
	RCC	HSE enabled	The system clock frequency is 60 MHz. The HSE clock source is used only when the CAN or the DFU (USB FS Device) interfaces are selected. The external clock must provide a frequency multiple of 1 MHz and ranging from 4 MHz to 26 MHz.
Common to all		-	The Clock Security System (CSS) interrupt is enabled for the CAN and DFU bootloaders. Any failure (or removal) of the external clock generates system reset.
bootloaders	RAM	-	8 Kbyte starting from address 0x20000000 are used by the bootloader firmware
	System memory	-	30424 byte starting from address 0x1FFF0000, contain the bootloader firmware
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
	Power	-	Voltage range is set to [1.62 V, 2.1 V]. In this range internal Flash write operations are allowed only in byte format (Half-Word, Word and Double-Word operations are not allowed). The voltage range can be configured in run time using bootloader commands.



Table 64. STM32F42xxx/43xxx configuration in system memory boot mode (continued)

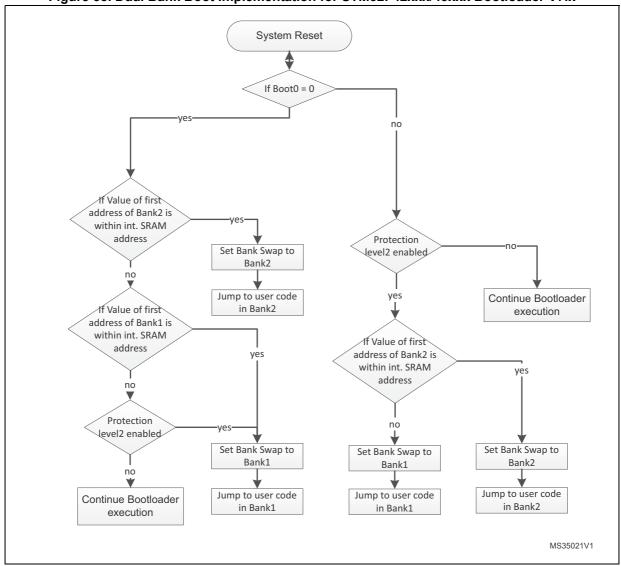
Bootloader	Feature/Peripheral	State	Comment
USART1	USART1	Enabled	Once initialized the USART1 configuration is: 8 bits, even parity and 1 Stop bit
bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART3	USART3	Enabled	Once initialized the USART3 configuration is: 8 bits, even parity and 1 Stop bit
bootloader (on PB10/PB11)	USART3_RX pin	Input	PB11 pin: USART3 in reception mode
	USART3_TX pin	Output	PB10 pin: USART3 in transmission mode
USART3	USART3	Enabled	Once initialized the USART3 configuration is: 8 bits, even parity and 1 Stop bit
bootloader (on PC10/PC11)	USART3_RX pin	Input	PC11 pin: USART3 in reception mode
(6.1. 6.16/1 6.1.)	USART3_TX pin	Output	PC10 pin: USART3 in transmission mode
USART1 and USART3 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.
CAN2 bootloader	CAN2	Enabled	Once initialized the CAN2 configuration is: Baudrate 125 kbps, 11-bit identifier.  Note: CAN1 is clocked during CAN2 bootloader execution because CAN1 manages the communication between CAN2 and SRAM.
	CAN2_RX pin	Input	PB5 pin: CAN2 in reception mode
	CAN2_TX pin	Output	PB13 pin: CAN2 in transmission mode
I2C1 bootloader	I2C1	Enabled	The I2C1 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0111000x (where x = 0 for write and x = 1 for read).
	I2C1_SCL pin	Input/Output	PB6 pin: clock line is used in open-drain mode.
	I2C1_SDA pin	Input/Output	PB9 pin: data line is used in open-drain mode.
	USB	Enabled	USB OTG FS configured in Forced Device mode
DFU bootloader	USB_DM pin		PA11: USB DM line.
	LIOD DDi	Input/Output	PA12: USB DP line
	USB_DP pin		No external Pull-up resistor is required
CAN2 and DFU bootloaders	TIM11	Enabled	This timer is used to determine the value of the HSE. Once the HSE frequency is determined, the system clock is configured to 60 MHz using PLL and HSE.

The system clock is derived from the embedded internal high-speed RC for USARTx and I2Cx bootloaders. This internal clock is also used for CAN and DFU (USB FS Device) but only for the selection phase. An external clock multiple of 1 MHz (between 4 and 26 MHz) is required for CAN and DFU bootloader execution after the selection phase.

#### 31.1.2 Bootloader selection

The figures below show the bootloader selection mechanism.

Figure 35. Dual Bank Boot Implementation for STM32F42xxx/43xxx Bootloader V7.x





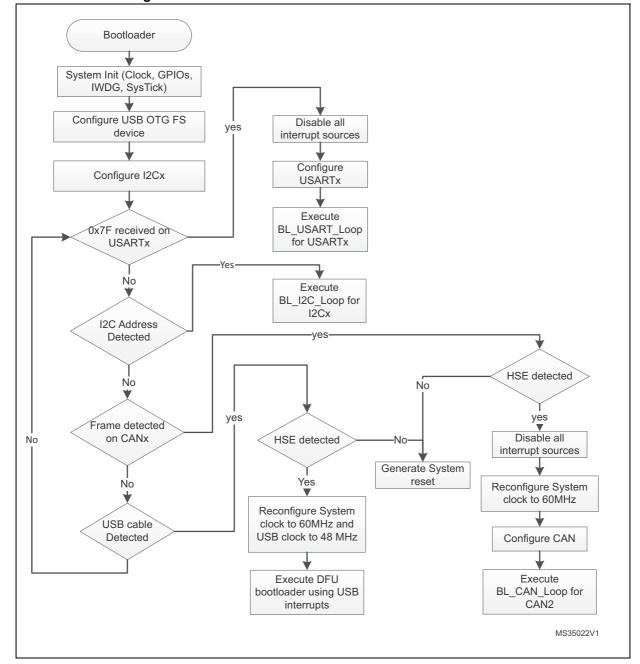


Figure 36. Bootloader V7.x selection for STM32F42xxx/43xxx



#### 31.1.3 Bootloader version

The following table lists the STM32F42xxx/43xxx devices bootloader V7.x versions.

Table 65. STM32F42xxx/43xxx bootloader V7.x versions

Bootloader version number	Description	Known limitations
V7.0	Initial bootloader version	For the CAN interface, the Write Unprotect command is not functional. Instead you can use Write Memory command and write directly to the option bytes in order to disable the write protection.

### 31.2 Bootloader V9.x

## 31.2.1 Bootloader configuration

The STM32F42xxx/43xxx bootloader is activated by applying pattern5 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.



Table 66. STM32F42xxx/43xxx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
		HSI enabled	The system clock frequency is 60 MHz using the PLL.  The HSI clock source is used at startup (interface detection phase) and when USART or SPI or I2C interfaces are selected (once CAN or DFU bootloader is selected, the clock source will be derived from the external crystal).
	RCC	HSE enabled	The system clock frequency is 60 MHz. The HSE clock source is used only when the CAN or the DFU (USB FS Device) interfaces are selected. The external clock must provide a frequency multiple of 1 MHz and ranging from 4 MHz to 26 MHz.
Common to all		-	The Clock Security System (CSS) interrupt is enabled for the CAN and DFU bootloaders. Any failure (or removal) of the external clock generates system reset.
bootloaders	RAM	-	12 Kbyte starting from address 0x20000000 are used by the bootloader firmware
	System memory	-	30424 byte starting from address 0x1FFF0000, contain the bootloader firmware
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
	Power	-	Voltage range is set to [1.62 V, 2.1 V]. In this range internal Flash write operations are allowed only in byte format (Half-Word, Word and Double-Word operations are not allowed). The voltage range can be configured in run time using bootloader commands.
USART1	USART1	Enabled	Once initialized the USART1 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART3	USART3	Enabled	Once initialized the USART3 configuration is: 8-bits, even parity and 1 Stop bit
bootloader (on PB10/PB11)	USART3_RX pin	Input	PB11 pin: USART3 in reception mode
	USART3_TX pin	Output	PB10 pin: USART3 in transmission mode

Table 66. STM32F42xxx/43xxx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
USART3	USART3	Enabled	Once initialized the USART3 configuration is: 8-bits, even parity and 1 Stop bit
bootloader (on PC10/PC11)	USART3_RX pin	Input	PC11 pin: USART3 in reception mode
	USART3_TX pin	Output	PC10 pin: USART3 in transmission mode
USART1 and USART3 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.
CAN2 bootloader	CAN2	Enabled	Once initialized the CAN2 configuration is: Baudrate 125 kbps, 11-bit identifier.  Note: CAN1 is clocked during CAN2 bootloader execution because CAN1 manages the communication between CAN2 and SRAM.
	CAN2_RX pin	Input	PB5 pin: CAN2 in reception mode
	CAN2_TX pin	Output	PB13 pin: CAN2 in transmission mode
I2C1 bootloader	I2C1	Enabled	The I2C1 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0111000x (where x = 0 for write and x = 1 for read).
	I2C1_SCL pin	Input/Output	PB6 pin: clock line is used in open-drain mode.
	I2C1_SDA pin	Input/Output	PB9 pin: data line is used in open-drain mode.
I2C2 bootloader	12C2	Enabled	The I2C2 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0111000x (where x = 0 for write and x = 1 for read).
	I2C2_SCL pin	Input/Output	PF1 pin: clock line is used in open-drain mode.
	I2C2_SDA pin	Input/Output	PF0 pin: data line is used in open-drain mode.
I2C3 bootloader	12C3	Enabled	The I2C3 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0111000x (where x = 0 for write and x = 1 for read).
, , , , , , , , , , , , , , , , , , , ,	I2C3_SCL pin	Input/Output	PA8 pin: clock line is used in open-drain mode.
	I2C3_SDA pin	Input/Output	PC9 pin: data line is used in open-drain mode.



Table 66. STM32F42xxx/43xxx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
	SPI1	Enabled	The SPI1 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI1_MOSI pin	Input	PA7 pin: Slave data Input line, used in Push-pull pull-down mode
SPI1 bootloader	SPI1_MISO pin	Output	PA6 pin: Slave data output line, used in Push-pull pull-down mode
	SPI1_SCK pin	Input	PA5 pin: Slave clock line, used in Push-pull pull-down mode
	SPI1_NSS pin	Input	PA4 pin: Slave Chip Select pin used in Push-pull pull-down mode.
	SPI2	Enabled	The SPI2 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI2_MOSI pin	Input	PI3 pin: Slave data Input line, used in Push- pull pull-down mode
SPI2 bootloader	SPI2_MISO pin	Output	PI2 pin: Slave data output line, used in Push-pull pull-down mode
	SPI2_SCK pin	Input	PI1 pin: Slave clock line, used in Push-pull pull-down mode
	SPI2_NSS pin	Input	PI0 pin: Slave Chip Select pin used in Push-pull pull-down mode.
	SPI4	Enabled	The SPI4 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI4_MOSI pin	Input	PE14 pin: Slave data Input line, used in Push-pull pull-down mode
SPI4 bootloader	SPI4_MISO pin	Output	PE13 pin: Slave data output line, used in Push-pull pull-down mode
	SP4_SCK pin	Input	PE12 pin: Slave clock line, used in Push- pull pull-down mode
	SPI4_NSS pin	Input	PE11 pin: Slave Chip Select pin used in Push-pull pull-down mode.

Table 66. STM32F42xxx/43xxx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
DFU bootloader	USB	Enabled	USB OTG FS configured in Forced Device mode
	USB_DM pin	Input/Output	PA11: USB DM line.
	USB_DP pin		PA12: USB DP line No external Pull-up resistor is required
CAN2 and DFU bootloaders	TIM11	Enabled	This timer is used to determine the value of the HSE. Once the HSE frequency is determined, the system clock is configured to 60 MHz using PLL and HSE.

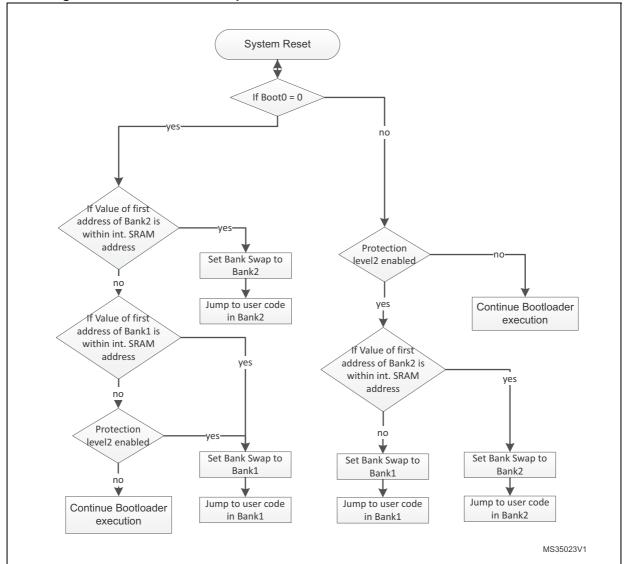
The system clock is derived from the embedded internal high-speed RC for USARTx, I2Cx and SPIx bootloaders. This internal clock is also used for CAN and DFU (USB FS Device) but only for the selection phase. An external clock multiple of 1 MHz (between 4 and 26 MHz) is required for CAN and DFU bootloader execution after the selection phase.



#### 31.2.2 Bootloader selection

The figures below show the bootloader selection mechanism.

Figure 37. Dual Bank Boot Implementation for STM32F42xxx/43xxx Bootloader V9.x



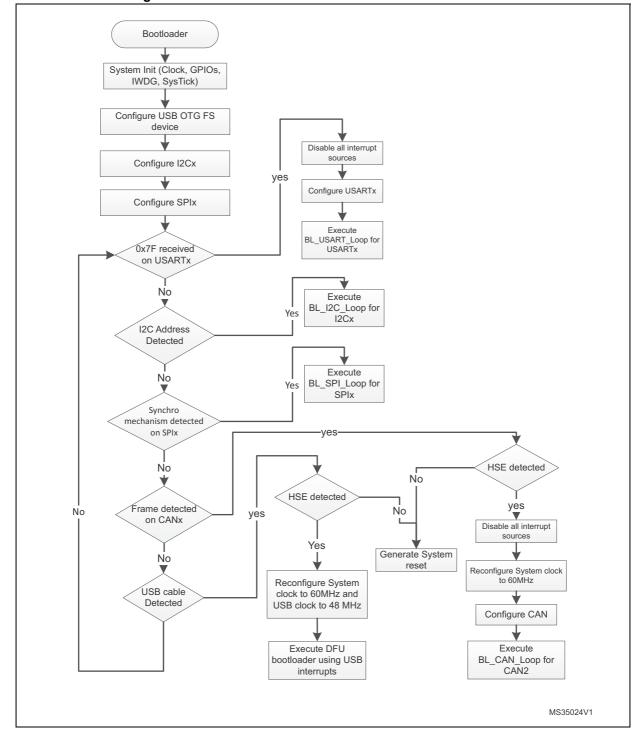


Figure 38. Bootloader V9.x selection for STM32F42xxx/43xxx



### 31.2.3 Bootloader version

The following table lists the STM32F42xxx/43xxx devices bootloader V9.x versions.

Table 67. STM32F42xxx/43xxx bootloader V9.x versions

Bootloader version number	Description	Known limitations
V9.0	This bootloader is an updated version of Bootloader v7.0. This new version of bootloader supports I2C2, I2C3, SPI1, SPI2 and SPI4 interfaces. The RAM used by this bootloader is increased from 8Kb to 12Kb. The ID of this bootloader is 0x90 The connection time is increased.	None
V9.1	This bootloader is an updated version of Bootloader v9.0. This new version implements the new I2C No-stretch commands (I2C protocol v1.1) and the capability of disabling PcROP when RDP1 is enabled with ReadOutUnprotect command for all protocols(USB, USART, CAN, I2C and SPI). The ID of this bootloader is 0x91	For the CAN interface, the Write Unprotect command is not functional. Instead you can use Write Memory command and write directly to the option bytes in order to disable the write protection.



## 32 STM32F446xx devices bootloader

# 32.1 Bootloader configuration

The STM32F446xx bootloader is activated by applying pattern1 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 68.STM32F446xx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
Common to all bootloaders	RCC	HSI enabled	The HSI is used at startup as clock source for system clock configured to 60 MHz and for USART, I2C and SPI bootloader operation.
		HSE enabled	The HSE is used only when the CAN or the DFU (USB FS Device) interfaces are selected. In this case the system clock configured to 60 MHz with HSE as clock source.  The HSE frequency must be multiple of 1 MHz and ranging from 4 MHz to 26 MHz.
		-	The Clock Security System (CSS) interrupt is enabled for the CAN and DFU bootloaders. Any failure (or removal) of the external clock generates system reset.
	RAM	-	12 Kbyte starting from address 0x20000000 are used by the bootloader firmware
	System memory	-	30424 byte starting from address 0x1FFF0000, contain the bootloader firmware
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
	Power	-	The voltage range is [1.71 V, 3.6 V]. In this range: - Flash wait states 3 System Clock 60 MHz Prefetch disabled Flash write operation by byte (refer to section Bootloader Memory Management for more information).



Table 68.STM32F446xx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
USART1 bootloader	USART1	Enabled	Once initialized the USART1 configuration is: 8-bits, even parity and 1 Stop bit
	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART3 bootloader (on PB10/PB11)	USART3	Enabled	Once initialized the USART3 configuration is: 8-bits, even parity and 1 Stop bit
	USART3_RX pin	Input	PB11 pin: USART3 in reception mode
	USART3_TX pin	Output	PB10 pin: USART3 in transmission mode
USART3	USART3	Enabled	Once initialized the USART3 configuration is: 8-bits, even parity and 1 Stop bit
bootloader (on PC10/PC11)	USART3_RX pin	Input	PC11 pin: USART3 in reception mode
1 6 10/1 6 11)	USART3_TX pin	Output	PC10 pin: USART3 in transmission mode
USART1 and USART3 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.
CAN2 bootloader	CAN2	Enabled	Once initialized the CAN2 configuration is: Baudrate 125 kbps, 11-bit identifier.  Note: CAN1 is clocked during CAN2 bootloader execution because in CAN1 manages the communication between CAN2 and SRAM.
	CAN2_RX pin	Input	PB5 pin: CAN2 in reception mode
	CAN2_TX pin	Output	PB13 pin: CAN2 in transmission mode
I2C1 bootloader	I2C1	Enabled	The I2C1 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0111100x (where x = 0 for write and x = 1 for read)
	I2C1_SCL pin	Input/Output	PB6 pin: clock line is used in open-drain mode.
	I2C1_SDA pin	Input/Output	PB9 pin: data line is used in open-drain mode.
I2C2 bootloader	I2C2	Enabled	The I2C2 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0111100x (where x = 0 for write and x = 1 for read)
	I2C2_SCL pin	Input/Output	PF1 pin: clock line is used in open-drain mode.
	I2C2_SDA pin	Input/Output	PF0 pin: data line is used in open-drain mode.

Table 68.STM32F446xx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
I2C3 bootloader	I2C3	Enabled	The I2C3 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0111100x (where x = 0 for write and x = 1 for read)
	I2C3_SCL pin	Input/Output  Enabled	PA8 pin: clock line is used in open-drain mode.
	I2C3_SDA pin		PC9 pin: data line is used in open-drain mode.
	SPI1	Enabled	The SPI1 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI1_MOSI pin	Input	PA7 pin: Slave data Input line, used in Push-pull pull-down mode
SPI1 bootloader	SPI1_MISO pin	Output	PA6 pin: Slave data output line, used in Push-pull pull-down mode
	SPI1_SCK pin	Input	PA5 pin: Slave clock line, used in Push-pull pull-down mode
	SPI1_NSS pin	Input	PA4 pin: Slave Chip Select pin used in Push-pull pull-up mode.
	SPI2	Enabled	The SPI2 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI2_MOSI pin	Input	PB15 pin: Slave data Input line, used in Push-pull pull-down mode
SPI2 bootloader	SPI2_MISO pin	Output	PB14 pin: Slave data output line, used in Push-pull pull-down mode
	SPI2_SCK pin	Input	PC7 pin: Slave clock line, used in Push-pull pull-down mode
	SPI2_NSS pin	Input	PB12 pin: Slave Chip Select pin used in Push-pull pull-up mode.



Table 68.STM32F446xx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
	SPI4	Enabled	The SPI4 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI4_MOSI pin	Input	PE14 pin: Slave data Input line, used in Push-pull pull-down mode
SPI4 bootloader	SPI4_MISO pin	Output	PE13 pin: Slave data output line, used in Push-pull pull-down mode
	SPI4_SCK pin	Input	PE12 pin: Slave clock line, used in Push- pull pull-down mode
	SPI4_NSS pin	Input	PE11 pin: Slave Chip Select pin used in Push-pull pull-up mode.
	USB	Enabled	USB OTG FS configured in Forced Device mode
DFU bootloader	USB_DM pin		PA11: USB DM line.
	USB_DP pin	Input/Output	PA12: USB DP line No external Pull-up resistor is required
CAN2 and DFU bootloaders	TIM17	Enabled	This timer is used to determine the value of the HSE. Once the HSE frequency is determinated, the system clock is configured to 60 MHz using PLL and HSE.

The system clock is derived from the embedded internal high-speed RC for USARTx and I2Cx bootloaders. This internal clock is also used for CAN and DFU (USB FS Device) but only for the selection phase. An external clock multiple of 1 MHz (between 4 and 26 MHz) is required for CAN and DFU bootloader execution after the selection phase.

### 32.2 Bootloader selection

The figure below shows the bootloader selection mechanism.

System Reset Disable all System Init (Clock, GPIOs, interrupt sources IWDG, SysTick) yes Configure Configure USB OTG FS **USART**x device Execute Configure I2Cx BL USART Loop for USARTx 0x7F received on USARTx Disable all Yes interrupt sources No Execute I2C Address BL\_I2C\_Loop for Detected I2Cx Disable all Yes No interrupt sources Execute Synchro mechanism BL\_SPI\_Loop for detected on SPIx SPIx ves No HSE detected No yes Frame detected on CANx Disable all HSE detected interrupt sources Generate System Yes reset Reconfigure System No clock to 60MHz Reconfigure System clock to 60MHz and USB cable USB clock to 48 MHz Configure CAN Detected Execute DFU Execute BL\_CAN\_Loop for bootloader using USB interrupts CAN2 MSv36763V1

Figure 39.Bootloader V9.x selection for STM32F446xx



## 32.3 Bootloader version

The following table lists the STM32F446xx devices bootloader V9.x versions:

Table 69. STM32F446xx bootloader V9.x versions

Bootloader version number	Description	Known limitations
V9.0	Initial bootloader version	None

## 33 STM32F469xx/479xx devices bootloader

## 33.1 Bootloader configuration

The STM32F469xx/479xx bootloader is activated by applying pattern5 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 70. STM32F469xx/479xx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
	RCC	HSI enabled	The system clock frequency is 60 MHz using the PLL.  The HSI clock source is used at startup (interface detection phase) and when USART or SPI or I2C interfaces are selected (once CAN or DFUbootloader is selected, the clock source will be derived from external crystal).
		HSE enabled	The system clock frequency is 60 MHz. The HSE clock source is used only when the CAN or the DFU (USB FS Device) interfaces are selected. The external clock must provide a frequency multiple of 1 MHz and ranging from 4 MHz to 26 MHz.
Common to all		-	The Clock Security System (CSS) interrupt is enabled for the CAN and DFU bootloaders. Any failure (or removal) of the external clock generates system reset.
bootloaders	RAM	-	12 Kbyte starting from address 0x20000000 are used by the bootloader firmware
	System memory	-	30431 byte starting from address 0x1FFF0000, contain the bootloader firmware
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
	Power	-	Voltage range is set to [1.62 V, 2.1 V]. In this range internal Flash write operations are allowed only in byte format (Half-Word, Word and Double-Word operations are not allowed). The voltage range can be configured in run time using bootloader commands.



Table 70. STM32F469xx/479xx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
USART1	USART1	Enabled	Once initialized the USART1 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART3	USART3	Enabled	Once initialized the USART3 configuration is: 8-bits, even parity and 1 Stop bit
bootloader (on PB10/PB11)	USART3_RX pin	Input	PB11 pin: USART3 in reception mode
	USART3_TX pin	Output	PB10 pin: USART3 in transmission mode
USART3	USART3	Enabled	Once initialized the USART3 configuration is: 8-bits, even parity and 1 Stop bit
bootloader (on PC10/PC11)	USART3_RX pin	Input	PC11 pin: USART3 in reception mode
PC10/PC11)	USART3_TX pin	Output	PC10 pin: USART3 in transmission mode
USART1 and USART3 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.
CAN2 bootloader	CAN2	Enabled	Once initialized the CAN2 configuration is: Baudrate 125 kbps, 11-bit identifier.  Note: CAN1 is clocked during CAN2 bootloader execution because CAN1 manages the communication between CAN2 and SRAM.
	CAN2_RX pin	Input	PB05 pin: CAN2 in reception mode
	CAN2_TX pin	Input Output Enabled Input Output Enabled Input Output Enabled Input Output Enabled	PB13 pin: CAN2 in transmission mode
I2C1 bootloader	12C1	Enabled	The I2C1 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b1000100x (where x = 0 for write and x = 1 for read).
	I2C1_SCL pin	Input/Output	PB6 pin: clock line is used in open-drain mode.
	I2C1_SDA pin	Input/Output	PB9 pin: data line is used in open-drain mode.
I2C2 bootloader	I2C2	Enabled	The I2C2 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b1000100x (where x = 0 for write and x = 1 for read).
,	I2C2_SCL pin	Input/Output	PF0 pin: clock line is used in open-drain mode.
	I2C2_SDA pin	Input/Output	PF1 pin: data line is used in open-drain mode.



Table 70. STM32F469xx/479xx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
I2C3 bootloader	I2C3	Enabled	The I2C3 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b1000100x (where x = 0 for write and x = 1 for read).
	I2C3_SCL pin	Input/Output	PA8 pin: clock line is used in open-drain mode.
	I2C3_SDA pin	Input/Output	PC9 pin: data line is used in open-drain mode.
	SPI1	Enabled	The SPI1 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI1_MOSI pin	Input	PA7 pin: Slave data Input line, used in Push-pull pull-down mode
SPI1 bootloader	SPI1_MISO pin	Output	PA6 pin: Slave data output line, used in Push-pull pull-down mode
	SPI1_SCK pin	Input	PA5 pin: Slave clock line, used in Push- pull pull-down mode
	SPI1_NSS pin	Input	PA4 pin: Slave Chip Select pin used in Push-pull pull-up mode.
	SPI2	Enabled	The SPI2 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI2_MOSI pin	Input	PI3 pin: Slave data Input line, used in Push-pull pull-down mode
SPI2 bootloader	SPI2_MISO pin	Output	PI2 pin: Slave data output line, used in Push-pull pull-down mode
	SPI2_SCK pin	Input	PI1pin: Slave clock line, used in Push-pull pull-down mode
	SPI2_NSS pin	Input	PI0 pin: Slave Chip Select pin used in Push-pull pull-up mode.



Table 70. STM32F469xx/479xx configuration in system memory boot mode (continued)

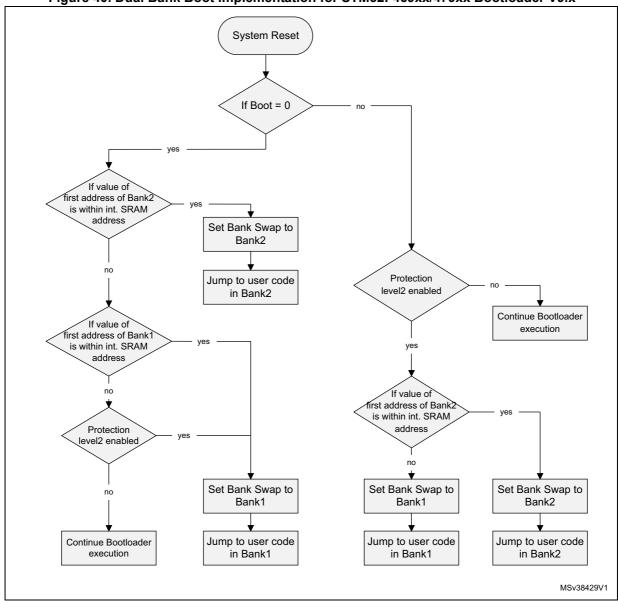
Bootloader	Feature/Peripheral	State	Comment
	SPI4	Enabled	The SPI4 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
05/41 # 1	SPI4_MOSI pin	Input	PE14 pin: Slave data Input line, used in Push-pull pull-down mode
SPI4 bootloader	SPI4_MISO pin	Output	PE13 pin: Slave data output line, used in Push-pull pull-down mode
	SP4_SCK pin	Input	PE12 pin: Slave clock line, used in Push- pull pull-down mode
	SPI4_NSS pin	Input	PE11 pin: Slave Chip Select pin used in Push-pull pull-up mode.
DFU bootloader	USB	Enabled	USB OTG FS configured in Forced Device mode. USB_OTG_FS interrupt vector is enabled and used for USB DFU communications.
Di o bootioadei	USB_DM pin		PA11 pin: USB DM line.
	USB_DP pin	Input/Output	PA12 pin: USB DP line. No external Pull-Up resistor is required.

The system clock is derived from the embedded internal high-speed RC for USARTx and I2Cx bootloaders. This internal clock is also used for CAN and DFU (USB FS Device) but only for the selection phase. An external clock multiple of 1 MHz (between 4 and 48 MHz) is required for CAN and DFU bootloaders execution after the selection phase.

### 33.2 Bootloader selection

The *Figure 40* and show the bootloader selection mechanism.

Figure 40. Dual Bank Boot Implementation for STM32F469xx/479xx Bootloader V9.x



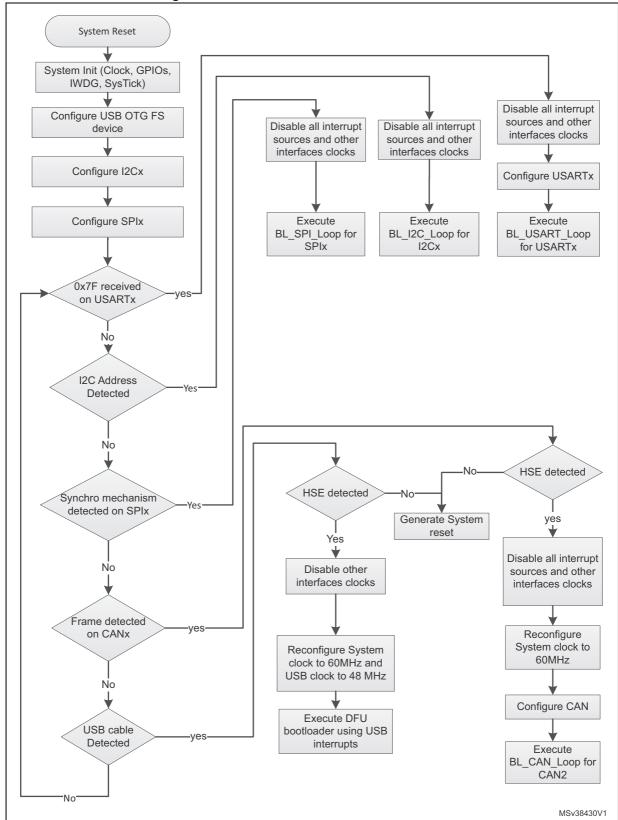


Figure 41.Bootloader V9.x selection for STM32F469xx/479xx



## 33.3 Bootloader version

The following table lists the STM32F469xx/479xx devices V9.x bootloader versions:

Table 71.STM32F469xx/479xx bootloader V9.x version

Bootloader version number	Description	Known limitations
V9.0	Initial bootloader version	None



### 34 STM32F74xxx/75xxx devices bootloader

Two bootloader versions are available on STM32F74xxx/75xxx:

- V7.x supporting USART1, USART3, CAN2, I2C1, I2C2, I2C3 and DFU (USB FS Device). This version is embedded in STM32F74xxx/75xxx rev. A devices.
- V9.x supporting USART1, USART3, CAN2, I2C1, I2C2, I2C3, SPI1, SPI2, SPI4 and DFU (USB FS Device). This version is embedded in STM32F74xxx/75xxx rev. Z devices.

Note:

When readout protection Level2 is activated, STM32F74xxx/75xxx devices can boot also on system memory and all commands are not accessible except Get, GetID, and GetVersion.

### 34.1 Bootloader V7.x

### 34.1.1 Bootloader configuration

The STM32F74xxx/75xxx bootloader is activated by applying pattern8 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

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Table 72. STM32F74xxx/75xxx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
		HSI enabled	The HSI is used at startup as clock source for system clock configured to 60 MHz and for USART and I2C bootloader operation.
	RCC	HSE enabled	The HSE is used only when the CAN or the DFU (USB FS Device) interfaces are selected. In this case the system clock configured to 60 MHz with HSE as clock source.  The HSE frequency must be multiple of 1 MHz and ranging from 4 MHz to 26 MHz.
		-	The Clock Security System (CSS) interrupt is enabled for the CAN and DFU bootloaders. Any failure (or removal) of the external clock generates system reset.
Common to all bootloaders	RAM	-	16 Kbyte starting from address 0x20000000 are used by the bootloader firmware
	System memory	-	61440 byte starting from address 0x1FF00000, contain the bootloader firmware
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
	Power	-	The voltage range is [1.8V, 3.6V]. In this range: - Flash wait states 3 System clock Frequency 60 MHz ART Accelerator enabled Flash write operation by byte (refer to Bootloader Memory Management section for more information).
USART1	USART1	Enabled	Once initialized the USART1 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART3	USART3	Enabled	Once initialized the USART3 configuration is: 8-bits, even parity and 1 Stop bit
bootloader (on	USART3_RX pin	Input	PB11 pin: USART3 in reception mode
PB10/PB11)	USART3_TX pin	Output	PB10 pin: USART3 in transmission mode
USART3	USART3	Enabled	Once initialized the USART3 configuration is: 8-bits, even parity and 1 Stop bit
bootloader (on	USART3_RX pin	Input	PC11 pin: USART3 in reception mode
PC10/PC11)	USART3_TX pin	Output	PC10 pin: USART3 in transmission mode
USART1 and USART3 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.



Table 72. STM32F74xxx/75xxx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
CAN2 bootloader	CAN2	Enabled	Once initialized the CAN2 configuration is: Baudrate 125 kbps, 11-bit identifier.  Note: CAN1 is clocked during CAN2 bootloader execution because CAN1 manages the communication between CAN2 and SRAM.
	CAN2_RX pin	Input	PB5 pin: CAN2 in reception mode
	CAN2_TX pin	Output	PB13 pin: CAN2 in transmission mode
I2C1 bootloader	I2C1	Enabled	The I2C1 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b1000101x (where x = 0 for write and x = 1 for read)
	I2C1_SCL pin	Input/Output	PB6 pin: clock line is used in open-drain mode.
	I2C1_SDA pin	Input/Output	PB9 pin: data line is used in open-drain mode.
I2C2 bootloader	12C2	Enabled	The I2C2 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b1000101x (where x = 0 for write and x = 1 for read)
	I2C2_SCL pin	Input/Output	PF1 pin: clock line is used in open-drain mode.
	I2C2_SDA pin	Input/Output	PF0 pin: data line is used in open-drain mode.
I2C3 bootloader	I2C3	Enabled	The I2C3 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b1000101x (where x = 0 for write and x = 1 for read)
	I2C3_SCL pin	Input/Output	PA8 pin: clock line is used in open-drain mode.
	I2C3_SDA pin	Input/Output	PC9 pin: data line is used in open-drain mode.
	USB	Enabled	USB OTG FS configured in Forced Device mode.
DFU bootloader	USB_DM pin		PA11 pin: USB DM line.
Dr o boolloader	USB_DP pin	Input/Output	PA12 pin: USB DP line No external Pull-Up resistor is required.
CAN2 and DFU bootloaders	TIM11	Enabled	This timer is used to determine the value of the HSE. Once HSE frequency is determined, the system clock is configured to 60 MHz using PLL and HSE.

The system clock is derived from the embedded internal high-speed RC for USARTx and I2Cx bootloaders. This internal clock is also used for CAN and DFU (USB FS Device) but only for the selection phase. An external clock multiple of 1 MHz (between 4 and 26 MHz) is required for CAN and DFU bootloader execution after the selection phase.



### 34.1.2 Bootloader selection

The figure below shows the bootloader selection mechanism.

System Reset System Init (Clock, GPIOs, IWDG, SysTick) -ves Disable all interrupt sources and other Configure USB OTG FS interfaces clocks device Disable all interrupt Configure sources and other USARTx interfaces clocks Configure I2Cx Execute Execute BL\_I2C\_Loop BL\_USART\_Loop for I2Cx for USARTx 0x7F received on **USART**x no I2C Address Detected HSE detected HSE detected no Generate System reset Disable all interrupt Disable other Frame detected sources and other on CANx interfaces clocks interfaces clocks no Reconfigure System Reconfigure System no clock to 60MHz clock to 60MHz and USB clock to 48 MHz USB cable Detected Configure CAN Execute DFU bootloader using USB interrupts Execute BL\_CAN\_Loop for MSv37792V1

Figure 42.Bootloader V7.x selection for STM32F74xxx/75xxx



### 34.1.3 Bootloader version

The following table lists the STM32F74xxx/75xxx devices bootloader V7.x versions:

Table 73.STM32F74xxx/75xxx bootloader V7.x versions

Bootloader version number	Description	Known limitations
V7.0	Initial bootloader version	None

## 34.2 Bootloader V9.x

## 34.2.1 Bootloader configuration

The STM32F74xxx/75xxx bootloader is activated by applying pattern8 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 74. STM32F74xxx/75xxx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
	RCC	HSI enabled	The HSI is used at startup as clock source for system clock configured to 60MHz and for USART, I2C and SPI bootloader operation.
		HSE enabled	The HSE is used only when the CAN or the DFU (USB FS Device) interfaces are selected. In this case the system clock configured to 60 MHz with HSE as clock source.  The HSE frequency must be multiple of 1 MHz and ranging from 4 MHz to 26 MHz.
		-	The Clock Security System (CSS) interrupt is enabled for the CAN and DFU bootloaders. Any failure (or removal) of the external clock generates system reset.
Common to all bootloaders	RAM	-	16 Kbyte starting from address 0x20000000 are used by the bootloader firmware
Bootioaders	System memory	-	61440 byte starting from address 0x1FF00000, contain the bootloader firmware
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
	Power	-	The voltage range is [1.8V, 3.6V] In this range: - Flash wait states 3 System clock Frequency 60MHz ART Accelerator enabled Flash write operation by byte (refer to Bootloader Memory Management section for more information).



Table 74. STM32F74xxx/75xxx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
USART1	USART1	Enabled	Once initialized the USART1 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Enabled  Input  Output  Enabled  Input  Cois  Input  Property  Enabled  Input  Coutput  Enabled  Input  Output  Enabled  Input  Output  Enabled  Input  Cois  Input  Cois  Input	PA9 pin: USART1 in transmission mode
USART3	USART3	Enabled	Once initialized the USART3 configuration is: 8-bits, even parity and 1 Stop bit
bootloader (on PB10/PB11)	USART3_RX pin	Input	PB11 pin: USART3 in reception mode
	USART3_TX pin	Output	PB10 pin: USART3 in transmission mode
USART3	USART3	Enabled	Once initialized the USART3 configuration is: 8-bits, even parity and 1 Stop bit
bootloader (on PC10/PC11)	USART3_RX pin	Input	PC11 pin: USART3 in reception mode
PC10/PC11)	USART3_TX pin	Output	PC10 pin: USART3 in transmission mode
USART1 and USART3 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.
CAN2 bootloader	CAN2	Enabled Us rate  On Ba  No boo ma CA  Input PB  Output PB	Once initialized the CAN2 configuration is: Baudrate 125 kbps, 11-bit identifier.  Note: CAN1 is clocked during CAN2 bootloader execution because CAN1 manages the communication between CAN2 and SRAM.
	CAN2_RX pin	Input	PB5 pin: CAN2 in reception mode
	CAN2_TX pin	Output	PB13 pin: CAN2 in transmission mode
I2C1 bootloader	I2C1	Enabled	The I2C1 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b1000101x (where x = 0 for write and x = 1 for read)
	I2C1_SCL pin	Input/output	PB6 pin: clock line is used in open-drain mode.
	I2C1_SDA pin	Input/output	PB9 pin: data line is used in open-drain mode.
I2C2 bootloader	12C2	Enabled	The I2C2 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b1000101x (where x = 0 for write and x = 1 for read)
	I2C2_SCL pin	Input/output	PF1 pin: clock line is used in open-drain mode.
	I2C2_SDA pin	Enabled  PB Output  PB Output  Enabled  Input/output  Enabled  Input/output  Enabled  Input/output  Enabled  Input/output  Input/output  Enabled  Input/output  PB mo Input/output  Input/output  Input/output  Input/output  PF mo Input/output  Input/output	PF0 pin: data line is used in open-drain mode.

Table 74. STM32F74xxx/75xxx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
I2C3 bootloader	I2C3	Enabled	The I2C3 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b1000101x (where x = 0 for write and x = 1 for read)
	I2C3_SCL pin	Input/output	PA8 pin: clock line is used in open-drain mode.
	I2C3_SDA pin	Input/output	PC9 pin: data line is used in open-drain mode.
	SPI1	Enabled	The SPI1 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI1_MOSI pin	Input	PA7 pin: Slave data Input line, used in Push-pull pull-down mode
SPI1 bootloader	SPI1_MISO pin	Output	PA6 pin: Slave data output line, used in Push-pull pull-down mode
	SPI1_SCK pin	Input	PA5 pin: Slave clock line, used in Push-pull pull-down mode
	SPI1_NSS pin	Input	PA4 pin: Slave Chip Select pin used in Push-pull pull-up mode.
	SPI2	Enabled	The SPI2 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI2_MOSI pin	Input	PI3 pin: Slave data Input line, used in Push- pull pull-down mode
SPI2 bootloader	SPI2_MISO pin	Output	PI2 pin: Slave data output line, used in Push-pull pull-down mode
	SPI2_SCK pin	Input	PI1 pin: Slave clock line, used in Push-pull pull-down mode
	SPI2_NSS pin	Input	PI0 pin: Slave Chip Select pin used in Push-pull pull-up mode.



Table 74. STM32F74xxx/75xxx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
	SPI4	Enabled	The SPI4 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
ODIAL SHOOLS	SPI4_MOSI pin		PE14 pin: Slave data Input line, used in Push-pull pull-down mode
SPI4 bootloader	SPI4_MISO pin	Output	PE13 pin: Slave data output line, used in Push-pull pull-down mode
	SP4_SCK pin	Input	PE12 pin: Slave clock line, used in Push- pull pull-down mode
	SPI4_NSS pin	Input PE pul Input PE Pu	PE11 pin: Slave Chip Select pin used in Push-pull pull-up mode.
	USB	Enabled	USB OTG FS configured in Forced Device mode.
DFU bootloader	USB_DM pin		PA11 pin: USB DM line.
	USB_DP pin	Input/Output	PA12 pin: USB DP line No external Pull-Up resistor is required.
CAN2 and DFU bootloaders	TIM11	Enabled	This timer is used to determine the value of the HSE. Once HSE frequency is determined, the system clock is configured to 60 MHz using PLL and HSE.

The system clock is derived from the embedded internal high-speed RC for USARTx, I2Cx and SPIx bootloaders. This internal clock is also used for CAN and DFU (USB FS Device) but only for the selection phase. An external clock multiple of 1 MHz (between 4 and 26 MHz) is required for CAN and DFU bootloader execution after the selection phase.

### 34.2.2 Bootloader selection

The Figure 43 shows the bootloader selection mechanism.

System Reset System Init (Clock, GPIOs, IWDG, SysTick) ves-Configure USB OTG FS device Disable all interrupt sources and other interfaces clocks Configure I2Cx Disable all interrupt Disable all interrupt Configure sources and other sources and other **USART**x interfaces clocks interfaces clocks Configure SPIx Execute Execute Execute BL I2C Loop BL USART Loop BL SPI Loop for I2Cx for USARTx for SPIx 0x7F received on **USART**x no 12C Address Detected no HSE detected HSE detected Synchro mechanism Generate System detected on SPIx yes yes reset Disable all interrupt Disable other sources and other interfaces clocks no interfaces clocks no Reconfigure System Reconfigure System Frame detected clock to 60MHz and clock to 60MHz on CANx USB clock to 48 MHz Configure CAN no Execute DFU bootloader using USB interrupts USB cable Execute ves Detected BL CAN Loop for CAN2

Figure 43.Bootloader V9.x selection for STM32F74xxx/75xxx



MSv36793V1

### 34.2.3 Bootloader version

The following table lists the STM32F74xxx/75xxx bootloader V9.x versions:

Table 75.STM32F74xxx/75xxx bootloader V9.x versions

Bootloader version number	Description	Known limitations
V9.0	Initial bootloader version	None

## 35 STM32L01xxx/02xxx devices bootloader

# 35.1 Bootloader configuration

The STM32L01xxx/02xxx bootloader is activated by applying pattern6 (described in *Table 2: Bootloader activation patterns*). The following *Table 76* shows the hardware resources used by this bootloader.

Table 76. STM32L01xxx/02xxx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
	RCC	HSI enabled	The system clock frequency is 32 MHz with HSI 16 MHz as clock source.
	RAM	-	2 Kbytes starting from address 0x20000000 are used by the bootloader firmware
Common to all bootloaders	System memory	-	4 Kbytes starting from address 0x1FF00000, contain the bootloader firmware
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
USART2	USART2	Enabled	Once initialized the USART2 configuration is: 8-bits, even parity and 1 Stop bit
bootloader (on PA9/PA10)	USART2_RX pin	Input	PA10 pin: USART2 in reception mode
17(0/17(10)	USART2_TX pin	Output	PA9 pin: USART2 in transmission mode
USART2	USART2	Enabled	Once initialized the USART2 configuration is: 8-bits, even parity and 1 Stop bit
bootloader (on PA2/PA3)	USART2_RX pin	Input	PA3 pin: USART2 in reception mode
17.2717.0)	USART2_TX pin	Output	PA2 pin: USART2 in transmission mode
USART2 bootloader	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.
	SPI1	Enabled	The SPI1 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
SPI1 bootloader	SPI1_MOSI pin	Input	PA7 pin: Slave data Input line, used in Push-pull pull-down mode
(for all device packages except	SPI1_MISO pin	Output	PA6 pin: Slave data output line, used in Push-pull pull-down mode
TSSOP14)	SPI1_SCK pin	Input	PA5 pin: Slave clock line, used in Push-pull pull-down mode
	SPI1_NSS pin	Input	PA4 pin: Slave Chip Select pin used in Push-pull pull-up mode.  Note:This IO can be tied to GND if the SPI Master does not use it.



Table 76. STM32L01xxx/02xxx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
	SPI1	Enabled	The SPI1 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI1_MOSI pin	Input	PA7 pin: Slave data Input line, used in Push-pull pull-down mode
SPI1 bootloader (only for devices on	SPI1_MISO pin	Output	PA14 pin: Slave data output line, used in Push-pull pull-down mode
TSSOP14 package)	SPI1_SCK pin	Input	PA13 pin: Slave clock line, used in Push-pull pull-down mode
	SPI1_NSS pin	Input	PA4 pin: Slave Chip Select pin used in Push-pull pull-up mode.  Note: NSS pin synchronization is required on Bootloader with SPI1 interface for devices on TSSOP14 package.

The system clock is derived from the embedded internal high-speed RC for all bootloader interfaces. No external quartz is required for bootloader operations.

#### 35.2 **Bootloader selection**

The *Table 44* shows the bootloader selection mechanism.

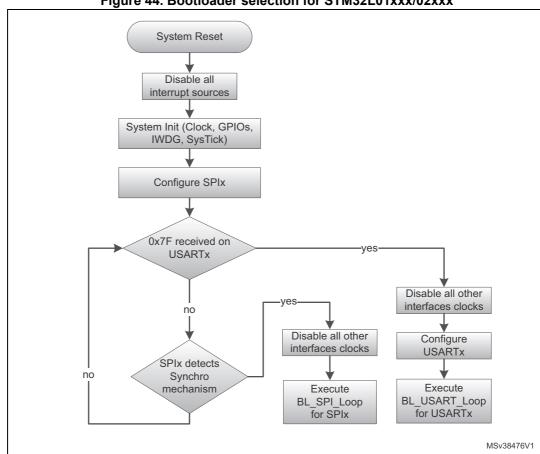


Figure 44. Bootloader selection for STM32L01xxx/02xxx

## 35.3 Bootloader version

The following table lists the STM32L01xxx/02xxx devices bootloader versions.

Table 77.STM32L01xxx/02xxx bootloader versions

Bootloader version number	Description	Known limitations
V12.0	Deprecated version (not used)	None
V12.1	Deprecated version (not used)	None
V12.2	Initial bootloader version	Bootloader not functional with SPI1 interface for devices on TSSOP14 package.
V12.3	This bootloader is an updated version of Bootloader V12.2. This new version add support of SPI interface for devices on TSSOP14 package.	For the SPI1 interface for devices in TSSOP14, a falling edge on NSS pin is required before staring communication, to properly sychronize the SPI interface. If the NSS pin is grounded (all time from device reset) the SPI communication is not synchronized and bootloader does not work properly with the SPI interface.



## 36 STM32L031xx/041xx devices bootloader

## 36.1 Bootloader configuration

The STM32L031xx/041xx bootloader is activated by applying pattern2 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 78. STM32L031xx/041xx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
	RCC	HSI enabled	The system clock frequency is 32 MHz with HSI 16 MHz as clock source.
	RAM	-	4 Kbyte starting from address 0x20000000 are used by the bootloader firmware
Common to all bootloaders	System memory	-	4 Kbyte starting from address 0x1FF00000, contain the bootloader firmware
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
USART2	USART2	Enabled	Once initialized the USART2 configuration is: 8-bits, even parity and 1 Stop bit
bootloader (on PA9/PA10)	USART2_RX pin	Input	PA10 pin: USART2 in reception mode
(OII PA9/PA10)	USART2_TX pin	Output	PA9 pin: USART2 in transmission mode
USART2	USART2	Enabled	Once initialized the USART2 configuration is: 8-bits, even parity and 1 Stop bit
bootloader (on PA2/PA3)	USART2_RX pin	Input	PA3 pin: USART2 in reception mode
(OII FAZ/FAS)	USART2_TX pin	Output	PA2 pin: USART2 in transmission mode
USART2 bootloader	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.



Table 78. STM32L031xx/041xx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
	SPI1	Enabled	The SPI1 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI1_MOSI pin	Input	PA7 pin: Slave data Input line, used in Push-pull pull-down mode
SPI1 bootloader	SPI1_MISO pin	Output	PA6 pin: Slave data output line, used in Push-pull pull-down mode
	SPI1_SCK pin	Inniit	PA5 pin: Slave clock line, used in Push-pull pull-down mode
	SPI1_NSS pin	Input	PA4 pin: Slave Chip Select pin used in Push-pull pull-up mode.  Note:This IO can be tied to GND if the SPI Master does not use it.

The system clock is derived from the embedded internal high-speed RC for all bootloader interfaces. No external quartz is required for bootloader operations.

The bootloader Read/Write commands don't support SRAM memory space for this product.



### 36.2 Bootloader selection

The *Figure 45* shows the bootloader selection mechanism.

System Reset Disable all interrupt sources System Init (Clock, GPIOs, IWDG, SysTick) Configure SPIx 0x7F received on yes **USART**x Disable all other interfaces clocks yes Configure USARTx Disable all other interfaces clocks SPIx detects Execute no Synchro BL USART Loop mechanism Execute for USARTx BL\_SPI\_Loop for MS35035V1

Figure 45. Bootloader selection for STM32L031xx/041xx

### 36.3 Bootloader version

The *Table 79* lists the STM32L031xx/041xx devices bootloader versions:

Table 79. STM32L031xx/041xx bootloader versions

Bootloader version number	Description	Known limitations
V12.0	Initial bootloader version	None

## 37 STM32L05xxx/06xxx devices bootloader

## 37.1 Bootloader configuration

The STM32L05xxx/06xxx bootloader is activated by applying pattern1 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 80. STM32L05xxx/06xxx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
	RCC	HSI enabled	The system clock frequency is 32 MHz with HSI 16 MHz as clock source.
	Power	-	Voltage range is set to Voltage Range 1.
	RAM	-	4 Kbyte starting from address 0x20000000 are used by the bootloader firmware
Common to all bootloaders	System memory	-	4 Kbyte starting from address 0x1FF00000, contain the bootloader firmware
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
USART1	USART1	Enabled	Once initialized the USART1 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART2	USART2	Enabled	Once initialized the USART2 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART2_RX pin	Input	PA3 pin: USART2 in reception mode
	USART2_TX pin	Output	PA2 pin: USART2 in transmission mode
USART1 and USART2 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.

Table 80. STM32L05xxx/06xxx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
	SPI1	Enabled	The SPI1 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI1_MOSI pin	Input	PA7 pin: Slave data Input line, used in Push-pull pull-down mode
SPI1 bootloader	SPI1_MISO pin	Output	PA6 pin: Slave data output line, used in Push-pull pull-down mode
	SPI1_SCK pin	Input	PA5 pin: Slave clock line, used in Push-pull pull-down mode
	SPI1_NSS pin	Input	PA4 pin: Slave Chip Select pin used in Push-pull pull-down mode.
	SPI2	Enabled	The SPI2 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI2_MOSI pin	Input	PB15 pin: Slave data Input line, used in Push-pull pull-down mode
SPI2 bootloader	SPI2_MISO pin	Output	PB14 pin: Slave data output line, used in Push-pull pull-down mode
	SPI2_SCK pin	Input	PB13 pin: Slave clock line, used in Push- pull pull-down mode
	SPI2_NSS pin	Input	PB12 pin: Slave Chip Select pin used in Push-pull pull-down mode.

The system clock is derived from the embedded internal high-speed RC for all bootloader interfaces. No external quartz is required for bootloader operations.



### 37.2 Bootloader selection

The figure below shows the bootloader selection mechanism.

System Reset Disable all interrupt sources System Init (Clock, GPIOs, IWDG, SysTick) Configure SPIx 0x7F received on yes **USART**x Disable all other interfaces clocks yes Configure USARTx Disable all other interfaces clocks SPIx detects Execute Synchro no BL USART Loop mechanism Execute for USARTx BL\_SPI\_Loop for MS35035V1

Figure 46. Bootloader selection for STM32L05xxx/06xxx

### 37.3 Bootloader version

The following table lists the STM32L05xxx/06xxx devices bootloader versions:

Table 81. STM32L05xxx/06xxx bootloader versions

Bootloader version number	Description	Known limitations
V12.0	Initial bootloader version	None

### 38 STM32L07xxx/08xxx devices bootloader

Two bootloader versions are available on STM32L07xxx/08xxx devices:

- V4.x supporting USART1, USART2 and DFU (USB FS Device).
   This version is embedded in STM32L072xx/73xx and STM32L082xx/83xx devices.
- V11.x supporting USART1, USART2, I2C1, I2C2, SPI1 and SPI2.
   This version is embedded in other STM32L071xx/081xx devices.

### 38.1 Bootloader V4.x

### 38.1.1 Bootloader configuration

The STM32L07xxx/08xxx bootloader is activated by applying pattern2 or pattern7 when dual bank boot feature is available (described in *Table 2: Bootloader activation patterns*). The *Table 82* shows the hardware resources used by this bootloader.

Table 82. STM32L07xxx/08xxx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
	RCC	HSI enabled	The system clock frequency is 32 MHz with HSI 16 MHz as clock source.
	RAM	-	4 Kbyte starting from address 0x20000000 are used by the bootloader firmware.
Common to all bootloaders	System memory	-	8 Kbyte starting from address 0x1FF00000, contain the bootloader firmware.
boottoaders	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
USART1	USART1	Enabled	Once initialized the USART1 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART1_RX pin	Input	PA10 pin: USART2 in reception mode
	USART1_TX pin	Output	PA9 pin: USART2 in transmission mode
USART2	USART2	Enabled	Once initialized the USART2 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART2_RX pin	Input	PA3 pin: USART2 in reception mode
	USART2_TX pin	Output	PA2 pin: USART2 in transmission mode
USARTx bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.



Table 82. STM32L07xxx/08xxx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
DFU bootloader	USB	Enabled	USB FS configured in Forced Device mode. USB FS interrupt vector is enabled and used for USB DFU communications.
	USB_DM pin	Input/Output	PA11 pin: USB FS DM line
	USB_DP pin		PA12 pin: USB FS DP line. No external Pull-up resistor is required.

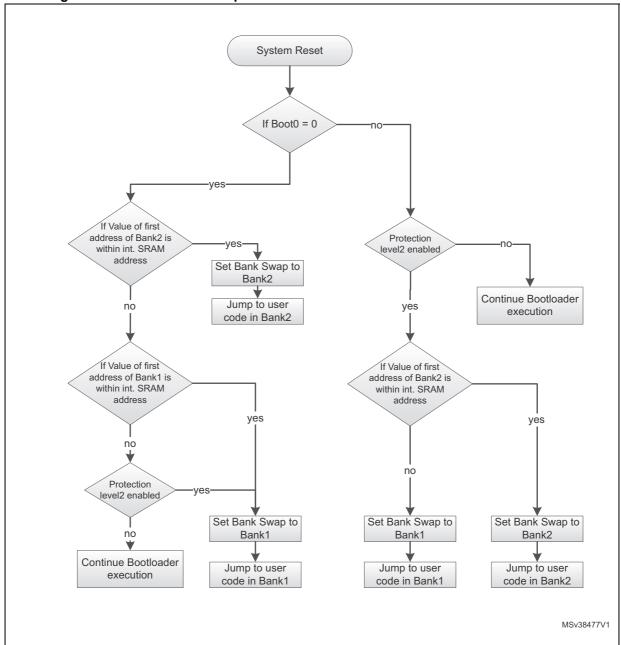
The system clock is derived from the embedded internal high-speed RC for all bootloader interfaces. No external quartz is required for bootloader operations.



### 38.1.2 Bootloader selection

The Figure 47 and Figure 48 show the bootloader selection mechanism.

Figure 47. Dual Bank Boot Implementation for STM32L07xxx/08xxx Bootloader V4.x





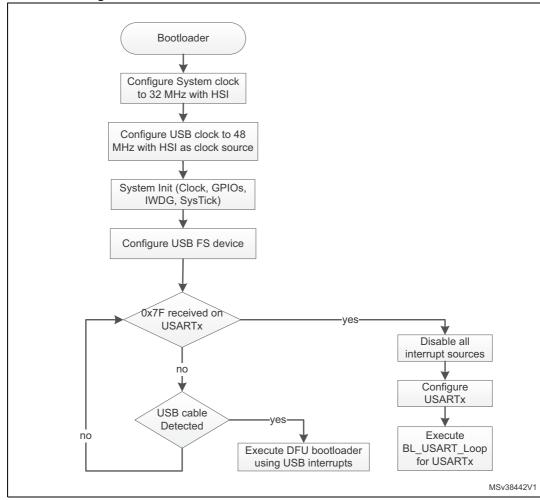


Figure 48. Bootloader V4.x selection for STM32L07xxx/08xxx

### 38.1.3 Bootloader version

The Table 83 lists the STM32L07xxx/08xxx devices bootloader versions:

Table 83. STM32L07xxx/08xxx bootloader versions

Bootloader version number	Description	Known limitations
V4.0	Initial bootloader version	None
V4.1	This bootloader is an updated version of Bootloader V4.0. This new version implements the Dual Bank Boot feature.	None

### 38.2 Bootloader V11.x

### 38.2.1 Bootloader configuration

The STM32L07xxx/08xxx bootloader is activated by applying pattern2 or pattern7 when dual bank boot feature is available (described in *Table 2: Bootloader activation patterns*). The *Table 84* shows the hardware resources used by this bootloader.

Table 84. STM32L07xxx/08xxx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
	RCC	HSI enabled	The system clock frequency is 32 MHz with HSI 16 MHz as clock source.
	RAM	-	5 Kbyte starting from address 0x20000000 are used by the bootloader firmware
Common to all bootloaders	System memory	-	8 Kbyte starting from address 0x1FF00000, contain the bootloader firmware
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
USART1	USART1	Enabled	Once initialized the USART1 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART1_RX pin	Input	PA10 pin: USART2 in reception mode
	USART1_TX pin	Output	PA9 pin: USART2 in transmission mode
USART2	USART2	Enabled	Once initialized the USART2 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART2_RX pin	Input	PA3 pin: USART2 in reception mode
	USART2_TX pin	Output	PA2 pin: USART2 in transmission mode
USARTx bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.
I2C1 bootloader	I2C1	Enabled	The I2C1 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b1000010x (where x = 0 for write and x = 1 for read)
	I2C1_SCL pin	Input/Output	PB6 pin: I2C1 clock line is used in open-drain mode.
	I2C1_SDA pin	Input/Output	PB7 pin: I2C1 data line is used in opendrain mode.



Table 84. STM32L07xxx/08xxx configuration in system memory boot mode (continued)

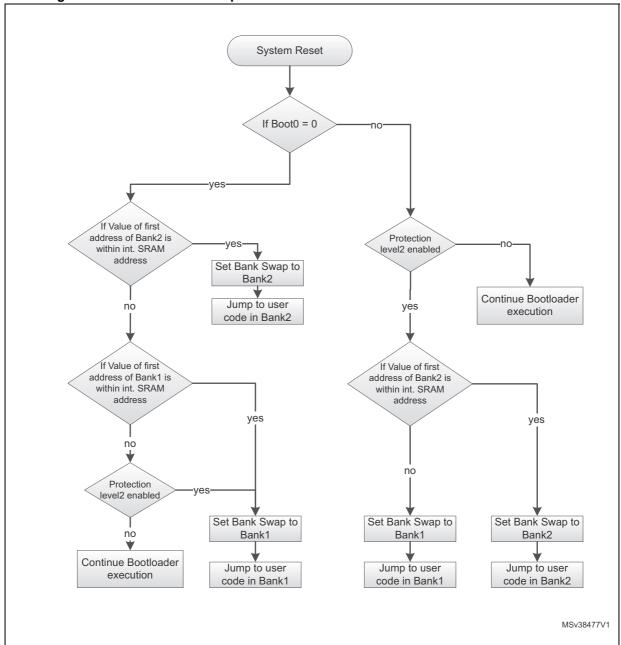
Bootloader	Feature/Peripheral	State	Comment
I2C2 bootloader	I2C2	Enabled	The I2C2 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b1000010x (where x = 0 for write and x = 1 for read)
	I2C2_SCL pin	Input/Output	PB10 pin: I2C2 clock line is used in open-drain mode.
	I2C2_SDA pin	Input/Output	PB11 pin: I2C2 data line is used in open-drain mode.
	SPI1	Enabled	The SPI1 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI1_MOSI pin	Input	PA7 pin: Slave data Input line, used in Push-pull pull-down mode
SPI1 bootloader	SPI1_MISO pin	Output	PA6 pin: Slave data output line, used in Push-pull pull-down mode
	SPI1_SCK pin	Input	PA5 pin: Slave clock line, used in Push- pull pull-down mode
	SPI1_NSS pin	Input	PA4 pin: Slave Chip Select pin used in Push-pull pull-up mode.  Note: This IO can be tied to Gnd if the SPI Master does not use it.
	SPI2	Enabled	The SPI2 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI2_MOSI pin	Input	PB15 pin: Slave data Input line, used in Push-pull pull-down mode
SPI2 bootloader	SPI2_MISO pin	Output	PB14 pin: Slave data output line, used in Push-pull pull-down mode
	SPI2_SCK pin	Input	PB13 pin: Slave clock line, used in Push-pull pull-down mode
	SPI2_NSS pin	Input	PB12 pin: Slave Chip Select pin used in Push-pull pull-up mode.  Note: This IO can be tied to GND if the SPI Master does not use it.

The system clock is derived from the embedded internal high-speed RC for all bootloader interfaces. No external quartz is required for bootloader operations.

#### 38.2.2 Bootloader selection

The Figure 49 and Figure 50 show the bootloader selection mechanism.

Figure 49. Dual Bank Boot Implementation for STM32L07xxx/08xxx Bootloader V11.x





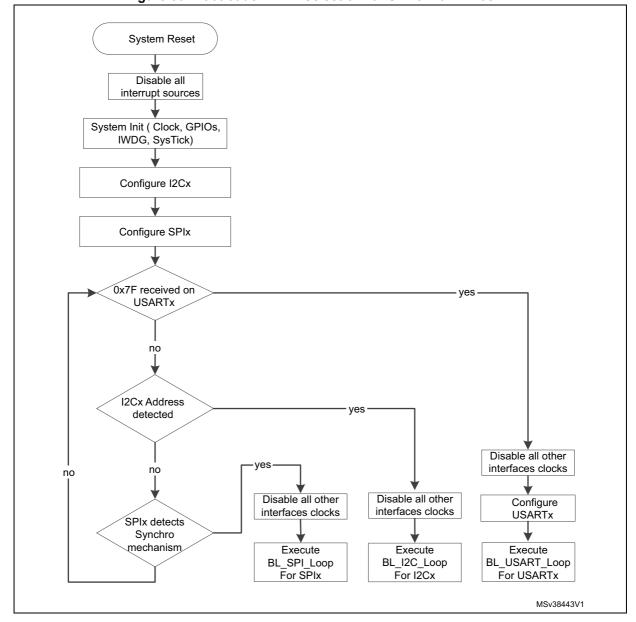


Figure 50. Bootloader V11.x selection for STM32L07xxx/08xxx

### 38.2.3 Bootloader version

The following table lists the STM32L07xxx/08xxx devices bootloader versions:

Table 85. STM32L07xxx/08xxx bootloader V11.x version

Bootloader version number	Description	Known limitations
V11.0	Deprecated version (not used)	None
V11.1	Initial bootloader version	None
V11.2	This bootloader is an updated version of Bootloader V11.1. This new version implements the Dual Bank Boot feature.	None



# 39 STM32L1xxx6(8/B)A devices bootloader

## 39.1 Bootloader configuration

The STM32L1xxx6(8/B)A bootloader is activated by applying pattern1 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 86. STM32L1xxx6(8/B)A configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
	RCC	HSI enabled	The system clock frequency is 16 MHz.
	RAM	-	2 Kbyte starting from address 0x20000000 are used by the bootloader firmware.
0	System memory	-	4 Kbyte starting from address 0x1FF00000 contain the bootloader firmware.
Common to all bootloaders	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value and is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
	Power	-	Voltage range is set to Voltage Range 1.
USART1	USART1	Enabled	Once initialized, the USART1 configuration is: 8 bits, even parity and 1 Stop bit.
bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART2	USART2	Enabled	Once initialized, the USART2 configuration is: 8 bits, even parity and 1 Stop bit.
bootloader	USART2_RX pin	Input	PD6 pin: USART2 in reception mode
	USART2_TX pin	Output	PD5 pin: USART2 in transmission mode
USART1 and USART2 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host.

The system clock is derived from the embedded internal high-speed RC, no external quartz is required for the bootloader execution.

### 39.2 Bootloader selection

The figure below shows the bootloader selection mechanism.

System Reset

System Init (Clock, GPIOs, IWDG, SysTick)

Disable all interrupt sources

Configure
USARTx

Execute
BL\_USART\_Loop
for USARTx

MS35033V1

Figure 51. Bootloader selection for STM32L1xxx6(8/B)A devices

### 39.3 Bootloader version

The following table lists the STM32L1xxx6(8/B)A devices bootloader versions:

Table 87. STM32L1xxx6(8/B)A bootloader versions

Bootloader version number	Description	Known limitations
V2.0	Initial bootloader version	When a Read Memory command or Write Memory command is issued with an unsupported memory address and a correct address checksum (ie. address 0x6000 0000), the command is aborted by the bootloader device, but the NACK (0x1F) is not sent to the host. As a result, the next 2 bytes (which are the number of bytes to be read/written and its checksum) are considered as a new command and its checksum. (1)

If the "number of data - 1" (N-1) to be read/written is not equal to a valid command code, then the limitation is not perceived from the host since the command is NACKed anyway (as an unsupported new command).



#### STM32L1xxx6(8/B) devices bootloader 40

#### 40.1 **Bootloader configuration**

The STM32L1xxx6(8/B) bootloader is activated by applying pattern1 (described in Table 2: Bootloader activation patterns). The following table shows the hardware resources used by this bootloader.

Table 88. STM32L1xxx6(8/B) configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
	RCC	HSI enabled	The system clock frequency is 16 MHz.
	RAM	-	2 Kbyte starting from address 0x20000000 are used by the bootloader firmware.
Oursess to all	System memory	-	4 Kbyte starting from address 0x1FF00000 contain the bootloader firmware.
Common to all bootloaders	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value and is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
	Power	-	Voltage range is set to Voltage Range 1.
USART1	USART1	Enabled	Once initialized, the USART1 configuration is: 8 bits, even parity and 1 Stop bit.
bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART2	USART2	Enabled	Once initialized, the USART2 configuration is: 8 bits, even parity and 1 Stop bit.
bootloader	USART2_RX pin	Input	PD6 pin: USART2 in reception mode
	USART2_TX pin	Output	PD5 pin: USART2 in transmission mode
USART1 and USART2 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host.

The system clock is derived from the embedded internal high-speed RC, no external quartz is required for the bootloader execution.



### 40.2 Bootloader selection

The figure below shows the bootloader selection mechanism.

System Reset

System Init (Clock, GPIOs, IWDG, SysTick)

Ox7F received on USARTx

Pes

Configure
USARTx

Execute
BL\_USART\_Loop
for USARTx

MS35007V1

Figure 52. Bootloader selection for STM32L1xxx6(8/B) devices

#### 40.3 Bootloader version

The following table lists the STM32L1xxx6(8/B) devices bootloader versions:

Table 89. STM32L1xxx6(8/B) bootloader versions

Bootloader version number	Description	Known limitations
V2.0	Initial bootloader version	When a Read Memory command or Write Memory command is issued with an unsupported memory address and a correct address checksum (ie. address 0x6000 0000), the command is aborted by the bootloader device, but the NACK (0x1F) is not sent to the host. As a result, the next 2 bytes (which are the number of bytes to be read/written and its checksum) are considered as a new command and its checksum. <sup>(1)</sup>

If the "number of data - 1" (N-1) to be read/written is not equal to a valid command code, then the limitation is not perceived from the host since the command is NACKed anyway (as an unsupported new command).

# 41 STM32L1xxxC devices bootloader

## 41.1 Bootloader configuration

The STM32L1xxxC bootloader is activated by applying pattern1 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 90. STM32L1xxxC configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
	RCC	HSI enabled	The system clock frequency is 16 MHz using the HSI. This is used only for USART1 and USART2 bootloaders and during USB detection for DFU bootloader (once the DFU bootloader is selected, the clock source is derived from the external crystal).
		HSE enabled	The external clock is mandatory only for the DFU bootloader and must be in the following range: [24, 16, 12, 8, 6, 4, 3, 2] MHz.  The PLL is used to generate the USB 48 MHz clock and the 32 MHz clock for the system clock.
Common to all bootloaders		-	The Clock Security System (CSS) interrupt is enabled for the DFU bootloader. Any failure (or removal) of the external clock generates a system reset.
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value and is periodically refreshed to prevent watchdog resets (in case the hardware IWDG option was previously enabled by the user).
	Power	-	Voltage range is set to Voltage Range 1.
	System memory	-	8 Kbyte starting from address 0x1FF0 0000. This area contains the bootloader firmware.
	RAM	-	4 Kbyte starting from address 0x20000000 are used by the bootloader firmware.
	USART1	Enabled	Once initialized, the USART1 configuration is 8 bits, even parity and 1 stop bit.
USART1 bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART1 and USART2 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for the USARTx bootloader.

Table 90. STM32L1xxxC configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
USART2 bootloader	USART2	Enabled	Once initialized, the USART2 configuration is 8 bits, even parity and 1 stop bit. The USART2 uses its remapped pins.
	USART2_RX pin	Input	PD6 pin: USART2 in reception mode
	USART2_TX pin	Output	PD5 pin: USART2 in transmission mode
	USB	Enabled	USB used in FS mode
DFU bootloader	USB_DM pin	Input/Output	PA11: USB DM line.
	USB_DP pin		PA12: USB DP line An external pull-up resistor 1.5 KOhm must be connected to USB_DP pin.

The system clock is derived from the embedded internal high-speed RC for the USARTx bootloader. This internal clock is also used the for DFU bootloader but only for the selection phase. An external clock in the range of [24, 16, 12, 8, 6, 4, 3, 2] MHz is required for the execution of the DFU bootloader after the selection phase.



### 41.2 Bootloader selection

The figure below shows the bootloader selection mechanism.

System Reset System Init (Clock, GPIOs, IWDG, SysTick) Configure USB USB cable Detected No HSE = 24, 16, 12, 8, 6, 4, 3, 2 MHz 0x7F received on **USART**x Νο Generate System Yes reset Reconfigure System clock to 32MHz and Disable all USB clock to 48 MHz interrupt sources Configure Execute DFU USARTx bootloader using USB interrupts Execute BL\_USART\_Loop for USARTx MS35008V1

Figure 53. Bootloader selection for STM32L1xxxC devices

### 41.3 Bootloader version

The following table lists the STM32L1xxxC devices bootloader versions:

Table 91. STM32L1xxxC bootloader versions

Bootloader version number	Description	Known limitations
V4.0	Initial bootloader version	For the USART interface, two consecutive NACKs instead of 1 NACK are sent when a Read Memory or Write Memory command is sent and the RDP level is active.



## 42 STM32L1xxxD devices bootloader

# 42.1 Bootloader configuration

The STM32L1xxxD bootloader is activated by applying pattern4 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 92. STM32L1xxxD configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
	RCC	HSI enabled	The system clock frequency is 16 MHz using the HSI. This is used only for USART1 and USART2 bootloaders and during USB detection for DFU bootloader (once the DFU bootloader is selected, the clock source will be derived from the external crystal).
		HSE enabled	The external clock is mandatory only for DFU bootloader and it must be in the following range: [24, 16, 12, 8, 6, 4, 3, 2] MHz.  The PLL is used to generate the USB 48 MHz clock and the 32 MHz clock for the system clock.
Common to all bootloaders		-	The Clock Security System (CSS) interrupt is enabled for the DFU bootloader. Any failure (or removal) of the external clock generates system reset.
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value and is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
	Power	-	Voltage range is set to Voltage Range 1.
	System memory	-	8 Kbyte starting from address 0x1FF0 0000. This area contains the bootloader firmware.
	RAM	-	4 Kbyte starting from address 0x20000000 are used by the bootloader firmware.
	USART1	Enabled	Once initialized, the USART1 configuration is: 8 bits, even parity and 1 Stop bit.
USART1 bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART1 and USART2 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloader.



Table 92. STM32L1xxxD configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
USART2 bootloader	USART2	Enabled	Once initialized, the USART2 configuration is: 8 bits, even parity and 1 Stop bit. The USART2 uses its remapped pins.
	USART2_RX pin	Input	PD6 pin: USART2 in reception mode
	USART2_TX pin	Output	PD5 pin: USART2 in transmission mode
	USB	Enabled	USB used in FS mode
DFU bootloader	USB_DM pin		PA11: USB DM line.
	USB_DP pin	Input/Output	PA12: USB DP line An external pull-up resistor 1.5 KOhm must be connected to USB_DP pin.

The system clock is derived from the embedded internal high-speed RC for USARTx bootloader. This internal clock is used also for DFU bootloader but only for the selection phase. An external clock in the range of [24, 16, 12, 8, 6, 4, 3, 2] MHz is required for DFU bootloader execution after the selection phase.

### 42.2 Bootloader selection

The figure below shows the bootloader selection mechanism.

System Reset BFB2 bit reset (BFB2 = 0)Protection level2 enabled If Value @0x08030000 is within int. SRAM yes address Jump to user code in Bank2 If Value no @0x08030000 is within int. SRAM If Value address Jump to user code @0x08000000 is in Bank2 within int. SRAM address Jump to user code no in Bank1 If Value @0x08000000 is Continue Bootloader execution within int. SRAM address Jump to user code Disable all in Bank1 interrupt sources no CPU blocked System Init (Clock, GPIOs, (halted) IWDG, SysTick) Configure USB USB cable Generate System HSE detected Detected reset Yes no Configure Yes **USART**x Reconfigure System 0x7F received on clock to 32MHz and **USART**x USB clock to 48 MHz Execute no BL USART Loop for USARTx **Execute DFU** bootloader using USB interrupts MS35009V2

Figure 54. Bootloader selection for STM32L1xxxD devices



## 42.3 Bootloader version

The following table lists the STM32L1xxxD devices bootloader versions:

Table 93. STM32L1xxxD bootloader versions

Bootloader version number	Description	Known limitations
V4.1	Initial bootloader version	<ul> <li>In the bootloader code the PA13 (JTMS/SWDIO) I/O output speed is configured to 400 KHz, as consequence some debugger can not connect to the device in Serial Wire mode when the bootloader is running.</li> <li>When the DFU bootloader is selected, the RTC is reset and thus all RTC information (calendar, alarm,) will be lost including backup registers. Note: When the USART bootloader is selected there is no change on the RTC configuration (including backup registers).</li> </ul>
V4.2	Fix V4.1 limitations (available on Rev.Z devices only.)	<ul> <li>Stack overflow by 8 bytes when jumping to Bank1/Bank2 if BFB2=0 or when Read Protection level is set to 2.</li> <li>Workaround: the user code should force in the startup file the top of stack address before to jump to the main program. This can be done in the "Reset_Handler" routine.</li> <li>When the Stack of the user code is placed outside the SRAM (ie. @ 0x2000C000) the bootloader cannot jump to that user code which is considered invalid. This might happen when using compilers which place the stack at a non-physical address at the top of the SRAM (ie. @ 0x2000C000). Workaround: place manually the stack at a physical address.</li> </ul>
V4.5	Fix V4.2 limitations. DFU interface robustness enhancements (available on Rev.Y devices only).	- For the USART interface, two consecutive NACKs (instead of 1 NACK) are sent when a Read Memory or Write Memory command is sent and the RDP level is active.



## 43 STM32L1xxxE devices bootloader

# 43.1 Bootloader configuration

The STM32L1xxxE bootloader is activated by applying pattern4 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 94. STM32L1xxxE configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
		HSI enabled	The system clock frequency is 16 MHz using the HSI. This is used only for USART1 and USART2 bootloaders and during USB detection for DFU bootloader (once the DFU bootloader is selected, the clock source will be derived from the external crystal).
Common to all bootloaders	RCC	HSE enabled	The external clock is mandatory only for DFU bootloader and it must be in the following range: [24, 16, 12, 8, 6, 4, 3, 2] MHz.  The PLL is used to generate the USB 48 MHz clock and the 32 MHz clock for the system clock.
		-	The Clock Security System (CSS) interrupt is enabled for the DFU bootloader. Any failure (or removal) of the external clock generates system reset.
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value and is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
	Power	-	Voltage range is set to Voltage Range 1.
	System memory	-	8 Kbyte starting from address 0x1FF0 0000. This area contains the bootloader firmware.
	RAM	-	4 Kbyte starting from address 0x20000000 are used by the bootloader firmware.
	USART1	Enabled	Once initialized, the USART1 configuration is: 8 bits, even parity and 1 Stop bit.
USART1 bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART1 and USART2 bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloader.



Table 94. STM32L1xxxE configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
USART2 bootloader	USART2	Enabled	Once initialized, the USART2 configuration is: 8 bits, even parity and 1 Stop bit. The USART2 uses its remapped pins.
	USART2_RX pin	Input	PD6 pin: USART2 in reception mode
	USART2_TX pin	Output	PD5 pin: USART2 in transmission mode
	USB	Enabled	USB used in FS mode
	USB_DM pin		PA11: USB DM line.
DFU bootloader	USB_DP pin	Input/Output	PA12: USB DP line An external pull-up resistor 1.5 KOhm must be connected to USB_DP pin.

The system clock is derived from the embedded internal high-speed RC for USARTx bootloader. This internal clock is used also for DFU bootloader but only for the selection phase. An external clock in the range of [24, 16, 12, 8, 6, 4, 3, 2] MHz is required for DFU bootloader execution after the selection phase.

### 43.2 Bootloader selection

The figure below shows the bootloader selection mechanism.

System Reset BFB2 bit reset (BFB2 = 0)Protection Jevel2 enabled If Value @0x08040000 is within int. SRAM address Jump to user code in Bank2 If Value no @0x08040000 is no within int. SRAM If Value address Jump to user code @0x08000000 is in Bank2 within int. SRAM address no Jump to user code in Bank1 If Value @0x08000000 is Continue Bootloader execution within int. SRAM address Jump to user code in Bank1 Disable all interrupt sources no CPU blocked System Init (Clock, GPIOs, (halted) IWDG, SysTick) Configure USB USB cable Generate System HSE detected Detected reset Yes no Configure Yes **USART**x Reconfigure System 0x7F received on clock to 32MHz and **USART**x USB clock to 48 MHz Execute nο BL USART Loop for USARTx Execute DFU bootloader using USB interrupts

Figure 55. Bootloader selection for STM32L1xxxE devices

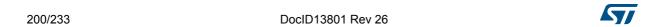
MS35034V2

## 43.3 Bootloader version

The following table lists the STM32L1xxxE devices bootloader versions:

Table 95. STM32L1xxxE bootloader versions

Bootloader version number	Description	Known limitations
V4.0	Initial bootloader version	For the USART interface, two consecutive NACKs (instead of 1 NACK) are sent when a Read Memory or Write Memory command is sent and the RDP level is active.



### 44 STM32L476xx/486xx devices bootloader

Two bootloader versions are available on STM32L476xx/486xx:

- V10.x supporting USART, I2C and DFU (USB FS Device).
   This version is embedded in STM32L476xx/486xx rev. 2 and rev. 3 devices.
- V9.x supporting USART, I2C, SPI, CAN and DFU (USB FS Device).
   This version is embedded in STM32L476xx/486xx rev. 4 devices.

### 44.1 Bootloader V10.x

#### 44.1.1 Bootloader configuration

The STM32L476xx/486xx bootloader is activated by applying pattern7 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

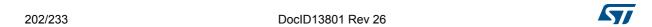
Table 96. STM32L476xx/486xx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment	
		HSI enabled	The HSI is used at startup as clock source for system clock configured to 72 MHz and for USART and I2C bootloader operation.	
		HSE enabled	The HSE is used only when the USB interface is selected and the LSE is not present. The HSE must have one of the following value [24,20,18,16,12,9,8,6,4] MHz.	
	RCC	LSE enabled	The LSE is used to trim the MSI which is configured to 48 MHz as USB clock source. The LSE must be equal to 32,768 KHz. If the LSE is not detected, the HSE will be used instead if USB is connected.	
		MSI enabled	The MSI is configured to 48 MHz and will be used as USB clock source. The MSI is used only if LSE is detected, otherwise, HSE will be used if USB is connected.	
Common to all bootloaders		-	The Clock Security System (CSS) interrupt is enabled when LSE or HSE is enabled. Any failure (or removal) of the external clock generates system reset.	
	RAM	-	12 Kbyte starting from address 0x20000000 are used by the bootloader firmware	
	System memory	-	28672 byte starting from address 0x1FFF0000, contain the bootloader firmware	
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).	
	Power	-	The DFU can't be used to communicate with Bootloader if the voltage scaling range 2 is selected. Bootloader firmware doesn't configure voltage scaling range value in PWR_CR1 register.	



Table 96. STM32L476xx/486xx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral State		Comment	
USART1	USART1	Enabled	Once initialized the USART1 configuration is: 8-bits, even parity and 1 Stop bit	
bootloader	USART1_RX pin	Input	PA10 pin: USART1 in reception mode	
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode	
USART2	USART2	Enabled	Once initialized the USART2 configuration is: 8-bits, even parity and 1 Stop bit	
bootloader	USART2_RX pin	Input	PA3 pin: USART2 in reception mode	
	USART2_TX pin	Output	PA2 pin: USART2 in transmission mode	
USART3	USART3	Enabled	Once initialized the USART3 configuration is: 8-bits, even parity and 1 Stop bit	
bootloader	USART3_RX pin	Input	PC11 pin: USART3 in reception mode	
	USART3_TX pin	Output	PC10 pin: USART3 in transmission mode	
USARTx bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.	
I2C1 bootloader	I2C1	Enabled	The I2C1 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b1000011x (where x = 0 for write and x = 1 for read)	
	I2C1_SCL pin	Input/Output	PB6 pin: clock line is used in open-drain mode.	
	I2C1_SDA pin	Input/Output	PB7 pin: data line is used in open-drain mode.	
I2C2 bootloader	I2C2	Enabled	The I2C2 configuration is:  I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON.  Slave 7-bit address: 0b1000011x  (where x = 0 for write and x = 1 for read)	
	I2C2_SCL pin	Input/Output	PB10 pin: clock line is used in open-drain mode.	
	I2C2_SDA pin	Input/Output	PB11 pin: data line is used in open-drain mode.	
I2C3 bootloader	I2C3	Enabled	The I2C3 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address is 0b1000011x (where x = 0 for write and x = 1 for read)	
	I2C3_SCL pin	Input/Output	PC0 pin: clock line is used in open-drain mode.	
	I2C3_SDA pin	Input/Output	PC1 pin: data line is used in open-drain mode.	
	USB	Enabled	USB OTG FS configured in Forced Device mode	
	USB_DM pin		PA11: USB DM line.	
DFU bootloader	USB_DP pin	Input/Output	PA12: USB DP line No external Pull-up resistor is required	
	TIM17	Enabled	This timer is used to determine the value of the HSE. Once the HSE frequency is determined, the system clock is configured to 72 MHz using PLL and HSE.	



For USARTx and I2Cx bootloaders no external clock is required.

USB bootloader (DFU) requires either an LSE (low-speed external clock) or a HSE (high-speed external clock) :

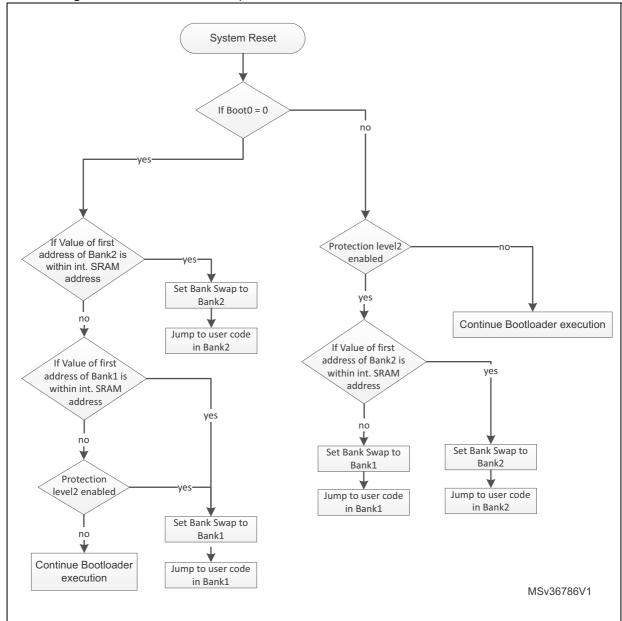
- In case, the LSE is present regardless the HSE presence, the MSI will be configured and trimmed by the LSE to provide an accurate clock equal to 48 MHz which is the clock source of the USB. The system clock is kept clocked to 24 MHz by the HSI.
- In case, the HSE is present, the system clock and USB clock will be configured respectively to 24 MHz and 48 MHz with HSE as clock source.

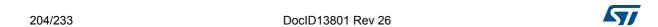


#### 44.1.2 Bootloader selection

The Figure 56 and Figure 57 show the bootloader selection mechanism.

Figure 56. Dual Bank Boot Implementation for STM32L476xx/486xx Bootloader v10.x





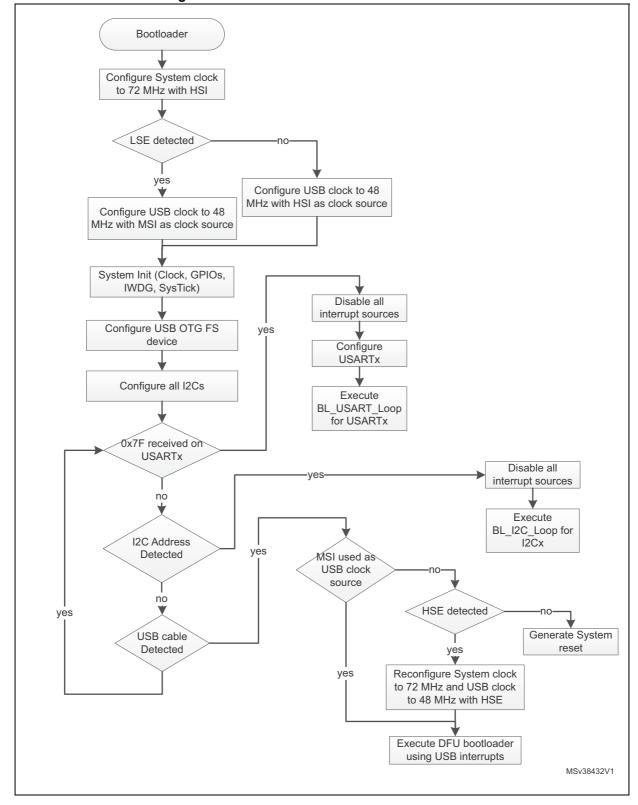


Figure 57.Bootloader V10.x selection for STM32L476xx/486xx

### 44.1.3 Bootloader version

The following table lists the STM32L476xx/486xx devices bootloader V10.x versions:

Table 97. STM32L476xx/486xx bootloader V10.x versions

Bootloader version number	Description	Known limitations
V10.0	Deprecated version (not used)	None
V10.1	Initial bootloader version	Write in SRAM is corrupted
V10.2	Fix write in SRAM issue	None
V10.3	Add support of MSI as USB clock source (MSI is trimmed by LSE). Update dual bank boot feature to support the case when user stack is mapped in SRAM2.	None



### 44.2 Bootloader V9.x

### 44.2.1 Bootloader configuration

The STM32L476xx/486xx bootloader is activated by applying pattern7 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 98. STM32L476xx/486xx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
	RCC	HSI enabled	The HSI is used at startup as clock source for system clock configured to 72 MHz and for USART and I2C bootloader operation.
		HSE enabled	The HSE is used only when the USB interface is selected and the LSE is not present. The HSE must have one of the following values [24,20,18,16,12,8,6,4] MHz.System is clocked at 72 MHz if USB is used or 60 MHz if CAN is used.
		LSE enabled	The LSE is used to trim the MSI which is configured to 48 MHz as USB clock source. The LSE must be equal to 32,768 KHz. If the LSE is not detected, the HSE will be used instead if USB is connected.
Common to all		MSI enabled	The MSI is configured to 48 MHz and will be used as USB clock source. The MSI is used only if LSE is detected, otherwise, HSE will be used if USB is connected.
bootloaders		CSS	The Clock Security System (CSS) interrupt is enabled when LSE or HSE is enabled. Any failure (or removal) of the external clock generates system reset.
	RAM	-	12544 byte starting from address 0x20000000 are used by the bootloader firmware
	System memory	-	28672 byte starting from address 0x1FFF0000, contain the bootloader firmware
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
	Power	-	The DFU can't be used to communicate with Bootloader if the voltage scaling range 2 is selected. Bootloader firmware doesn't configure voltage scaling range value in PWR_CR1 register.
USART1	USART1	Enabled	Once initialized the USART1 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART1_RX pin	Input	PA10 pin: USART2 in reception mode
	USART1_TX pin	Output	PA9 pin: USART2 in transmission mode



Table 98. STM32L476xx/486xx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
USART2	USART2	Enabled	Once initialized the USART2 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART2_RX pin	Input	PA3 pin: USART2 in reception mode
	USART2_TX pin	Output	PA2 pin: USART2 in transmission mode
USART3	USART3	Enabled	Once initialized the USART3 configuration is: 8-bits, even parity and 1 Stop bit
bootloader	USART3_RX pin	Input	PC11 pin: USART3 in reception mode
	USART3_TX pin	Output	PC10 pin: USART3 in transmission mode
USARTx bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.
I2C1 bootloader	I2C1	Enabled	The I2C1 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b1000011x (where x = 0 for write and x = 1 for read)
	I2C1_SCL pin	Input/Output	PB6 pin: clock line is used in open-drain mode.
	I2C1_SDA pin	Input/Output	PB7 pin: data line is used in open-drain mode.
I2C2 bootloader	I2C2	Enabled	The I2C2 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b1000011x (where x = 0 for write and x = 1 for read)
	I2C2_SCL pin	Input/Output	PB10 pin: clock line is used in open-drain mode.
	I2C2_SDA pin	Input/Output	PB11 pin: data line is used in open-drain mode.
I2C3 bootloader	I2C3	Enabled	The I2C3 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b1000011x (where x = 0 for write and x = 1 for read)
	I2C3_SCL pin	Input/Output	PC0 pin: clock line is used in open-drain mode.
	I2C3_SDA pin	Input/Output	PC1 pin: data line is used in open-drain mode.
	SPI1	Enabled	The SPI1 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
SPI1 bootloader	SPI1_MOSI pin	Input	PA7 pin: Slave data Input line, used in Push- pull pull-down mode
	SPI1_MISO pin	Output	PA6 pin: Slave data output line, used in Push- pull pull-down mode
	SPI1_SCK pin	Input	PA5 pin: Slave clock line, used in Push-pull pull-down mode
	SPI1_NSS pin	Input	PA4 pin: Slave Chip Select pin used in Pushpull pull-down mode.



Table 98. STM32L476xx/486xx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
	SPI2	Enabled	The SPI2 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware
CDIO haadlaadar	SPI2_MOSI pin	Input	PB15 pin: Slave data Input line, used in Push- pull pull-down mode
SPI2 bootloader	SPI2_MISO pin	Output	PB14 pin: Slave data output line, used in Push- pull pull-down mode
	SPI2_SCK pin	Input	PB13 pin: Slave clock line, used in Push-pull pull-down mode
	SPI2_NSS pin	Input	PB12 pin: Slave Chip Select pin used in Push-pull pull-down mode.
	CAN1	Enabled	Once initialized the CAN1 configuration is: Baudrate 125 kbps, 11-bit identifier.
CAN1 bootloader	CAN1_RX pin	Input	PB8 pin: CAN1 in reception mode
	CAN1_TX pin	Output	PB9 pin: CAN1 in transmission mode
DFU bootloader	USB	Enabled	USB FS configured in Forced Device mode. USB FS interrupt vector is enabled and used for USB DFU communications.  NOTE: VDDUSB IO must be connected to 3.3V for USB to be operational.
	USB_DM pin		PA11 pin: USB FS DM line
	USB_DP pin	Input/Output	PA12 pin: USB FS DP line. No external Pull-up resistor is required.

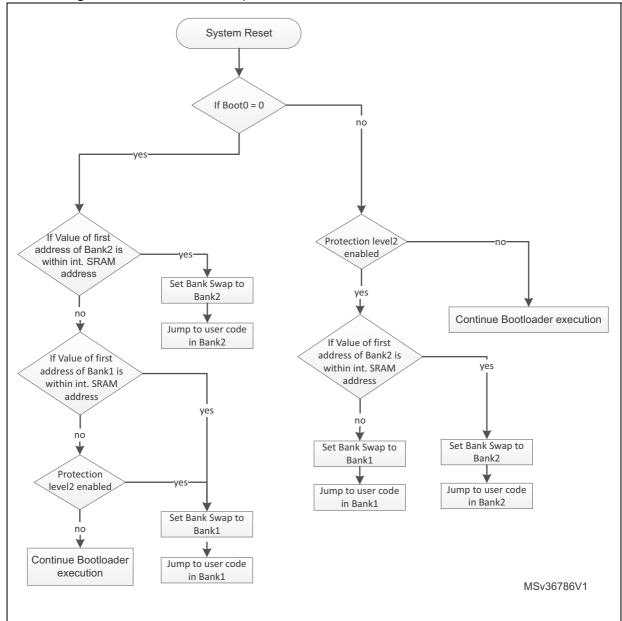
In case, the HSE is present, the system clock and USB clock will be configured respectively to 72 MHz and 48 MHz with PLL (clocked by HSE) as a clock source.

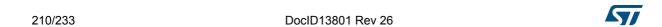


#### 44.2.2 Bootloader selection

The figures below show the bootloader selection mechanism.

Figure 58. Dual Bank Boot Implementation for STM32L476xx/486xx Bootloader v9.x





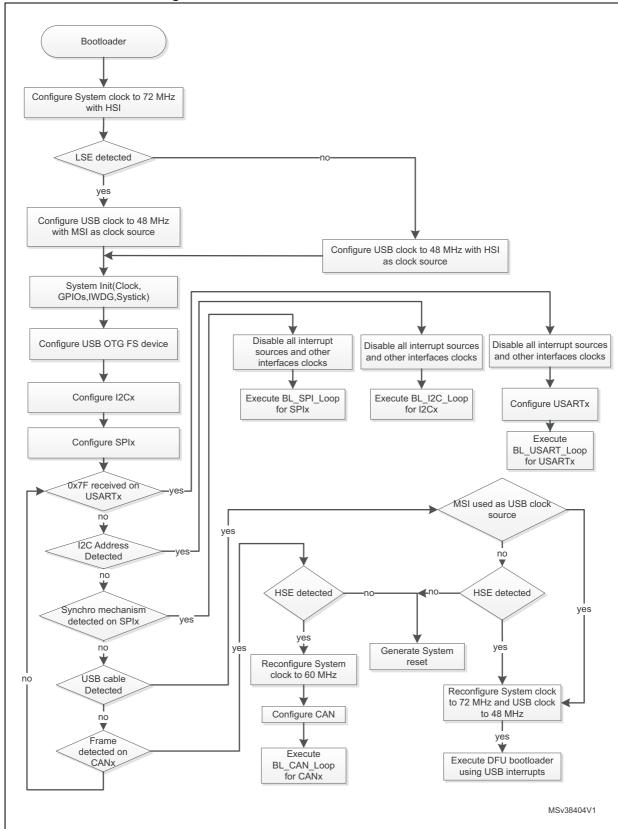


Figure 59.Bootloader V9.x selection for STM32L476xx/486xx

### 44.2.3 Bootloader version

The following table lists the STM32L476xx/486xx devices bootloader V9.x versions:

Table 99. STM32L476xx/486xx bootloader V9.x versions

Bootloader version number	Description	Known limitations	
V9.0	Initial bootloader version	None	



# 45 Device-dependent bootloader parameters

The bootloader protocol's command set and sequences for each serial peripheral are the same for all STM32 devices. However, some parameters depend on device and bootloader version:

- PID (Product ID)
- Valid RAM memory addresses (RAM area used during bootloader execution is not accessible) accepted by the bootloader when the Read Memory, Go and Write Memory commands are requested.
- System Memory area.

The table below shows the values of these parameters for each STM32 device bootloader in production.

Table 100. Bootloader device-dependent parameters

STM32 series	De	vice	PID	BL ID	RAM memory	System memory
	STM32F05xxx and STM32F030x8 devices		0x440	0x21	0x20000800 - 0x20001FFF	0x1FFFEC00 - 0x1FFFF7FF
	STM32F03xx	4/6	0x444	0x10	0x20000800 - 0x20000FFF	
	STM32F030x	С	0x442	0x52	0x20001800 - 0x20007FFF	0x1FFFD800 - 0x1FFFF7FF
F0	STM32F04xx	х	0x445	0xA0	NA	0x1FFFC400 - 0x1FFFF7FF
	STM32F070x	6	0x445	0xA2	NA	0x1FFFC400 - 0x1FFFF7FF
	STM32F070x	В	0x448	0xA2	NA	0x1FFFC800 - 0x1FFFF7FF
	STM32F071x	x/72xx	0x448	0xA1	0x20001800 - 0x20003FFF	0x1FFFC800 - 0x1FFFF7FF
	STM32F09xx	x	0x442	0x50	NA	0x1FFFD800 - 0x1FFFF7FF
		Low-density	0x412	NA	0x20000200 - 0x200027FF	
		Medium- density	0x410	NA	0x20000200 - 0x20004FFF	
	STM32F10x	High-density	0x414	NA	0x20000200 - 0x2000FFFF	
F1	xx	Medium- density value line	0x420	0x10	0x20000200 - 0x20001FFF	0x1FFFF000 - 0x1FFFF7FF
		High-density value line	0x428	0x10	0x20000200 - 0x20007FFF	
	STM32F105xx/107xx		0x418	NA	0x20001000 - 0x2000FFFF	0x1FFFB000 - 0x1FFFF7FF
	STM32F10xx	x XL-density	0x430	0x21	0x20000800 - 0x20017FFF	0x1FFFE000 - 0x1FFFF7FF
F2	F2 STM32F2xxxx		0x411	0x20	0x20002000 - 0x2001FFFF	0x1FFF0000 - 0x1FFF77FF
1 4			0.411	0x33	1 UXZUUUZUUU - UXZUU IFFFF	UX 1FFFUUUU - UX 1FFF//FF



Table 100. Bootloader device-dependent parameters (continued)

	Device TM32F373xx				System
	TM32F373xx	PID	ID	RAM memory	memory
l ST		0x432	0x41	0x20001400 - 0x20007FFF	0x1FFFD800 - 0x1FFFF7FF
l <u>Ŭ</u>	TM32F378xx		0x50	0x20001000 - 0x20007FFF	
ST	TM32F302xB(C)/303xB(C)	0x422	0x41	0x20001400 - 0x20009FFF	
ST	TM32F358xx		0x50		
F3 S1	TM32F301xx/302x4(6/8)	0x439	0x40	0x20001800 - 0x20003FFF	
ST	TM32F318xx		0x50		
	TM32F303x4(6/8)/ 34xx/328xx	0x438	0x50	0x20001800 - 0x20002FFF	
ST	TM32F302xD(E)/303xD(E)	0x446	0x40	0x20001800 - 0x2000FFFF	
ST	TM32F398xx	0x446	0x50	0x20001800 - 0x2000FFFF	
61	STM32F40xxx/41xxx	0x413	0x31	0x20002000 - 0x2001FFFF	0x1FFF0000 - 0x1FFF77FF
	110132F40XXX/41XXX	08413	0x90	0x20003000 - 0x2001FFFF	
67	TM22F42yoo/42yoo	0x419	0x70	0x20003000 - 0x2002FFFF	
	STM32F42xxx/43xxx		0x90		
ST	TM32F401xB(C)	0x423	0xD1	0x20003000 - 0x2000FFFF	
F4 S1	TM32F401xD(E)	0x433	0xD1	0x20003000 - 0x20017FFF	
ST	TM32F410xx	0x458	0xB1	0x20003000 - 0x20007FFF	
ST	TM32F411xx	0x431	0xD0	0x20003000 - 0x2001FFFF	
ST	TM32F412xx	0x441	0x90	0x20003000 - 0x2003FFFF	
ST	TM32F446xx	0x421	0x90	0x20003000 - 0x2001FFFF	
ST	TM32F469xx/479xx	0x434	0x90	0x20003000 - 0x2005FFFF	
F7 S1	STM32F74xxx/75xxx	0x449	0x70	0x20004000 - 0x2004FFFF	0x1FF00000 - 0x1FF0EDBF
17   31			0x90	0x20004000 - 0x2004FFFF	0x1FF00000 - 0x1FF0EDBF
ST	TM32L01xxx/02xxx	0x457	0xC3	NA	0x1FF00000 - 0x1FF00FFF
ST	TM32L031xx/041xx	0x425	0xC0	0x20001000 - 0x20002000	0x1FF00000 - 0x1FF00FFF
L0 S1	TM32L05xxx/06xxx	0x417	0xC0	0x20001000 - 0x20001FFF	0x1FF00000 - 0x1FF00FFF
97	STM32L07xxx/08xxx	0x447	0x41	0x20001000 - 0x20004FFF	0x1FF00000 - 0x1FF01FFF
			0xB2	0x20001400 - 0x20004FFF	
ST	TM32L1xxx6(8/B)	0x416	0x20	0x20000800 - 0x20003FFF	0x1FF00000 - 0x1FF01FFF
ST	TM32L1xxx6(8/B)A	0x429	0x20	Ox20001000 - 0x20007FFF	
L1 S1	TM32L1xxxC	0x427	0x40		
ST	TM32L1xxxD	0x436	0x45	0x20001000 - 0x2000BFFF	
ST	TM32L1xxxE	0x437	0x40	0x20001000 - 0x20013FFF	

### Table 100. Bootloader device-dependent parameters (continued)

STM32 series	Device	PID	BL ID	RAM memory	System memory
L4	STM32L476xx/486xx	0x415	0xA3	0x20003000 - 0x20017FFF	- 0x1FFF0000 - 0x1FFF6FFF
			0x90	0x20003100 - 0x20017FFF	



**Bootloader timing AN2606** 

#### **Bootloader timing** 46

This section presents the typical timings of the bootloader firmware that should be used to ensure correct synchronization between host and STM32 device.

Two types of timings will be described herein:

- STM32 device bootloader resources initialization duration.
- Communication interface selection duration.

After these timings the bootloader is ready to receive and execute host commands.

#### **Bootloader Startup timing** 46.1

After bootloader reset, the host should wait until the STM32 bootloader is ready to start detection phase with a specific interface communication. This time corresponds to bootloader startup timing, during which resources used by bootloader are initialized.

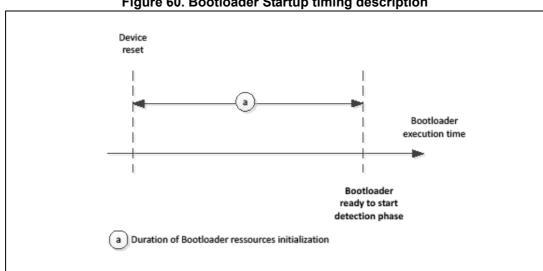


Figure 60. Bootloader Startup timing description

The table below contains the minimum startup timing for each STM32 product:

**Minimum Device** bootloader Startup **HSE Timeout (ms)** (ms) STM32F03xx4/6 1.612 NA STM32F05xxx and STM32F030x8 devices 1.612 NA STM32F04xxx 0.058 NA STM32F071xx/72xx 0.058 NA HSE connected 3 STM32F070x6 200 HSE not connected 230

Table 101. Bootloader startup timings of STM32 devices

Table 101. Bootloader startup timings of STM32 devices (continued)

Device	Minimum bootloader Startup (ms)	HSE Timeout (ms)	
CTM22F070vD	HSE connected	6	200
STM32F070xB	HSE not connected	230	200
STM32F09xxx	·	2	NA
STM32F10xxx		1.227	NA
STM32F105xx/107xx	PA9 pin low	1.396	NA
31W32F103XX/107XX	PA9 pin high	524.376	I INA
STM32F10xxx XL-density		1.227	NA
CTM22F2vavav	V2.x	134	NA
STM32F2xxxx	V3.x	84.59	0.790
CTM22F204vv/202v4/C/2)	HSE connected	45	E60 E
STM32F301xx/302x4(6/8)	HSE not connected	560.8	560.5
OTM00F000::P(O)/000::P(O)	HSE connected	43.4	0.000
STM32F302xB(C)/303xB(C)	HSE not connected	2.36	2.236
	HSE connected	7.53	NA
STM32F302xD(E)/303xD	HSE not connected	146.71	NA
STM32F303x4(6/8)/334xx/328xx	0.155	NA	
STM32F318xx	0.182	NA	
STM32F358xx	1.542	NA	
OTMO0F070	HSE connected	43.4	0.000
STM32F373xx	HSE not connected	2.36	2.236
STM32F378xx	-	1.542	NA
STM32F398xx		1.72	NA
CTM20F40van/44van/	V3.x	84.59	0.790
STM32F40xxx/41xxx	V9.x	74	96
STM32F401xB(C)		74.5	85
STM32F401xD(E)		74.5	85
STM32F410xx		0.614	NA
STM32F411xx		74.5	85
STM32F412xx		0.614	180
OTM00F400/400	V7.x	82	97
STM32F429xx/439xx	V9.x	74	97
STM32F446xx	·	73.61	96
STM32F469xx/479xx		73.68	230

Table 101. Bootloader startup timings of STM32 devices (continued)

Device			Minimum bootloader Startup (ms)	HSE Timeout (ms)
STM32F74xxx/75xxx			16.63	50
STM32L01xxx/02xxx			0.63	NA
STM32L031xx/041xx			0.62	NA
STM32L05xxx/06xxx			0.22	NA
STM32L07xxx/08xxx		V4.x	0.61	NA
STIVISZEU/XXX/UOXXX	V11.x		0.71	NA
STM32L1xxx6(8/B)A			0.542	NA
STM32L1xxx6(8/B)			0.542	NA
STM32L1xxxC			0.708	80
STM32L1xxxD			0.708	80
STM32L1xxxE			0.708	200
	)/40 ··		55	100
STM32L476xx/486xx	V10.x	LSE Not Connected	2560	100
511VI32L410XX/480XX		LSE connected	55,40	100
	V9.x	LSE not connected	2560,51	100

## 46.2 USART connection timing

USART connection timing is the time that the host should wait for between sending the synchronization data (0x7F) and receiving the first acknowledge response (0x79).

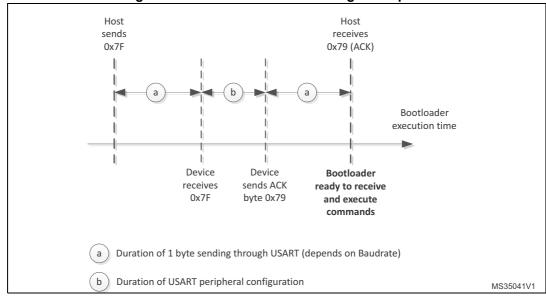


Figure 61. USART connection timing description

- Receiving any other character different from 0x7F (or line glitches) will cause Bootloader to start communication using a wrong baudrate. Bootloader measures the signal length between rising edge of first 1 bit in 0x7F to the falling edge of the last 1 bit in 0x7F to deduce the baudrate value
- Bootloader does not re-align the calculated baudrate to standard baudrate values (ie. 1200, 9600, 115200, ...).

Note:

For STM32F105xx/107xx line devices, PA9 pin (USB\_VBUS) is used to detect the USB host connection. The initialization of USB peripheral is performed only if PA9 is high at detection phase which means that a host is connected to the port and delivering 5 V on the USB bus. When PA9 level is high at detection phase, more time is required to initialize and shutdown the USB peripheral. To minimize bootloader detection time when PA9 pin is not used, keep PA9 state low during USART detection phase from the moment the device is reset till a device ACK is sent.

Table 102. USART bootloader minimum timings of STM32 devices

Device	One USART byte sending (ms)	USART configuration (ms)	USART connection (ms)
STM32F03xx4/6	0.078125	0.0064	0.16265
STM32F05xxx and STM32F030x8 devices	0.078125	0.0095	0.16575
STM32F04xxx	0.078125	0.007	0.16325
STM32F071xx/72xx	0.078125	0.007	0.16325
STM32F070x6	0.078125	0.014	0.17
STM32F070xB	0.078125	0.08	0.23

Table 102. USART bootloader minimum timings of STM32 devices (continued)

Device		One USART byte sending (ms)	USART configuration (ms)	USART connection (ms)
STM32F09xxx	STM32F09xxx		0.07	0.22
STM32F10xxx		0.078125	0.002	0.15825
STM32F105xx/107xx	PA9 pin low	0.078125	0.007	0.16325
31W32F103XX/107XX	PA9 pin High	0.076125	105	105.15625
STM32F10xxx XL-density	•	0.078125	0.006	0.16225
CTM22F2yoog	V2.x	0.079125	0.000	0.46505
STM32F2xxxx	V3.x	0.078125	0.009	0.16525
OTN 400 F 0 0 4 / 0 0 0 4 / 0 / 0 \	HSE connected	0.070405	0.000	0.45005
STM32F301xx/302x4(6/8)	HSE not connected	0.078125	0.002	0.15825
OTMOSEOGO D/O//000 D/O/	HSE connected	0.070405	0.000	0.45005
STM32F302xB(C)/303xB(C)	HSE not connected	0.078125	0.002	0.15825
STM32F302xD(E)/303xD		0.078125	0.002	0.15885
STM32F303x4(6/8)/334xx/328	xx	0.078125	0.002	0.15825
STM32F318xx		0.078125	0.002	0.15825
STM32F358xx		0.15625	0.001	0.3135
CTM22F272vv	HSE connected	0.070405	0.002	0.45925
STM32F373xx	HSE not connected	0.078125		0.15825
STM32F378xx	•	0.15625	0.001	0.3135
STM32F398xx		0.078125	0.002	0.15885
STM22E40vvv/41vvv	V3.x	0.079125	0.009	0.16525
STM32F40xxx/41xxx	V9.x	0.078125	0.0035	0.15975
STM32F401xB(C)		0.078125	0.00326	0.15951
STM32F401xD(E)		0.078125	0.00326	0.15951
STM32F410xx		0.078125	0.002	0.158
STM32F411xx		0.078125	0.00326	0.15951
STM32F412xx		0.078125	0.002	0.158
OTM005400/400	V7.x	0.070405	0.007	0.16325
STM32F429xx/439xx	V9.x	0.078125	0.00326	0.15951
STM32F446xx		0.078125	0.004	0.16
STM32F469xx/479xx		0.078125	0.003	0.159
STM32F74xxx/75xxx		0.078125	0.065	0.22
STM32L01xxx/02xxx		0.078125	0.016	0.17
STM32L031xx/041xx		0.078125	0.018	0.174

Table 102. USART bootloader minimum timings of STM32 devices (continued)

Device		One USART byte sending (ms)	USART configuration (ms)	USART connection (ms)
STM32L05xxx/06xxx		0.078125	0.018	0.17425
STM32L07xxx/08xxx	V4.x	0.078125	0.017	0.173
STIVISZEU/XXX/UOXXX	V11.x	0.078125	0.017	0.158
STM32L1xxx6(8/B)A		0.078125	0.008	0.16425
STM32L1xxx6(8/B)		0.078125	0.008	0.16425
STM32L1xxxC		0.078125	0.008	0.16425
STM32L1xxxD		0.078125	0.008	0.16425
STM32L1xxxE		0.078125	0.008	0.16425
STM32L476xx/486xx	V10.x	0.078125	0.003	0.159
	V9.x	0.078125	0.003	0.159

### 46.3 USB connection timing

USB connection timing is the time that the host should wait for between plugging the USB cable and establishing a correct connection with the device. This timing includes enumeration and DFU components configuration. USB connection depends on the host.

Figure 62. USB connection timing description

Note:

For STM32F105xx/107xx devices, if the external HSE crystal frequency is different from 25 MHz (14.7456 MHz or 8 MHz), the device performs several unsuccessful enumerations (with connect – disconnect sequences) before being able to establish a correct connection with the host. This is due to the HSE automatic detection mechanism based on Start Of Frame (SOF) detection.

Table 103. USB bootloader minimum timings of STM32 devices

	Device	USB connection (ms)
STM32F04xxx		350
STM32F070x6		TBD
STM32F070xB		320
	HSE = 25 MHz	460
STM32F105xx/107xx	HSE = 14.7465 MHz	4500
	HSE = 8 MHz	13700
STM32F2xxxx		270
STM32F301xx/302x4(6/8)		300
STM32F302xB(C)/303xB(C	C)	300
STM32F302xD(E)/303xD		100
STM32F373xx		300
STM32F40xxx/41xxx	V3.x	270
	V9.x	250
STM32F401xB(C)	<u> </u>	250
STM32F401xD(E)		250
STM32F411xx		250
STM32F412xx		380
STM32F429xx/439xx	V7.x	250
31W32F429XX/439XX	V9.x	250
STM32F446xx	·	200
STM32F469xx/479xx		270
STM32F74xxx/75xxx		230
STM32L07xxx/08xxx		140
STM32L1xxxC		849
STM32L1xxxD		849
CTM22L47650/496504	V10.x	300
STM32L476xx/486xx	V9.x	300

## 46.4 I2C connection timing

I2C connection timing is the time that the host should wait for between sending I2C device address and sending command code. This timing includes I2C line stretching duration.

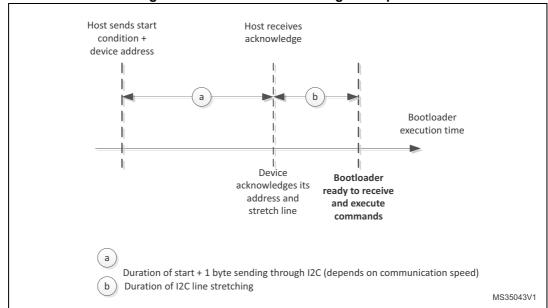


Figure 63. I2C connection timing description

Note:

For I2C communication, a timeout mechanism is implemented and it must be respected to execute bootloader commands correctly. This timeout is implemented between two I2C frames in the same command (eg: for Write memory command a timeout is inserted between command sending frame and address memory sending frame). Also the same timeout period is inserted between two successive data reception or transmission in the same I2C frame. If the timeout period is elapsed a system reset is generated to avoid bootloader crash.

In erase memory command and read-out unprotect command, the duration of flash operation should be taken into consideration when implementing the host side. After sending the code of pages to be erased, the host should wait until the bootloader device performs page erasing to complete the remaining steps of erase command.

Table 104. 120 bootloader minimum timings of 51 moz devices				
Device	Start condition + one I2C byte sending (ms)	I2C line stretching (ms)	I2C connection (ms)	I2C Timeout (ms)
STM32F04xxx	0.0225	0.0025	0.025	1000
STM32F071xx/72xx	0.0225	0.0025	0.025	1000
STM32F070x6	0.0225	0.002	0.245	1000
STM32F070xB	0.0225	0.002	0.245	1000
STM32F09xxx	0.0225	0.002	0.245	1000
STM32F410xx	0.0225	0.002	0.245	1000

Table 104. I2C bootloader minimum timings of STM32 devices

Table 104. I2C bootloader minimum timings of STM32 devices (continued)

Devi	ce	Start condition + one I2C byte sending (ms)	I2C line stretching (ms)	I2C connection (ms)	I2C Timeout (ms)
STM32F469xx/479xx		0.0225	0.002	0.245	1000
STM32F74xxx/75xxx		0.0225	0.002	0.245	500
STM32F303x4(6/8)/33	4xx/328xx	0.0225	0.0027	0.0252	1000
STM32F318xx		0.0225	0.0027	0.0252	1000
STM32F358xx		0.0225	0.0055	0.028	10
STM32F378xx		0.0225	0.0055	0.028	10
STM32F398xx		0.0225	0.002	0.245	1500
STM32F40xxx/41xxx		0.0225	0.0022	0.0247	1000
STM32F401xB(C)		0.0225	0022	0.0247	1000
STM32F401xD(E)		0.0225	0022	0.0247	1000
STM32F411xx		0.0225	0022	0.0247	1000
STM32F412xx		0.0225	0.002	0.245	1000
STM32F429xx/439xx	V7.x	0.0225	0.0033	0.0258	1000
51M32F429XX/439XX	V9.x	0.0225	0.0022	0.0247	1000
STM32F446xx		0.0225	0.002	0.245	1000
STM32L07xxx/08xxx		0.0225	0.002	0.245	1000
STM32L476xx/486xx	V10.x	0.0225	0.002	0.245	1000
3 1 W 3 2 L 4 / U X X / 4 0 U X X	V9.x	0.0225	0.002	0.245	1000

## 46.5 SPI connection timing

SPI connection timing is the time that the host should wait for between sending the synchronization data (0xA5) and receiving the first acknowledge response (0x79).

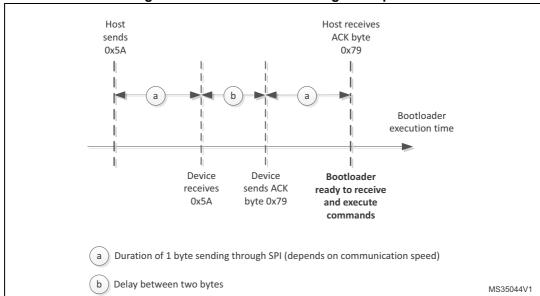


Figure 64. SPI connection timing description

Table 105. SPI bootloader minimum timings of STM32 devices

Device	One SPI byte sending (ms)	Delay between two bytes(ms)	SPI connection (ms)
All products	0.001	0.008	0.01

# 47 Revision history

Table 106. Document revision history

Date	Revision	Changes
22-Oct-2007	1	Initial release.
22-Jan-2008	2	All STM32 in production (rev. B and rev. Z) include the bootloader described in this application note.  Modified: Section 3.1: Bootloader activation and Section 1.4: Bootloader code sequence.  Added: Section 1.3: Hardware requirements, Section 1.5: Choosing the USART baud rate, Section 1.6: Using the bootloader and Section:  Note 2 linked to Get, Get Version & Read Protection Status and Get ID commands in Table 3: Bootloader commands, Note 3 added.  Notion of "permanent" (Permanent Write Unprotect/Readout Protect/Unprotect) removed from document. Small text changes.  Bootloader version upgraded to 2.0.
26-May-2008	3	Small text changes. RAM and System memory added to Table: The system clock is derived from the embedded internal high-speed RC, no external quartz is required for the bootloader execution.  Section 1.6: Using the bootloader on page 8 removed.  Erase modified, Note 3 modified and Note 1 added in Table 3: Bootloader commands on page 9.  Byte 3: on page 11 modified.  Byte 2: on page 13 modified.  Byte 2:, Bytes 3-4: and Byte 5: on page 15 modified, Note 3 modified.  Byte 8: on page 18 modified.  Notes added to Section 2.5: Go command on page 18.  Figure 11: Go command: device side on page 20 modified.  Note added in Section 2.6: Write Memory command on page 21.  Byte 8: on page 24 modified.  Figure 14: Erase Memory command: host side and Figure 15: Erase Memory command: device side modified.  Byte 3: on page 26 modified.  Table 3: Bootloader commands on page 9.  Note modified and note added in Section 2.8: Write Protect command on page 27.  Figure 16: Write Protect command: host side, Figure 17: Write Protect command: device side, Figure 19: Write Unprotect command: device side, Figure 21: Readout Protect command: device side and Figure 23: Readout Unprotect command: device side modified.
29-Jan-2009	4	This application note also applies to the STM32F102xx microcontrollers. Bootloader version updated to V2.2 (see <i>Table 4: Bootloader versions</i> ).



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Table 106. Document revision history (continued)

Date	Revision	Changes
19-Nov-2009	5	IWDG added to Table: The system clock is derived from the embedded internal high-speed RC, no external quartz is required for the bootloader execution. Note added.  BL changed bootloader in the entire document.  Go command description modified in Table: The system clock is derived from the embedded internal high-speed RC, no external quartz is required for the bootloader execution.  Number of bytes awaited by the bootloader corrected in Section 2.4: Read Memory command.  Note modified below Figure 10: Go command: host side.  Note removed in Section 2.5: Go command and note added.  Start RAM address specified and note added in Section 2.6: Write Memory command. All options are erased when a Write Memory command is issued to the Option byte area.  Figure 11: Go command: device side modified.  Figure 13: Write Memory command: device side modified.  Note added and bytes 3 and 4 sent by the host modified in Section 2.7: Erase Memory command.  Note added to Section 2.8: Write Protect command.
09-Mar-2010	6	Application note restructured. Value line and connectivity line device bootloader added (Replaces AN2662).  Introduction changed. Glossary added.
20-Apr-2010	7	Related documents: added XL-density line datasheets and programming manual.  Glossary: added XL-density line devices.  Table 3: added information for XL-density line devices.  Section 4.1: Bootloader configuration: updated first sentence.  Section 5.1: Bootloader configuration: updated first sentence.  Added Section 6: STM32F10xxx XL-density devices bootloader.  Table 65: added information for XL-density line devices.
08-Oct-2010	8	Added information for high-density value line devices in <i>Table 3</i> and <i>Table 65</i> .
14-Oct-2010	9	Removed references to obsolete devices.
26-Nov-2010	10	Added information on ultralow power devices.
13-Apr-2011	11	Added information related to STM32F205/215xx and STM32F207/217xx devices.  Added Section 32: Bootloader timing
06-Jun-2011	12	Updated:  - Table 12: STM32L1xxx6(8/B) bootloader versions  - Table 17: STM32F2xxxx configuration in System memory boot mode  - Table 18: STM32F2xxxx bootloader V2.x versions  - Table 20: STM32F2xxxx bootloader V3.x versions
28-Nov-2011	13	Added information related to STM32F405/415xx and STM32F407/417xx bootloader, and STM32F105xx/107xx bootloader V2.1.  Added value line devices in Section 4: STM32F10xxx devices bootloader title and overview.



Table 106. Document revision history (continued)

Date	Revision	Changes
		Added information related to STM32F051x6/STM32F051x8 and to High- density ultralow power STM32L151xx, STM32L152xx bootloader.
		Added case of BOOT1 bit in Section 3.1: Bootloader activation.
		Updated Connectivity line, High-density ultralow power line, STM32F2xx and STM32F4xx in <i>Table 3: Embedded bootloaders</i> .
		Added bootloader version V2.2 in <i>Table 8: STM32F105xx/107xx bootloader versions</i> .
		Added bootloader V2.2 in Section 5.3.1: How to identify STM32F105xx/107xx bootloader versions.
		Added note related to DFU interface below <i>Table 15: STM32L1xxxx high-density configuration in System memory boot mode</i> . Added V4.2 bootloader know limitations and updated description, and added V4.5 bootloader in <i>Table 16: STM32L1xxxx high-density bootloader versions</i> .
30-Jul-2012	14	Added note related to DFU interface below <i>Table 19: STM32F2xxxx</i> configuration in System memory boot mode. Added V3.2 bootloader know limitations, and added V3.3 bootloader in <i>Table 20: STM32F2xxxx bootloader V3.x versions</i> . Updated STM32F2xx and STM32F4xx system memory end address in <i>Table 21: STM32F40xxx/41xxx configuration in System memory boot mode</i> .
	Added note related to DFU interface below <i>Table 21: STM32F40xxx/41xxx</i> configuration in System memory boot mode. Added V3.0 bootloader know limitations, and added V3.1 bootloader in <i>Table 22: STM32F40xxx/41xxx</i> bootloader V3.x version.	
	Added bootloader V2.1 know limitations in <i>Table 26: STM32F051xx bootloader versions</i> .	
		Updated STM32F051x6/x8 system memory end address in <i>Table 65:</i> Bootloader device-dependent parameters.
		Added Table 75: USART bootloader timings for high-density ultralow power devices, and Table 78: USART bootloader timings for STM32F051xx devices.
		Added Table 88: USB minimum timings for high-density ultralow power devices.



AN2606 Revision history

Table 106. Document revision history (continued)

Date	Revision	106. Document revision history (continued)  Changes
- 300		
24-Jan-2013	15	Updated generic product names throughout the document (see <i>Glossary</i> ).  Added the following new sections:  - Section 8: STM32L1xxxC devices bootloader.  - Section 13: STM32F031xx devices bootloader.  - Section 14: STM32F373xx devices bootloader.  - Section 15: STM32F302xB(C)/303xB(C) devices bootloader.  - Section 16: STM32F378xx devices bootloader.  - Section 17: STM32F358xx devices bootloader.  - Section 18: STM32F427xx/437xx devices bootloader.  - Section 34.3: I2C bootloader timing characteristics.  Updated Section 1: Related documents and Section 2: Glossary.  Added Table 79 to Table 85 (USART bootloader timings).  Replaced Figure 6 to Figure 16, and Figures 18, 19 and 42.  Modified Tables 3, 5, 9, 11, 17, 20, 21, 22 to 13, 27, 29, 31, 33, 35, 37 and 65.  Removed "X = 6: one USART is used" in Section 3.3: Hardware connection requirement.  Replaced address 0x1FFFF 8002 with address 0x1FFF F802 in Section 12.1: Bootloader configuration.  Modified procedure related to execution of the bootloader code in Note: on page 28, in Section 6.2: Bootloader selection and in Section 9.2: Bootloader selection.
06-Feb-2013	16	Added information related to I <sup>2</sup> C throughout the document.  Streamlined <i>Table 1: Applicable products</i> and <i>Section 1: Related documents</i> .  Modified <i>Table 3: Embedded bootloaders</i> as follows:  - Replaced "V6.0" with "V1.0"  - Replaced "0x1FFF7A6" with "0x1FFFF796" in row STM32F31xx  - Replaced "0x1FFF7FA6" with "0x1FFFF7A6" in row STM32F051xx  Updated figures 6, 9 and 11.  Added <i>Note:</i> in <i>Glossary</i> and <i>Note:</i> in <i>Section 3.1: Bootloader activation</i> .  Replaced:  - "1.62 V" with "1.8 V" in tables17, 19, 19, 22, 21, 27, 37 and 59  - "5 Kbytes" with "4 Kbytes" in row RAM of <i>Table 33</i> - "127 pages (2 KB each)" with "4 KB (2 pages of 2 KB each)" in rows F3 of <i>Table 65</i> - "The bootloader ID is programmed in the last two bytes of the device system memory" with "The bootloader ID is programmed in the last byte address - 1 of the device system memory" in <i>Section 3.3: Hardware connection requirement</i> .  - "STM32F2xxxx devices revision Y" by "STM32F2xxxx devices revision X and Y" in <i>Section 10: STM32F2xxxx devices bootloader</i> - "Voltage Range 2" with "Voltage Range 1" in tables 11, 15 and 26.

Table 106. Document revision history (continued)

Date	Revision	Changes
21-May-2013	17	Updated:  — Introduction  — Section 2: Glossary  — Section 3.3: Hardware connection requirement  — Section 7: STM32L1xxx6(8/B) devices bootloader to include STM32L100 value line  — Section 32.2: USART connection timing  — Section 34.2: USB bootloader timing characteristics  — Section 34.3: I2C bootloader timing characteristics  — Table 1: Applicable products  — Table 3: Embedded bootloaders  — Table 25: STM32F051xx configuration in System memory boot mode  — Table 27: STM32F031xx configuration in System memory boot mode  — Table 65: Bootloader device-dependent parameters  — Figure 17: Bootloader selection for STM32F031xx devices  Added Section 19: STM32F429xx/439xx devices bootloader.
19-May-2014	18	Add:  - Figure 1 to Figure 5, Figure 55, Figure 6, Figure 25, Figure 26, Figure 24, from Figure 37 to Figure 60, Figure 64  - Table 4, Table 94, Table 95, from Table 6 to Table 45, from Table 46 to Table 43, from Table 66 to Table 67, from Table to Table 105  - Section 38.4, Section 31.2, Section 46.1, Section 46.5  - Section 4, Section 22, Section 23, Section 21, from Section 16 to Section 44  - note under Figure 1, Figure 2, Figure 3 and Figure 4  Updated:  - Updated starting from Section 3 to Section 6 and Section 17, Section 31 and Section 31 the chapter structure organized in three subsection: Bootloader configuration, Bootloader selection and Bootloader version.  Updated Section 44 and Section 46  - Updated block diagram of Figure 25 and Figure 20.  - Fixed I2C address for STM32F429xx/439xx devices in Table 64  - Table 1, Table 2, Table 3, Table 24, Table 88, Table 90, Table 92, Table 28, Table 30, Table 50, Table 100  - from Figure 14, to Figure 28, Figure 8, from Figure 60 to Figure 64  - note on Table 89

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Table 106. Document revision history (continued)

Date	Revision	Changes
29-Jul-2014	19	Updated:  notes under Table 2  Figure 54 and Figure 55  Section 2: Glossary  replaced any reference to STM32F427xx/437xx with STM32F42xxx/43xxx on Section 31: STM32F42xxx/43xxx devices bootloader  replace any occurrence of 'STM32F072xx' with 'STM32F07xxx'  replace any occurrence of 'STM32F051xx' with 'STM32F051xx and STM32F030x8 devices'.  comment field related to OTG_FS_DP and OTG_FS_DM on Table 24, Table 30, Table 50, Table 94, Table 64, Table 66, Table 12, Table 18, Table 54, Table 56 and Table 60  comment field related to USB_DM on Table 94.  replace reference to "STM32F429xx/439xx" by "STM32F42xxx/43xxx" on Table 3  comment field related to SPI2_MOSI, SPI2_MISO, SPI2_SCK and SPI2_NSS pins on Table 66  Added:  note under Table 2  reference to STM32F411 on Table 1, Section 2: Glossary, Table 101, Table 102, Table 103, Table 104  Section 29: STM32F411xx devices bootloader  Removed reference to STM32F427xx/437xx on Table 3, Section 2: Glossary, Table 100, Table 101, Table 102, Table 103, Table 103
24-Nov-2014	20	Updated:  - comment in "SPI1_NSS pin" and "SPI2_NSS pin" rows on <i>Table 94</i> and <i>Table 80</i> - comment in "SPI1_NSS pin", "SPI2_NSS pin" and "SPI3_NSS pin" rows on <i>Table 54</i> , <i>Table 56</i> and <i>Table 60</i> - <i>Figure 1</i>
11-Mar-2015	21	Updated:  - Table 1, Table 3, Table 22, Table 26, Table 88, Table 28, Table 30, Table 31, Table 50, Table 94, Table 10, Table 11, Table 6, Table 34, Table 64, Table 66, Table 12, Table 13, Table 18, Table 19, Table 32, Table 86, Table 96, Table 100, Table 101, Table 102, Table 103 and Table 104  - Figure 57  - Chapter 2: Glossary  - Section 3.1 and Section 3.4  Added:  - Section 44: STM32L476xx/486xx devices bootloader and Section 32: STM32F446xx devices bootloader

Table 106. Document revision history (continued)

Date	Revision	Changes
09-Jun-2015	22	Added:  Section 8: STM32F070x6 devices bootloader  Section 9: STM32F070xB devices bootloader  Section 11: STM32F09xxx devices bootloader  Section 18: STM32F302xD(E)/303xD(E) devices bootloaderSection 24: STM32F398xx devices bootloader  Section 34: STM32F74xxx/75xxx devices bootloader  Section 34: STM32F74xxx/75xxx devices bootloader  Section 44.2: Bootloader V9.x  Notes 1 and 2 on Figure 61  Updated:  Table 1  Section 2: Glossary  Table 2  Table 3  Section 3.4: Bootloader Memory Management  Table 100, Table 101, Table 102, Table 103 and Table 104
29-Sep-2015	23	Added:  - Section 28: STM32F410xx device bootloader  - Section 33: STM32F469xx/479xx devices bootloader  - Section 36: STM32L031xx/041xx devices bootloader  - Section 38: STM32L07xxx/08xxx devices bootloader  Updated:  - Table 1  - Section 2: Glossary  - Table 3  - Figure 57, Table 98, Table 101, Table 102, Table 103, Table 104
02-Nov-2015	24	Updated:  - Table 1, Table 3, Table 100, Table 101, Table 102, Table 103, Table 104  - Section 33 Added:  - Note on Section 25.2.1  - Section 30
01-Dec-2015	25	Updated:  - Section 3.1, Section 38  - Table 100
03-Mar-2016	26	Updated:  - Table 1, Table 3, Table 63, Table 83, Table 85, Table 100  - Section 2, Section 38.1.1, Section 38.2.1, Section 44 Added:  - Section 35: STM32L01xxx/02xxx devices bootloader  - Figure 47, Figure 49

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